

# ADS117L11 400-kSPS, Wide-Bandwidth, 16-Bit, Delta-Sigma ADC

## 1 Features

- Programmable data rate:
  - Up to 400 kSPS (wideband filter)
  - Up to 1.067 MSPS (low-latency filter)
- Selectable digital filter:
  - Wideband or low-latency
- AC accuracy with dc precision:
  - Dynamic range: 97.5 dB (200 kSPS), typical
  - THD: –110 dB, typical
  - INL: 0.5 LSB, typical
  - Offset drift: 50 nV/°C, typical
  - Gain drift: 0.6 ppm/°C, typical
- Power-scalable architecture:
  - High-speed mode: 400 kSPS, 18.6 mW
  - Low-speed mode: 50 kSPS, 3.3 mW
- Input and reference precharge buffers
- Internal or external clock
- [Functional Safety-Capable](#)
  - [Documentation available to aid functional safety system design](#)

## 2 Applications

- [Test and measurement](#):
  - Data acquisition (DAQ)
  - Shock and vibration instruments
  - Acoustics and dynamic strain gauges
- [Factory automation and control](#):
  - Analog input modules
- [Medical](#):
  - Pulse oximetry
- [Grid infrastructure](#):
  - Power quality analyzer

## 3 Description

The ADS117L11 is a 16-bit, delta-sigma ( $\Delta\Sigma$ ), analog-to-digital converter (ADC) with data rates up to 400 kSPS using the wideband filter and up to 1067 kSPS using the low-latency filter. The device offers an excellent combination of ac performance and dc precision with low power consumption (18.6 mW in high-speed mode).

The device integrates input and reference buffers to reduce signal loading. The low-drift modulator achieves excellent dc precision with low in-band noise for outstanding ac performance. The power-scalable architecture provides two speed modes to optimize data rate, resolution, and power consumption.

The digital filter is configurable for wideband or low-latency operation, optimizing ac performance or data throughput for dc signals, all in one device.

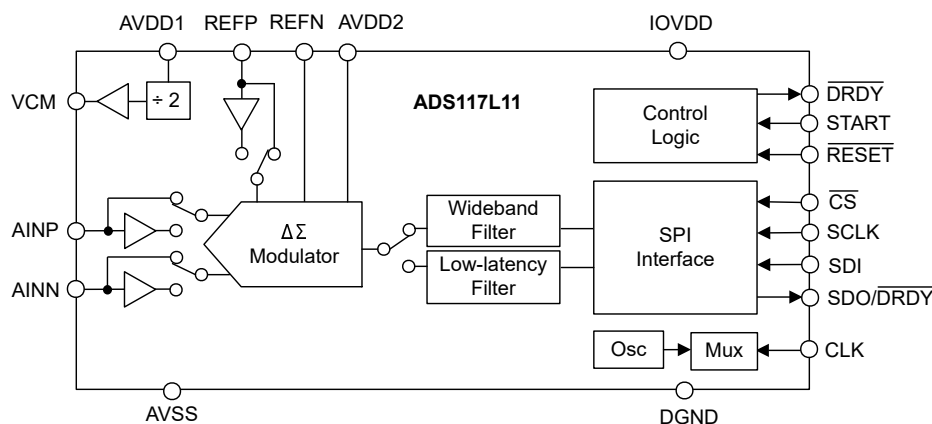
The serial interface features daisy-chain capability to reduce the SPI I/O over an isolation barrier. Input and output data and register settings are validated by a cyclic-redundancy check (CRC) feature to enhance operational reliability.

The small 3-mm × 3-mm WQFN package is designed for limited space applications. The device is fully specified for operation over the –40°C to +125°C temperature range.

### Package Information<sup>(1)</sup>

| PART NUMBER | PACKAGE        | BODY SIZE (NOM)   |
|-------------|----------------|-------------------|
| ADS117L11   | RUK (WQFN, 20) | 3.00 mm × 3.00 mm |

(1) For all available packages, see the orderable addendum at the end of the data sheet.



**Simplified Block Diagram**



## Table of Contents

|                                                           |           |                                                                  |           |
|-----------------------------------------------------------|-----------|------------------------------------------------------------------|-----------|
| <b>1 Features</b> .....                                   | <b>1</b>  | 7.9 THD Measurement.....                                         | <b>22</b> |
| <b>2 Applications</b> .....                               | <b>1</b>  | 7.10 SFDR Measurement.....                                       | <b>22</b> |
| <b>3 Description</b> .....                                | <b>1</b>  | 7.11 Noise Performance.....                                      | <b>23</b> |
| <b>4 Revision History</b> .....                           | <b>2</b>  | <b>8 Detailed Description</b> .....                              | <b>26</b> |
| <b>5 Pin Configuration and Functions</b> .....            | <b>3</b>  | 8.1 Overview.....                                                | <b>26</b> |
| <b>6 Specifications</b> .....                             | <b>4</b>  | 8.2 Functional Block Diagram.....                                | <b>26</b> |
| 6.1 Absolute Maximum Ratings.....                         | <b>4</b>  | 8.3 Feature Description.....                                     | <b>27</b> |
| 6.2 ESD Ratings.....                                      | <b>4</b>  | 8.4 Device Functional Modes.....                                 | <b>40</b> |
| 6.3 Recommended Operating Conditions.....                 | <b>5</b>  | 8.5 Programming.....                                             | <b>46</b> |
| 6.4 Thermal Information.....                              | <b>5</b>  | 8.6 Registers.....                                               | <b>56</b> |
| 6.5 Electrical Characteristics.....                       | <b>6</b>  | <b>9 Application and Implementation</b> .....                    | <b>68</b> |
| 6.6 Timing Requirements (1.65 V ≤ IOVDD ≤ 2 V).....       | <b>10</b> | 9.1 Application Information.....                                 | <b>68</b> |
| 6.7 Switching Characteristics (1.65 V ≤ IOVDD ≤ 2 V)..... | <b>10</b> | 9.2 Typical Application.....                                     | <b>69</b> |
| 6.8 Timing Requirements (2 V < IOVDD ≤ 5.5 V).....        | <b>11</b> | 9.3 Power Supply Recommendations.....                            | <b>71</b> |
| 6.9 Switching Characteristics (2 V < IOVDD ≤ 5.5 V).....  | <b>11</b> | 9.4 Layout.....                                                  | <b>72</b> |
| 6.10 Timing Diagrams.....                                 | <b>12</b> | <b>10 Device and Documentation Support</b> .....                 | <b>74</b> |
| 6.11 Typical Characteristics.....                         | <b>13</b> | 10.1 Documentation Support.....                                  | <b>74</b> |
| <b>7 Parameter Measurement Information</b> .....          | <b>20</b> | 10.2 Receiving Notification of Documentation Updates.....        | <b>74</b> |
| 7.1 Offset Error Measurement.....                         | <b>20</b> | 10.3 Support Resources.....                                      | <b>74</b> |
| 7.2 Offset Drift Measurement.....                         | <b>20</b> | 10.4 Trademarks.....                                             | <b>74</b> |
| 7.3 Gain Error Measurement.....                           | <b>20</b> | 10.5 Electrostatic Discharge Caution.....                        | <b>74</b> |
| 7.4 Gain Drift Measurement.....                           | <b>20</b> | 10.6 Glossary.....                                               | <b>74</b> |
| 7.5 NMRR Measurement.....                                 | <b>20</b> | <b>11 Mechanical, Packaging, and Orderable Information</b> ..... | <b>74</b> |
| 7.6 CMRR Measurement.....                                 | <b>21</b> | 11.1 Mechanical Data.....                                        | <b>75</b> |
| 7.7 PSRR Measurement.....                                 | <b>21</b> |                                                                  |           |
| 7.8 INL Error Measurement.....                            | <b>22</b> |                                                                  |           |

## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision * (March 2022) to Revision A (October 2022)                                               | Page     |
|-----------------------------------------------------------------------------------------------------------------|----------|
| • First public release, changed document status from <i>Advance Information</i> to <i>Production Data</i> ..... | <b>1</b> |

## 5 Pin Configuration and Functions

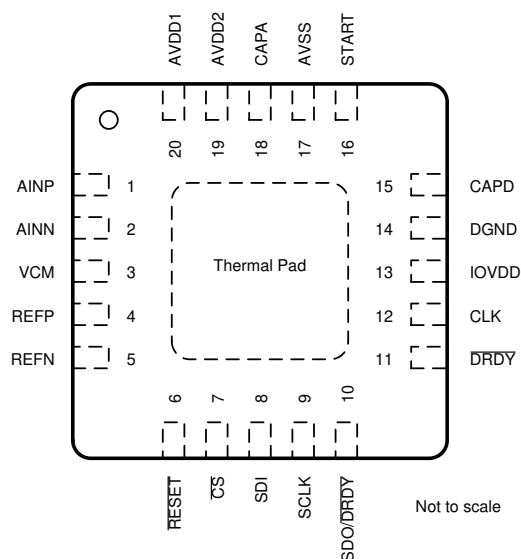


**Figure 5-1. RUK Package, 20-Pin WQFN (Top View)**

**Table 5-1. Pin Functions**

| NAME        | PIN NO. | I/O            | DESCRIPTION                                                                                         |
|-------------|---------|----------------|-----------------------------------------------------------------------------------------------------|
| AINN        | 2       | Analog input   | Negative analog input; see the <a href="#">Analog Input</a> section for details                     |
| AINP        | 1       | Analog input   | Positive analog input; see the <a href="#">Analog Input</a> section for details                     |
| AVDD1       | 20      | Analog Supply  | Positive analog supply 1; see the <a href="#">Power Supplies</a> section for details                |
| AVDD2       | 19      | Analog Supply  | Positive analog supply 2; see the <a href="#">Power Supplies</a> section for details                |
| AVSS        | 17      | Analog Supply  | Negative analog supply; see the <a href="#">Power Supplies</a> section for details                  |
| CAPA        | 18      | Analog output  | Analog voltage regulator output capacitor bypass                                                    |
| CAPD        | 15      | Analog output  | Digital voltage regulator output capacitor bypass                                                   |
| CLK         | 12      | Digital input  | Clock input; see the <a href="#">Clock Operation</a> section for details                            |
| CS          | 7       | Digital input  | Chip select, active low; see the <a href="#">Chip Select</a> section for details                    |
| DGND        | 14      | Ground         | Digital ground                                                                                      |
| DRDY        | 11      | Digital output | Data ready, active low; see the <a href="#">Data Ready</a> section for details                      |
| IOVDD       | 13      | Digital Supply | I/O supply voltage; see the <a href="#">Power Supplies</a> section for details                      |
| REFN        | 5       | Analog input   | Negative reference input; see the <a href="#">Reference Voltage</a> section for details             |
| REFP        | 4       | Analog input   | Positive reference input; see the <a href="#">Reference Voltage</a> section for details             |
| RESET       | 6       | Digital input  | Reset, active low; see the <a href="#">Reset</a> section for details                                |
| SCLK        | 9       | Digital input  | Serial data clock; see the <a href="#">Serial Clock</a> section for details                         |
| SDI         | 8       | Digital input  | Serial data input; see the <a href="#">Serial Data Input</a> section for details                    |
| SDO/DRDY    | 10      | Digital output | Serial data output and data ready (optional); see the <a href="#">SDO/DRDY</a> section for details  |
| START       | 16      | Digital input  | Conversion start; see the <a href="#">Synchronization</a> section for details                       |
| VCM         | 3       | Analog output  | Common-mode voltage buffered output; see the <a href="#">VCM Output Voltage</a> section for details |
| Thermal Pad | Pad     | —              | Thermal power pad; connect to AVSS                                                                  |

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating ambient temperature range (unless otherwise noted) <sup>(1)</sup>

|                              |                                                                  | MIN        | MAX         | UNIT |
|------------------------------|------------------------------------------------------------------|------------|-------------|------|
| Power supply voltage         | AVDD1 to AVSS                                                    | −0.3       | 6.5         | V    |
|                              | AVDD2 to AVSS                                                    | −0.3       | 6.5         |      |
|                              | AVSS to DGND                                                     | −3         | 0.3         |      |
|                              | IOVDD to DGND                                                    | −0.3       | 6.5         |      |
|                              | IOVDD to AVSS                                                    |            | 8.5         |      |
| Digital input/output voltage | SDO/ $\overline{\text{DRDY}}$ , $\overline{\text{DRDY}}$ , START | DGND − 0.3 | IOVDD + 0.3 | V    |
|                              | $\overline{\text{CS}}$ , SCLK, SDI, RESET, CLK                   | DGND − 0.3 | 6.5         |      |
| Input current                | Continuous, any pin except power-supply pins <sup>(2)</sup>      | −10        | 10          | mA   |
| Temperature                  | Junction, $T_J$                                                  |            | 150         | °C   |
|                              | Storage, $T_{\text{stg}}$                                        | −65        | 150         |      |

- (1) Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute Maximum Ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions. If briefly operating outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not sustain damage, but it may not be fully functional – this may affect device reliability, functionality, performance, and shorten the device lifetime.
- (2) Analog input pins AINP, AINN, REFP, and REFN are diode-clamped to AVDD1 and AVSS. Limit the input current to 10 mA in the event the analog input voltage exceeds AVDD1 + 0.3 V or AVSS − 0.3 V. Digital input pin START and digital output pins SDO/ $\overline{\text{DRDY}}$  and  $\overline{\text{DRDY}}$  are diode-clamped to IOVDD and DGND. Digital input pins  $\overline{\text{CS}}$ , SCLK, SDI, RESET and CLK are diode-clamped to DGND. Limit the input current to 10 mA in the event the digital input voltage exceeds IOVDD + 0.3 V (for effected pins) or exceeds DGND − 0.3 V.

### 6.2 ESD Ratings

|                    |                         |                                                                       | VALUE | UNIT |
|--------------------|-------------------------|-----------------------------------------------------------------------|-------|------|
| $V_{\text{(ESD)}}$ | Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>     | 2000  | V    |
|                    |                         | Charged-device model (CDM), per ANSI/ESDA/JEDEC JS-002 <sup>(2)</sup> | 1000  |      |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

## 6.3 Recommended Operating Conditions

over operating ambient temperature range (unless otherwise noted)

|                                          |                                                                                            |                                        | MIN                 | NOM   | MAX                | UNIT |
|------------------------------------------|--------------------------------------------------------------------------------------------|----------------------------------------|---------------------|-------|--------------------|------|
| POWER SUPPLY                             |                                                                                            |                                        |                     |       |                    |      |
|                                          | Analog power supply                                                                        | AVDD1 to AVSS, high-speed mode         | 4.5                 |       | 5.5                | V    |
|                                          |                                                                                            | AVDD1 to AVSS, low-speed mode          | 2.85                |       | 5.5                |      |
|                                          |                                                                                            | AVDD1 to DGND                          | 1.65                |       |                    |      |
|                                          |                                                                                            | Absolute ratio of AVSS / AVDD1 to DGND |                     |       | 1.2                | V/V  |
|                                          |                                                                                            | AVDD2 to AVSS                          | 1.74                |       | 5.5                | V    |
|                                          |                                                                                            | AVSS to DGND                           | −2.75               |       | 0                  |      |
|                                          | Digital power supply                                                                       | IOVDD to DGND                          | 1.65                |       | 5.5                | V    |
| ANALOG INPUTS                            |                                                                                            |                                        |                     |       |                    |      |
| V <sub>AINP</sub> ,<br>V <sub>AINN</sub> | Absolute input voltage                                                                     | Precharge buffer off                   | AVSS − 0.05         |       | AVDD1 + 0.05       | V    |
|                                          |                                                                                            | Precharge buffer on                    | AVSS + 0.1          |       | AVDD1 − 0.1        |      |
| V <sub>IN</sub>                          | Differential input voltage<br>V <sub>IN</sub> = V <sub>AINP</sub> − V <sub>AINN</sub>      | 1x input range                         | −V <sub>REF</sub>   |       | V <sub>REF</sub>   | V    |
|                                          |                                                                                            | 2x input range                         | −2·V <sub>REF</sub> |       | 2·V <sub>REF</sub> |      |
| VOLTAGE REFERENCE INPUTS                 |                                                                                            |                                        |                     |       |                    |      |
| V <sub>REF</sub>                         | Differential reference voltage<br>V <sub>REF</sub> = V <sub>REFP</sub> − V <sub>REFN</sub> | Low-reference range                    | 0.5                 | 2.5   | 2.75               | V    |
|                                          |                                                                                            | High-reference range                   | 1                   | 4.096 | AVDD1 − AVSS       |      |
| V <sub>REFN</sub>                        | Negative reference voltage                                                                 |                                        | AVSS − 0.05         |       |                    | V    |
| V <sub>REFP</sub>                        | Positive reference voltage                                                                 | REFP precharge buffer off              |                     |       | AVDD1 + 0.05       | V    |
|                                          |                                                                                            | REFP precharge buffer on               |                     |       | AVDD1 − 0.7        |      |
| EXTERNAL CLOCK SOURCE                    |                                                                                            |                                        |                     |       |                    |      |
| f <sub>CLK</sub>                         | Clock frequency                                                                            | High-speed mode                        | 0.5                 | 25.6  | 26.2               | MHz  |
|                                          |                                                                                            | Low-speed mode                         | 0.5                 | 3.2   | 3.28               |      |
| DIGITAL INPUTS                           |                                                                                            |                                        |                     |       |                    |      |
| V <sub>IL</sub>                          | Logic input voltage, low                                                                   |                                        | DGND                |       | 0.3·IOVDD          | V    |
| V <sub>IH</sub>                          | Logic input voltage, high                                                                  |                                        | 0.7·IOVDD           |       | IOVDD              | V    |
| TEMPERATURE RANGE                        |                                                                                            |                                        |                     |       |                    |      |
| T <sub>A</sub>                           | Operating ambient temperature                                                              |                                        | −45                 |       | 125                | °C   |

## 6.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | ADS117L11  | UNIT |
|-------------------------------|----------------------------------------------|------------|------|
|                               |                                              | WQFN (RUK) |      |
|                               |                                              | 20 PINS    |      |
| $R_{\theta JA}$               | Junction-to-ambient thermal resistance       | 46.0       | °C/W |
| $R_{\theta JC(top)}$          | Junction-to-case (top) thermal resistance    | 43.9       | °C/W |
| $R_{\theta JB}$               | Junction-to-board thermal resistance         | 19.9       | °C/W |
| $\psi_{JT}$                   | Junction-to-top characterization parameter   | 0.7        | °C/W |
| $\psi_{JB}$                   | Junction-to-board characterization parameter | 19.9       | °C/W |
| $R_{\theta JC(bot)}$          | Junction-to-case (bottom) thermal resistance | 6.1        | °C/W |

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 6.5 Electrical Characteristics

minimum and maximum specifications apply from  $T_A = -40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ ; typical specifications are at  $T_A = 25^{\circ}\text{C}$ ; all specifications are at  $\text{AVDD1} = 5\text{ V}$ ,  $\text{AVDD2} = 1.8\text{ V}$  to  $5\text{ V}$ ,  $\text{AVSS} = 0\text{ V}$ ,  $\text{IOVDD} = 1.8\text{ V}$ ,  $V_{\text{IN}} = 0\text{ V}$ ,  $V_{\text{CM}} = 2.5\text{ V}$ ,  $V_{\text{REFP}} = 4.096\text{ V}$ ,  $V_{\text{REFN}} = 0\text{ V}$ , high-reference range, 1x input range,  $f_{\text{CLK}} = 25.6\text{ MHz}$  (high-speed mode),  $f_{\text{CLK}} = 3.2\text{ MHz}$  (low-speed mode), input precharge buffers on, and reference precharge buffer on (unless otherwise noted)

| PARAMETER                      |                                                    | TEST CONDITIONS                                             | MIN                                                       | TYP   | MAX     | UNIT          |
|--------------------------------|----------------------------------------------------|-------------------------------------------------------------|-----------------------------------------------------------|-------|---------|---------------|
| ANALOG INPUTS, HIGH-SPEED MODE |                                                    |                                                             |                                                           |       |         |               |
|                                | Input current,<br>differential input voltage       | Precharge buffers off                                       | 95                                                        |       | μA/V    |               |
|                                |                                                    | Precharge buffers off, 2x input range                       | 47                                                        |       |         |               |
|                                |                                                    | Precharge buffers on                                        | ±3                                                        | μA    |         |               |
|                                | Input current drift,<br>differential input voltage | Precharge buffers off                                       | 3                                                         |       | nA/V/°C |               |
|                                |                                                    | Precharge buffers off, 2x input range                       | 1.5                                                       |       |         |               |
|                                |                                                    | Precharge buffers on                                        | 5                                                         | nA/°C |         |               |
|                                | Input current,<br>common-mode input voltage        | Precharge buffers off                                       | 5                                                         |       | μA/V    |               |
|                                |                                                    | Precharge buffers off, 2x input range                       | 2.5                                                       |       |         |               |
|                                |                                                    | Precharge buffers on                                        | ±3                                                        | μA    |         |               |
| ANALOG INPUTS, LOW-SPEED MODE  |                                                    |                                                             |                                                           |       |         |               |
|                                | Input current,<br>differential input voltage       | Precharge buffers off                                       | 12                                                        |       | μA/V    |               |
|                                |                                                    | Precharge buffers off, 2x input range                       | 6                                                         |       |         |               |
|                                |                                                    | Precharge buffers on                                        | ±0.4                                                      | μA    |         |               |
|                                | Input current drift,<br>differential input voltage | Precharge buffers off                                       | 1                                                         |       | nA/V/°C |               |
|                                |                                                    | Precharge buffers off, 2x input range                       | 0.5                                                       |       |         |               |
|                                |                                                    | Precharge buffers on                                        | 0.2                                                       | nA/°C |         |               |
|                                | Input current,<br>common-mode input voltage        | Precharge buffers off                                       | 0.6                                                       |       | μA/V    |               |
|                                |                                                    | Precharge buffers off, 2x input range                       | 0.3                                                       |       |         |               |
|                                |                                                    | Precharge buffers on                                        | ±0.4                                                      | μA    |         |               |
| DC PERFORMANCE                 |                                                    |                                                             |                                                           |       |         |               |
|                                | Resolution                                         |                                                             | 16                                                        |       | Bits    |               |
|                                | Noise                                              |                                                             | See <a href="#">Noise Performance section</a> for details |       |         |               |
| f <sub>DATA</sub>              | Output data rate                                   | High-speed mode, low-latency filter                         | 0.08                                                      | 1067  |         | kSPS          |
|                                |                                                    | High-speed mode, wideband filter                            | 3.125                                                     | 400   |         |               |
|                                |                                                    | Low-speed mode, low-latency filter                          | 0.01                                                      | 133   |         |               |
|                                |                                                    | Low-speed mode, wideband filter                             | 0.390625                                                  | 50    |         |               |
| INL                            | Integral nonlinearity                              | End point method                                            | 0.5                                                       |       | 1       | LSB           |
|                                | Offset error                                       | T <sub>A</sub> = 25°C                                       | –250                                                      | ±30   | 250     | μV            |
|                                | Offset drift                                       |                                                             | 50                                                        |       | 200     | nV/°C         |
|                                | Gain error                                         | T <sub>A</sub> = 25°C                                       | –2000                                                     | ±200  | 2000    | ppm of FSR    |
|                                | Gain drift                                         |                                                             | 0.6                                                       |       | 2       | ppm of FSR/°C |
| NMRR                           | Normal-mode rejection ratio                        | f <sub>IN</sub> = 50 Hz (±1 Hz), f <sub>DATA</sub> = 50 SPS | 100                                                       |       |         |               |
|                                |                                                    | f <sub>IN</sub> = 60 Hz (±1 Hz), f <sub>DATA</sub> = 60 SPS | 100                                                       |       |         |               |
| CMRR                           | Common-mode rejection ratio                        | At dc                                                       | 110                                                       | 120   | dB      |               |
|                                |                                                    | Up to 10 kHz                                                | 115                                                       |       |         |               |
|                                |                                                    | At dc, 2x input range                                       | 95                                                        |       |         |               |
| PSRR                           | Power-supply rejection ratio                       | AVDD1, dc                                                   | 95                                                        | 100   | dB      |               |
|                                |                                                    | AVDD2, dc                                                   | 95                                                        | 100   |         |               |
|                                |                                                    | IOVDD, dc                                                   | 95                                                        | 100   |         |               |

## 6.5 Electrical Characteristics (continued)

minimum and maximum specifications apply from  $T_A = -40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ ; typical specifications are at  $T_A = 25^{\circ}\text{C}$ ; all specifications are at  $\text{AVDD1} = 5\text{ V}$ ,  $\text{AVDD2} = 1.8\text{ V}$  to  $5\text{ V}$ ,  $\text{AVSS} = 0\text{ V}$ ,  $\text{IOVDD} = 1.8\text{ V}$ ,  $V_{\text{IN}} = 0\text{ V}$ ,  $V_{\text{CM}} = 2.5\text{ V}$ ,  $V_{\text{REFP}} = 4.096\text{ V}$ ,  $V_{\text{REFN}} = 0\text{ V}$ , high-reference range, 1x input range,  $f_{\text{CLK}} = 25.6\text{ MHz}$  (high-speed mode),  $f_{\text{CLK}} = 3.2\text{ MHz}$  (low-speed mode), input precharge buffers on, and reference precharge buffer on (unless otherwise noted)

| PARAMETER                       |                                                                | TEST CONDITIONS                                                                                                                               |                                                                            | MIN                            | TYP    | MAX             | UNIT          |
|---------------------------------|----------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------|--------------------------------|--------|-----------------|---------------|
| AC PERFORMANCE, HIGH-SPEED MODE |                                                                |                                                                                                                                               |                                                                            |                                |        |                 |               |
| SNR                             | Signal-to-noise ratio                                          | $f_{\text{IN}} = 1\text{ kHz}$ ,<br>$V_{\text{IN}} = -0.2\text{ dBFS}$ ,<br>OSR = 64,<br>$f_{\text{DATA}} = 200\text{ kSPS}$ ,<br>9 harmonics | Wideband filter                                                            | 96.5                           | 97.5   | dB              |               |
|                                 |                                                                |                                                                                                                                               | Wideband filter,<br>$V_{\text{REF}} = 2.5\text{ V}$                        |                                | 97.0   |                 |               |
|                                 |                                                                |                                                                                                                                               | Wideband filter,<br>$V_{\text{REF}} = 2.5\text{ V}$ ,<br>2x input range    |                                | 97.5   |                 |               |
|                                 |                                                                |                                                                                                                                               | Low-latency filter                                                         | 97.0                           | 98.0   |                 |               |
|                                 |                                                                |                                                                                                                                               | Low-latency filter,<br>$V_{\text{REF}} = 2.5\text{ V}$                     |                                | 97.5   |                 |               |
|                                 |                                                                |                                                                                                                                               | Low-latency filter,<br>$V_{\text{REF}} = 2.5\text{ V}$ ,<br>2x input range |                                | 98.0   |                 |               |
| THD                             | Total harmonic distortion                                      | $f_{\text{IN}} = 1\text{ kHz}$ ,<br>$V_{\text{IN}} = -0.2\text{ dBFS}$ ,<br>OSR = 64,<br>$f_{\text{DATA}} = 200\text{ kSPS}$ ,<br>9 harmonics | Wideband filter                                                            |                                | -110   | dB              |               |
| SFDR                            | Spurious-free dynamic range                                    | $f_{\text{IN}} = 1\text{ kHz}$ , $V_{\text{IN}} = -0.2\text{ dBFS}$ , OSR = 64                                                                |                                                                            |                                | 110    | dB              |               |
| AC PERFORMANCE, LOW-SPEED MODE  |                                                                |                                                                                                                                               |                                                                            |                                |        |                 |               |
| SNR                             | Signal-to-noise ratio                                          | $f_{\text{IN}} = 1\text{ kHz}$ ,<br>$V_{\text{IN}} = -0.2\text{ dBFS}$ ,<br>OSR = 64,<br>$f_{\text{DATA}} = 25\text{ kSPS}$                   | Wideband filter                                                            | 96.5                           | 97.5   | dB              |               |
|                                 |                                                                |                                                                                                                                               | Wideband filter,<br>$V_{\text{REF}} = 2.5\text{ V}$                        |                                | 97.0   |                 |               |
|                                 |                                                                |                                                                                                                                               | Wideband filter,<br>$V_{\text{REF}} = 2.5\text{ V}$ ,<br>2x input range    |                                | 97.5   |                 |               |
|                                 |                                                                |                                                                                                                                               | Low-latency filter                                                         | 97.0                           | 98.0   |                 |               |
|                                 |                                                                |                                                                                                                                               | Low-latency filter,<br>$V_{\text{REF}} = 2.5\text{ V}$                     |                                | 97.5   |                 |               |
|                                 |                                                                |                                                                                                                                               | Low-latency filter,<br>$V_{\text{REF}} = 2.5\text{ V}$ ,<br>2x input range |                                | 98.0   |                 |               |
| THD                             | Total harmonic distortion                                      | $f_{\text{IN}} = 1\text{ kHz}$ ,<br>$V_{\text{IN}} = -0.2\text{ dBFS}$ ,<br>OSR = 64,<br>$f_{\text{DATA}} = 25\text{ kSPS}$ ,<br>9 harmonics  | Wideband filter                                                            |                                | -110   | dB              |               |
| SFDR                            | Spurious-free dynamic range                                    | $f_{\text{IN}} = 1\text{ kHz}$ , $V_{\text{IN}} = -0.2\text{ dBFS}$ , OSR = 64                                                                |                                                                            |                                | 110    | dB              |               |
| WIDEBAND FILTER CHARACTERISTICS |                                                                |                                                                                                                                               |                                                                            |                                |        |                 |               |
|                                 | Pass-band frequency                                            | Within envelope of pass-band ripple                                                                                                           |                                                                            | $0.4 \cdot f_{\text{DATA}}$    |        | Hz              |               |
|                                 |                                                                | -0.1-dB frequency                                                                                                                             |                                                                            | $0.4125 \cdot f_{\text{DATA}}$ |        |                 |               |
|                                 |                                                                | -3-dB frequency                                                                                                                               |                                                                            | $0.4374 \cdot f_{\text{DATA}}$ |        |                 |               |
|                                 | Pass-band ripple                                               |                                                                                                                                               |                                                                            | -0.0004                        | 0.0004 | dB              |               |
|                                 | Stop-band frequency                                            | At stop-band attenuation                                                                                                                      |                                                                            | $0.5 \cdot f_{\text{DATA}}$    |        | Hz              |               |
|                                 | Stop-band attenuation <sup>(1)</sup>                           |                                                                                                                                               |                                                                            | 106                            |        | dB              |               |
|                                 | Group delay                                                    |                                                                                                                                               |                                                                            | $34 / f_{\text{DATA}}$         |        | s               |               |
|                                 | Settling time                                                  |                                                                                                                                               |                                                                            | $68 / f_{\text{DATA}}$         |        | s               |               |
| VOLTAGE REFERENCE INPUTS        |                                                                |                                                                                                                                               |                                                                            |                                |        |                 |               |
|                                 | REFP and REFN input current,<br>differential reference voltage | REFP precharge buffer off, high-speed mode                                                                                                    |                                                                            |                                | 190    | $\mu\text{A/V}$ |               |
|                                 |                                                                | REFP precharge buffer off, low-speed mode                                                                                                     |                                                                            |                                | 80     |                 |               |
|                                 |                                                                | REFP input current,<br>differential reference voltage                                                                                         | REFP precharge buffer on                                                   |                                |        | $\pm 2$         | $\mu\text{A}$ |

## 6.5 Electrical Characteristics (continued)

minimum and maximum specifications apply from  $T_A = -40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ ; typical specifications are at  $T_A = 25^{\circ}\text{C}$ ; all specifications are at  $\text{AVDD1} = 5\text{ V}$ ,  $\text{AVDD2} = 1.8\text{ V}$  to  $5\text{ V}$ ,  $\text{AVSS} = 0\text{ V}$ ,  $\text{IOVDD} = 1.8\text{ V}$ ,  $V_{\text{IN}} = 0\text{ V}$ ,  $V_{\text{CM}} = 2.5\text{ V}$ ,  $V_{\text{REFP}} = 4.096\text{ V}$ ,  $V_{\text{REFN}} = 0\text{ V}$ , high-reference range, 1x input range,  $f_{\text{CLK}} = 25.6\text{ MHz}$  (high-speed mode),  $f_{\text{CLK}} = 3.2\text{ MHz}$  (low-speed mode), input precharge buffers on, and reference precharge buffer on (unless otherwise noted)

| PARAMETER                                 |                                                         | TEST CONDITIONS                               | MIN                | TYP         | MAX  | UNIT              |
|-------------------------------------------|---------------------------------------------------------|-----------------------------------------------|--------------------|-------------|------|-------------------|
|                                           | REFP and REFN input current drift                       | REFP precharge buffer off, high-speed mode    |                    | 10          |      | nA/°C             |
|                                           |                                                         | REFP precharge buffer off, low-speed mode     |                    | 10          |      |                   |
|                                           | REFP input current drift                                | REFP precharge buffer on                      |                    | 10          |      |                   |
| INTERNAL OSCILLATOR                       |                                                         |                                               |                    |             |      |                   |
|                                           | Frequency                                               | High-speed mode                               | 25.4               | 25.6        | 25.8 | MHz               |
|                                           |                                                         | Low-speed mode                                | 3.17               | 3.2         | 3.23 |                   |
| VCM OUTPUT VOLTAGE                        |                                                         |                                               |                    |             |      |                   |
|                                           | Output voltage                                          |                                               | (AVDD1 + AVSS) / 2 |             |      | V                 |
|                                           | Accuracy                                                |                                               | −1%                | ±0.1%       | 1%   |                   |
|                                           | Voltage noise                                           | 1-kHz bandwidth                               |                    | 25          |      | μV <sub>RMS</sub> |
|                                           | Start-up time                                           | C <sub>L</sub> = 100 nF                       |                    | 1           |      | ms                |
|                                           | Capacitive load                                         |                                               |                    |             | 100  | nF                |
|                                           | Resistive load                                          |                                               | 2                  |             |      | kΩ                |
|                                           | Short-circuit current limit                             |                                               |                    | 10          |      | mA                |
| DIGITAL INPUTS/OUTPUTS                    |                                                         |                                               |                    |             |      |                   |
| V <sub>OL</sub>                           | Logic-low output level                                  | OUT_DRV = 0b, I <sub>OL</sub> = 2 mA          |                    | 0.2 · IOVDD |      | V                 |
|                                           |                                                         | OUT_DRV = 1b, I <sub>OL</sub> = 1 mA          |                    | 0.2 · IOVDD |      |                   |
| V <sub>OH</sub>                           | Logic-high output level                                 | OUT_DRV = 0b, I <sub>OH</sub> = −2 mA         | 0.8 · IOVDD        |             |      | V                 |
|                                           |                                                         | OUT_DRV = 1b, I <sub>OH</sub> = −1 mA         | 0.8 · IOVDD        |             |      |                   |
|                                           | Input hysteresis                                        |                                               |                    | 150         |      | mV                |
|                                           | Input current                                           | Excluding RESET pin                           | −1                 |             | 1    | μA                |
|                                           | RESET pin pullup resistor                               |                                               |                    | 20          |      | kΩ                |
| ANALOG SUPPLY CURRENT                     |                                                         |                                               |                    |             |      |                   |
| I <sub>AVDD1</sub> ,<br>I <sub>AVSS</sub> | AVDD1 and AVSS current (All buffers off)                | High-speed mode                               |                    | 1.7         | 1.85 | mA                |
|                                           |                                                         | Low-speed mode                                |                    | 0.25        | 0.3  |                   |
|                                           |                                                         | Standby mode                                  |                    | 35          |      | μA                |
|                                           |                                                         | Power-down mode                               |                    | 5           |      |                   |
|                                           | AVDD1 and AVSS additional current (per buffer function) | AINx precharge buffer, high-speed mode        |                    | 1.35        | 1.9  | mA                |
|                                           |                                                         | AINx precharge buffer, low-speed mode         |                    | 0.2         | 0.3  |                   |
|                                           |                                                         | REFP precharge buffer, high-speed mode        |                    | 1.5         | 1.6  |                   |
|                                           |                                                         | REFP precharge buffer, low-speed mode         |                    | 0.4         | 0.45 |                   |
|                                           | VCM buffer                                              |                                               | 0.1                |             |      |                   |
| I <sub>AVDD2</sub> ,<br>I <sub>AVSS</sub> | AVDD2 and AVSS current                                  | High-speed mode                               |                    | 3.5         | 3.8  | mA                |
|                                           |                                                         | Low-speed mode                                |                    | 0.85        | 0.95 |                   |
|                                           |                                                         | Standby mode                                  |                    | 60          |      | μA                |
|                                           |                                                         | Power-down mode                               |                    | 1           |      |                   |
| DIGITAL SUPPLY CURRENT                    |                                                         |                                               |                    |             |      |                   |
| I <sub>IOVDD</sub>                        | IOVDD current                                           | High-speed mode, wideband filter, OSR = 32    |                    | 2.1         | 2.7  | mA                |
|                                           |                                                         | High-speed mode, low-latency filter, OSR = 32 |                    | 0.6         | 1    |                   |
|                                           |                                                         | Low-speed mode, wideband filter, OSR = 32     |                    | 0.3         | 0.4  |                   |
|                                           |                                                         | Low-speed mode, low-latency filter, OSR = 32  |                    | 0.1         | 0.2  |                   |
|                                           |                                                         | Standby mode, external clock                  |                    | 10          |      | μA                |
|                                           |                                                         | Standby mode, internal oscillator             |                    | 40          |      |                   |
|                                           |                                                         | Power-down mode                               |                    | 10          |      |                   |

## 6.5 Electrical Characteristics (continued)

minimum and maximum specifications apply from  $T_A = -40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ ; typical specifications are at  $T_A = 25^{\circ}\text{C}$ ; all specifications are at  $AVDD1 = 5\text{ V}$ ,  $AVDD2 = 1.8\text{ V}$  to  $5\text{ V}$ ,  $AVSS = 0\text{ V}$ ,  $IOVDD = 1.8\text{ V}$ ,  $V_{IN} = 0\text{ V}$ ,  $V_{CM} = 2.5\text{ V}$ ,  $V_{REFP} = 4.096\text{ V}$ ,  $V_{REFN} = 0\text{ V}$ , high-reference range, 1x input range,  $f_{CLK} = 25.6\text{ MHz}$  (high-speed mode),  $f_{CLK} = 3.2\text{ MHz}$  (low-speed mode), input precharge buffers on, and reference precharge buffer on (unless otherwise noted)

| PARAMETER         |                   | TEST CONDITIONS                         |                                        | MIN  | TYP | MAX | UNIT |
|-------------------|-------------------|-----------------------------------------|----------------------------------------|------|-----|-----|------|
| POWER DISSIPATION |                   |                                         |                                        |      |     |     |      |
| P <sub>D</sub>    | Power dissipation | AVDD2 = 1.8 V,<br>precharge buffers off | High-speed mode,<br>wideband filter    | 18.6 |     | mW  |      |
|                   |                   |                                         | High-speed mode,<br>low-latency filter | 15.9 |     |     |      |
|                   |                   |                                         | Low-speed mode,<br>wideband filter     | 3.3  |     |     |      |
|                   |                   |                                         | Low-speed mode,<br>low-latency filter  | 3.0  |     |     |      |

- (1) Stop-band attenuation as provided by the digital filter. Input frequencies in the stop band intermodulate with the chop frequency beginning at  $f_{MOD} / 32$ , which results in stop-band attenuation exceeding 106 dB. See the [stopband attenuation](#) figure for details.

## 6.6 Timing Requirements ( $1.65\text{ V} \leq \text{IOVDD} \leq 2\text{ V}$ )

over operating ambient temperature range, unless otherwise noted

|                         |                                                                                                                                              | MIN   | MAX                        | UNIT             |
|-------------------------|----------------------------------------------------------------------------------------------------------------------------------------------|-------|----------------------------|------------------|
| t <sub>c</sub> (CLK)    | CLK period, high-speed mode                                                                                                                  | 38.2  | 2000                       | ns               |
|                         | CLK period, low-speed mode, CLK_DIV = 1b                                                                                                     | 38.2  | 2000                       |                  |
|                         | CLK period, low-speed mode, CLK_DIV = 0b                                                                                                     | 305   | 2000                       |                  |
| t <sub>w</sub> (CLKL)   | Pulse duration, CLK low                                                                                                                      | 17    |                            | ns               |
|                         | Pulse duration, CLK low, low-speed mode, CLK_DIV = 0b                                                                                        | 128   |                            |                  |
| t <sub>w</sub> (CLKH)   | Pulse duration, CLK high                                                                                                                     | 17    |                            | ns               |
|                         | Pulse duration, CLK high, low-speed mode, CLK_DIV = 0b                                                                                       | 128   |                            |                  |
| SERIAL INTERFACE        |                                                                                                                                              |       |                            |                  |
| t <sub>c</sub> (SC)     | SCLK period                                                                                                                                  | 25    | 1/(4 · f <sub>DATA</sub> ) | ns               |
| t <sub>w</sub> (SCL)    | Pulse duration, SCLK low                                                                                                                     | 10    |                            | ns               |
| t <sub>w</sub> (SCH)    | Pulse duration, SCLK high                                                                                                                    | 10    |                            | ns               |
| t <sub>d</sub> (CSSC)   | Delay time, first SCLK rising edge after $\overline{\text{CS}}$ falling edge                                                                 | 10    |                            | ns               |
| t <sub>su</sub> (DI)    | Setup time, SDI valid before SCLK falling edge                                                                                               | 4     |                            | ns               |
| t <sub>h</sub> (DI)     | Hold time, SDI valid after SCLK falling edge                                                                                                 | 6     |                            | ns               |
| t <sub>d</sub> (SCCS)   | Delay time, $\overline{\text{CS}}$ rising edge after final SCLK falling edge                                                                 | 10    |                            | ns               |
| t <sub>w</sub> (CSH)    | Pulse duration, $\overline{\text{CS}}$ high                                                                                                  | 20    |                            | ns               |
| RESET PIN               |                                                                                                                                              |       |                            |                  |
| t <sub>w</sub> (RSL)    | Pulse duration, RESET low                                                                                                                    | 4     |                            | t <sub>CLK</sub> |
| t <sub>d</sub> (RSSC)   | Delay time, communication start after RESET rising edge or after SPI RESET pattern                                                           | 10000 |                            | t <sub>CLK</sub> |
| START PIN               |                                                                                                                                              |       |                            |                  |
| t <sub>w</sub> (STL)    | Pulse duration, START low                                                                                                                    | 4     |                            | t <sub>CLK</sub> |
| t <sub>w</sub> (STH)    | Pulse duration, START high                                                                                                                   | 4     |                            | t <sub>CLK</sub> |
| t <sub>su</sub> (STCLK) | Setup time, START transition before CLK rising edge <sup>(1)</sup>                                                                           | 9     |                            | ns               |
| t <sub>h</sub> (STCLK)  | Hold time, START transition after CLK rising edge <sup>(1)</sup>                                                                             | 12    |                            | ns               |
| t <sub>su</sub> (STDR)  | Setup time, START falling edge or STOP bit before $\overline{\text{DRDY}}$ falling edge to stop next conversion (start/stop conversion mode) | 8     |                            | t <sub>CLK</sub> |

(1) START transition should not occur in the interval between the setup and hold times of the rising edge of CLK

## 6.7 Switching Characteristics ( $1.65\text{ V} \leq \text{IOVDD} \leq 2\text{ V}$ )

over operating ambient temperature range, OUT\_DRV = 0b, C<sub>LOAD</sub> = 20 pF (unless otherwise noted)

|                              | PARAMETER                                                                                                                                               | TEST CONDITIONS                           | MIN | TYP | MAX | UNIT             |
|------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------|-----|-----|-----|------------------|
| $t_{\text{p}}(\text{CSDO})$  | Propagation delay time, $\overline{\text{CS}}$ falling edge to SDO/ $\overline{\text{DRDY}}$ driven state                                               |                                           |     |     | 20  | ns               |
| $t_{\text{p}}(\text{CSDOZ})$ | Propagation delay time, $\overline{\text{CS}}$ rising edge to SDO/ $\overline{\text{DRDY}}$ high impedance state                                        |                                           |     |     | 20  | ns               |
| $t_{\text{h}}(\text{SCDO})$  | Hold time, SCLK rising edge to invalid SDO/ $\overline{\text{DRDY}}$                                                                                    |                                           | 3   |     |     | ns               |
| $t_{\text{p}}(\text{SCDO})$  | Propagation delay time, SCLK rising edge to valid SDO/ $\overline{\text{DRDY}}$                                                                         |                                           |     |     | 23  | ns               |
| $t_{\text{W}}(\text{DRH})$   | Pulse duration, $\overline{\text{DRDY}}$ high                                                                                                           |                                           | 2   |     |     | $t_{\text{CLK}}$ |
| $t_{\text{p}}(\text{SCDR})$  | Propagation delay time, 8th SCLK falling edge to $\overline{\text{DRDY}}$ return high                                                                   | Synchronized and start/stop control modes |     |     | 5   | $t_{\text{CLK}}$ |
| $t_{\text{p}}(\text{DODR})$  | Propagation delay time, last SCLK falling edge of read operation for SDO/ $\overline{\text{DRDY}}$ transition from SDO to $\overline{\text{DRDY}}$ mode | SDO_DRDY = 1b                             |     |     | 50  | ns               |

## 6.8 Timing Requirements (2 V < IOVDD ≤ 5.5 V)

over operating ambient temperature range, unless otherwise noted

|                         |                                                                                                                                       | MIN   | MAX                        | UNIT             |
|-------------------------|---------------------------------------------------------------------------------------------------------------------------------------|-------|----------------------------|------------------|
| t <sub>c</sub> (CLK)    | CLK period, high-speed mode                                                                                                           | 38.2  | 2000                       | ns               |
|                         | CLK period, low-speed mode, CLK_DIV = 1b                                                                                              | 38.2  | 2000                       |                  |
|                         | CLK period, low-speed mode, CLK_DIV = 0b                                                                                              | 305   | 2000                       |                  |
| t <sub>w</sub> (CLKL)   | Pulse duration, CLK low                                                                                                               | 17    |                            | ns               |
|                         | Pulse duration, CLK low, low-speed mode                                                                                               | 128   |                            |                  |
| t <sub>w</sub> (CLKH)   | Pulse duration, CLK high                                                                                                              | 17    |                            | ns               |
|                         | Pulse duration, CLK high, low-speed mode                                                                                              | 128   |                            |                  |
| SERIAL INTERFACE        |                                                                                                                                       |       |                            |                  |
| t <sub>c</sub> (SC)     | SCLK period                                                                                                                           | 20    | 1/(4 · f <sub>DATA</sub> ) | ns               |
| t <sub>w</sub> (SCL)    | Pulse duration, SCLK low                                                                                                              | 8     |                            | ns               |
| t <sub>w</sub> (SCH)    | Pulse duration, SCLK high                                                                                                             | 8     |                            | ns               |
| t <sub>d</sub> (CSSC)   | Delay time, first SCLK rising edge after $\overline{CS}$ falling edge                                                                 | 10    |                            | ns               |
| t <sub>su</sub> (DI)    | Setup time, SDI valid before SCLK falling edge                                                                                        | 4     |                            | ns               |
| t <sub>h</sub> (DI)     | Hold time, SDI valid after SCLK falling edge                                                                                          | 6     |                            | ns               |
| t <sub>d</sub> (SCCS)   | Delay time, $\overline{CS}$ rising edge after final SCLK falling edge                                                                 | 10    |                            | ns               |
| t <sub>w</sub> (CSH)    | Pulse duration, $\overline{CS}$ high                                                                                                  | 20    |                            | ns               |
| RESET PIN               |                                                                                                                                       |       |                            |                  |
| t <sub>w</sub> (RSL)    | Pulse duration, RESET low                                                                                                             | 4     |                            | t                |
| t <sub>d</sub> (RSSC)   | Delay time, communication start after RESET rising edge or after SPI RESET pattern                                                    | 10000 |                            | t <sub>CLK</sub> |
| START PIN               |                                                                                                                                       |       |                            |                  |
| t <sub>w</sub> (STL)    | Pulse duration, START low                                                                                                             | 4     |                            | t <sub>CLK</sub> |
| t <sub>w</sub> (STH)    | Pulse duration, START high                                                                                                            | 4     |                            | t <sub>CLK</sub> |
| t <sub>su</sub> (STCLK) | Setup time, START transition before CLKIN rising edge <sup>(1)</sup>                                                                  | 9     |                            | ns               |
| t <sub>h</sub> (STCLK)  | Hold time, START transition after CLKIN rising edge <sup>(1)</sup>                                                                    | 12    |                            | ns               |
| t <sub>su</sub> (STDR)  | Setup time, START falling edge or STOP bit before $\overline{DRDY}$ falling edge to stop next conversion (start/stop conversion mode) | 8     |                            | t <sub>CLK</sub> |

(1) START transition should not occur in the interval between the setup and hold times of the rising edge of CLK

## 6.9 Switching Characteristics (2 V < IOVDD ≤ 5.5 V)

over operating ambient temperature range, OUT\_DRV = 0b, C<sub>LOAD</sub> = 20 pF (unless otherwise noted)

| PARAMETER      |                                                                                                                                           | TEST CONDITIONS                           | MIN | TYP | MAX | UNIT      |
|----------------|-------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------|-----|-----|-----|-----------|
| $t_{p(CSDO)}$  | Propagation delay time, $\overline{CS}$ falling edge to SDO/ $\overline{DRDY}$ driven                                                     |                                           |     |     | 17  | ns        |
| $t_{p(CSDOZ)}$ | Propagation delay time, $\overline{CS}$ rising edge to SDO/ $\overline{DRDY}$ high impedance state                                        |                                           |     |     | 17  | ns        |
| $t_{h(SCDO)}$  | Hold time, SCLK rising edge to invalid SDO/ $\overline{DRDY}$                                                                             |                                           | 3   |     |     | ns        |
| $t_{p(SCDO)}$  | Propagation delay time, SCLK rising edge to valid SDO/ $\overline{DRDY}$                                                                  |                                           |     |     | 19  | ns        |
| $t_{w(DRH)}$   | Pulse duration, $\overline{DRDY}$ high                                                                                                    |                                           | 2   |     |     | $t_{CLK}$ |
| $t_{p(SCDR)}$  | Propagation delay time, 8th SCLK falling edge to $\overline{DRDY}$ return high                                                            | Synchronized and start/stop control modes |     |     | 5   | $t_{CLK}$ |
| $t_{p(DODR)}$  | Propagation delay time, last SCLK falling edge of read operation for SDO/ $\overline{DRDY}$ transition from SDO to $\overline{DRDY}$ mode | SDO_DRDY = 1b                             |     |     | 50  | ns        |

## 6.10 Timing Diagrams

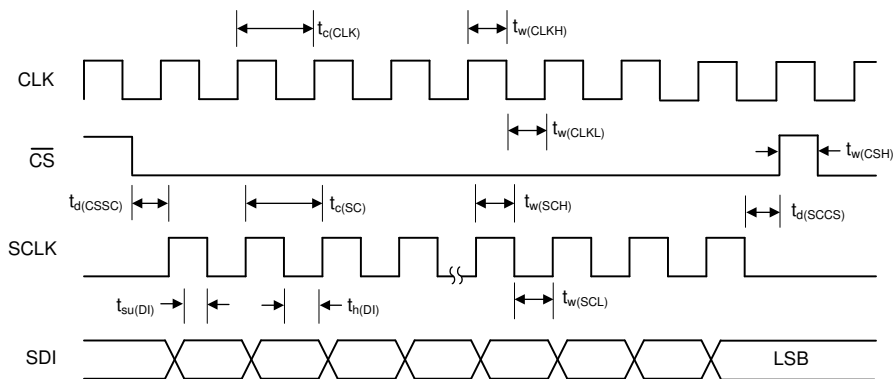


**Figure 6-1. Clock and Serial Interface Timing Requirements**

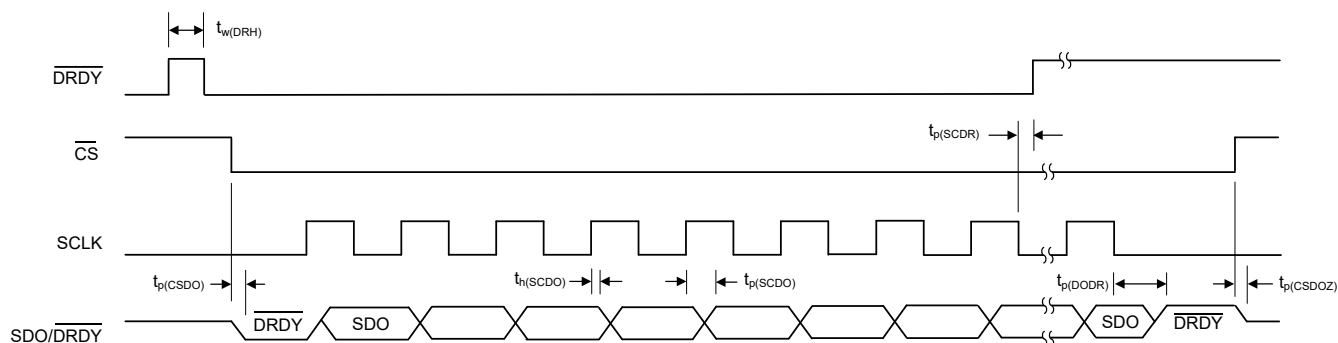


**Figure 6-2. Serial Interface Switching Characteristics**

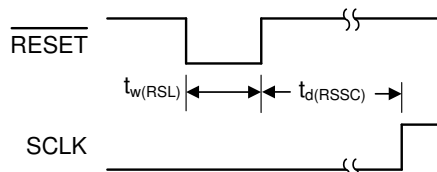


**Figure 6-3. RESET Pin Timing**

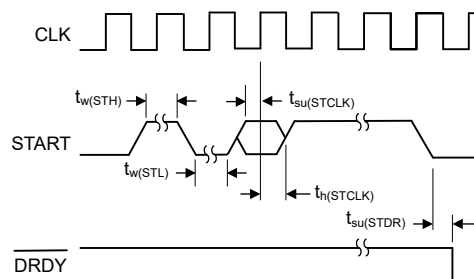


**Figure 6-4. START Pin Timing**

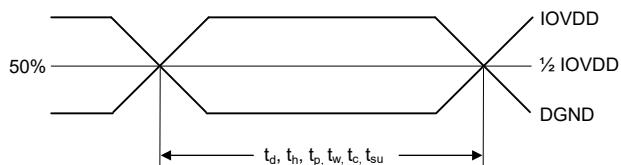
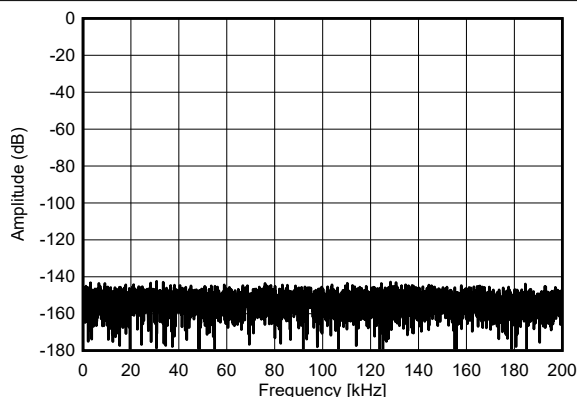


**Figure 6-5. Timing Reference**

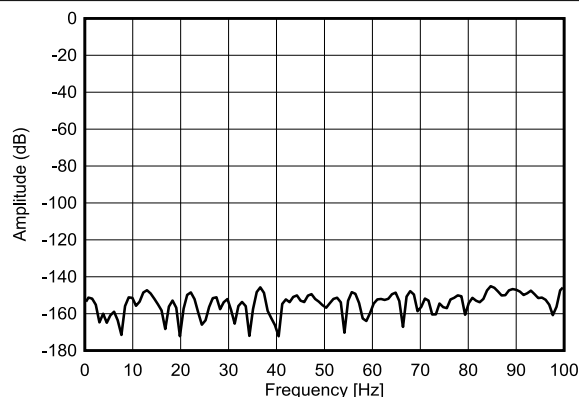
## 6.11 Typical Characteristics

AVDD1 = 5 V, AVDD2 = 5 V, AVSS = 0 V, IOVDD = 1.8 V,  $V_{REF} = 4.096$  V, high-reference range, high-speed mode, wideband filter, OSR = 32, 1x input range, input precharge buffers on, reference precharge buffer off, and  $T_A = 25^\circ\text{C}$  (unless otherwise noted)



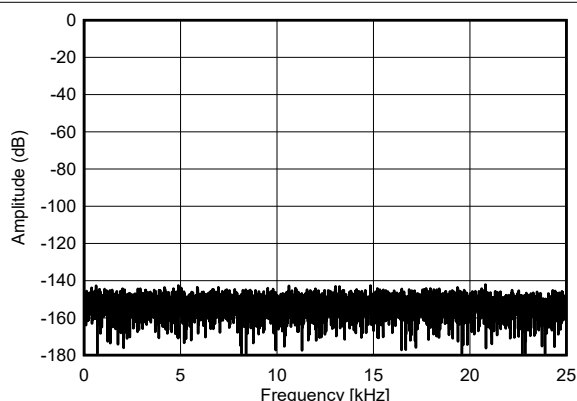
Wideband filter, OSR = 32, high-speed mode,  
524,288 samples

**Figure 6-6. Shorted Input FFT**



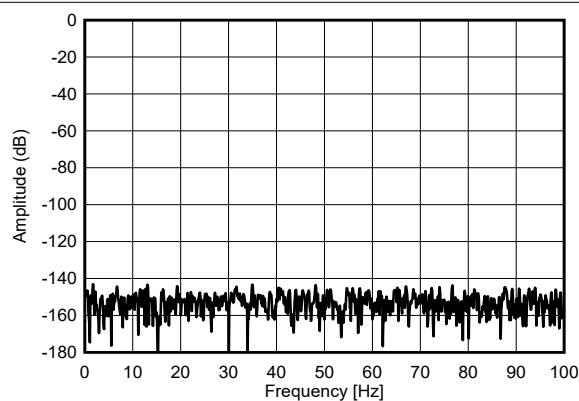
Wideband filter, OSR = 32, high-speed mode,  
524,288 samples

**Figure 6-7. Shorted Input FFT (0-Hz to 100-Hz Detail)**



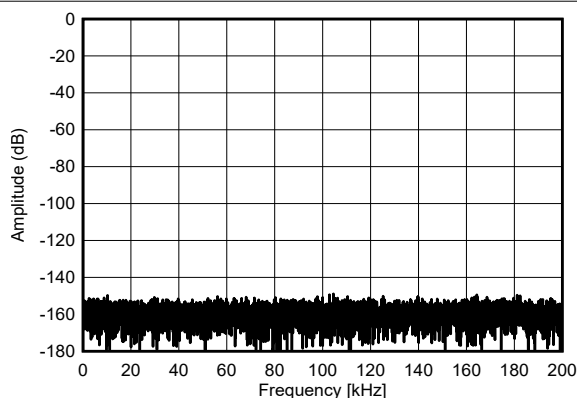
Wideband filter, OSR = 32, low-speed mode,  
524,288 samples

**Figure 6-8. Shorted Input FFT**



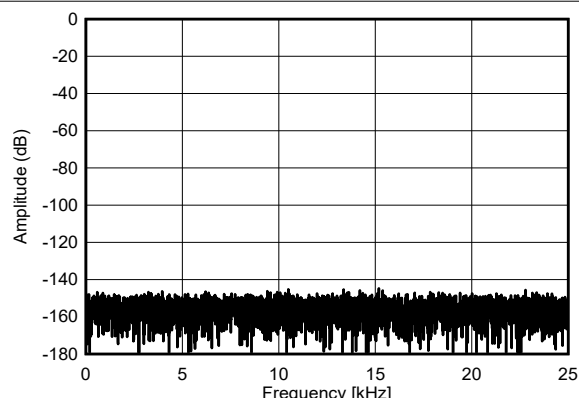
Wideband filter, OSR = 32, low-speed mode,  
524,288 samples

**Figure 6-9. Shorted Input FFT (0-Hz to 100-Hz Detail)**



2x input range,  $V_{REF} = 2.5$  V, wideband filter, OSR = 32,  
high-speed mode, 524,288 samples

**Figure 6-10. Shorted Input FFT**

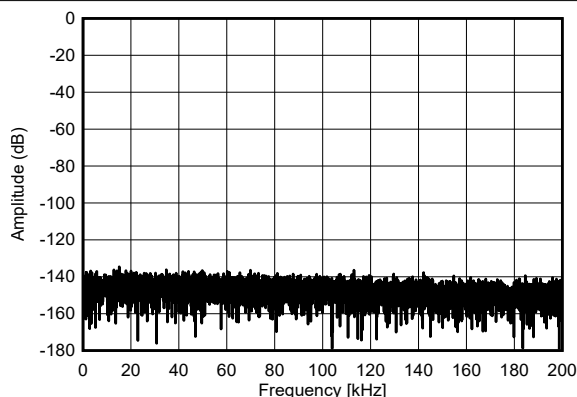


2x input range,  $V_{REF} = 2.5$  V, wideband filter, OSR = 32,  
low-speed mode, 524,288 samples

**Figure 6-11. Shorted Input FFT**

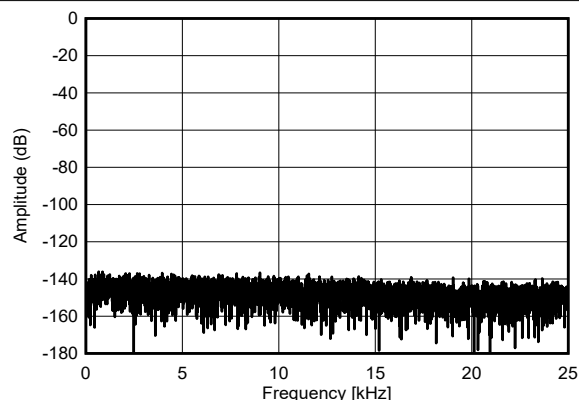
## 6.11 Typical Characteristics (continued)

AVDD1 = 5 V, AVDD2 = 5 V, AVSS = 0 V, IOVDD = 1.8 V,  $V_{REF} = 4.096$  V, high-reference range, high-speed mode, wideband filter, OSR = 32, 1x input range, input precharge buffers on, reference precharge buffer off, and  $T_A = 25^\circ\text{C}$  (unless otherwise noted)



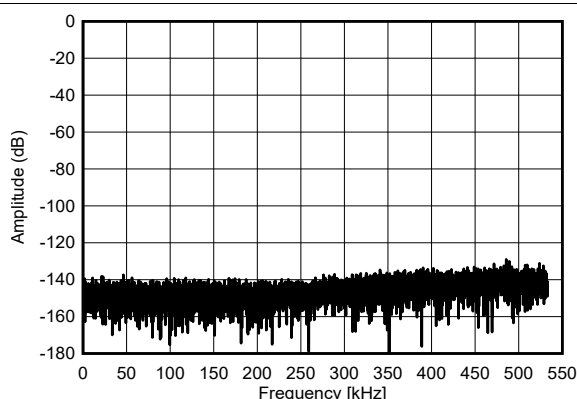
Sinc4 filter, OSR = 32, high-speed mode,  
524,288 samples

**Figure 6-12. Shorted Input FFT**



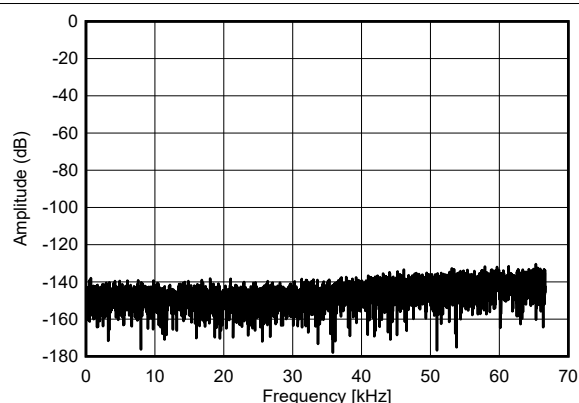
Sinc4 filter, OSR = 32, low-speed mode,  
524,288 samples

**Figure 6-13. Shorted Input FFT**



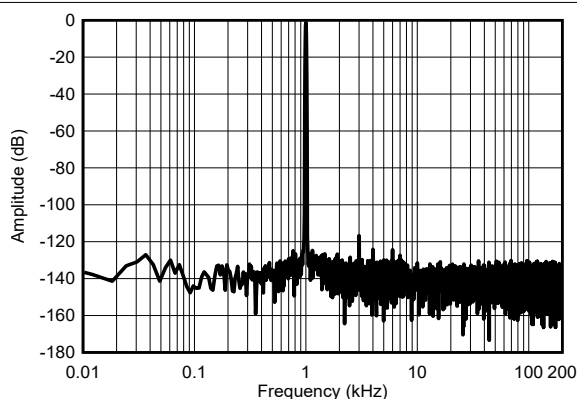
Sinc4 filter, OSR = 12, high-speed mode,  
524,288 samples

**Figure 6-14. Shorted Input FFT**



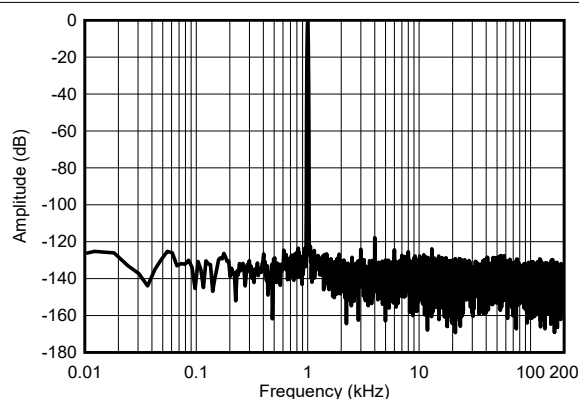
Sinc4 filter, OSR = 12, low-speed mode,  
524,288 samples

**Figure 6-15. Shorted Input FFT**



Input precharge buffers on, wideband filter, OSR = 32,  
high-speed mode,  $V_{IN} = -0.2$  dBFS, 65,536 samples

**Figure 6-16. Full-Scale Input FFT**

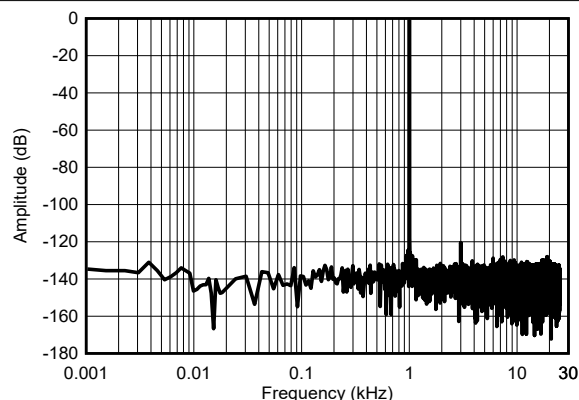


Input precharge buffers off, wideband filter, OSR = 32,  
high-speed mode,  $V_{IN} = -0.2$  dBFS, 65,536 samples

**Figure 6-17. Full-Scale Input FFT**

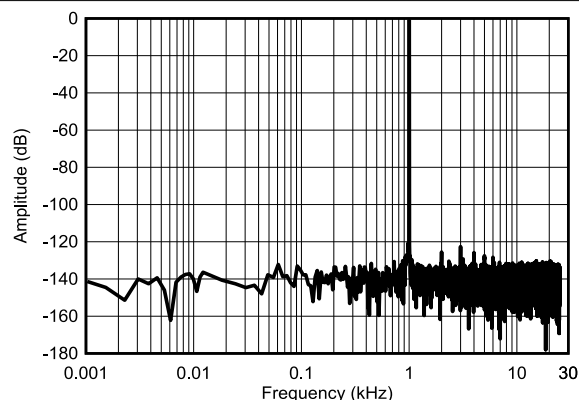
## 6.11 Typical Characteristics (continued)

AVDD1 = 5 V, AVDD2 = 5 V, AVSS = 0 V, IOVDD = 1.8 V,  $V_{REF} = 4.096$  V, high-reference range, high-speed mode, wideband filter, OSR = 32, 1x input range, input precharge buffers on, reference precharge buffer off, and  $T_A = 25^\circ\text{C}$  (unless otherwise noted)



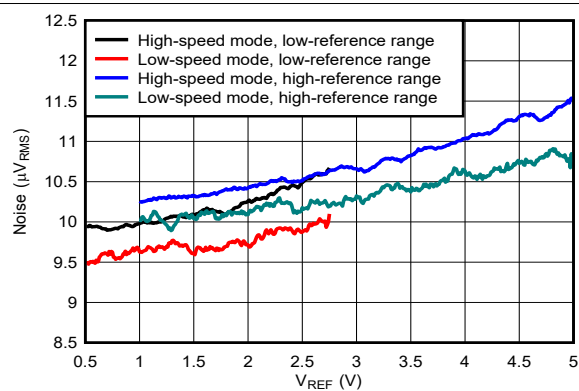
Input precharge buffers on, wideband filter, OSR = 32, low-speed mode,  $V_{IN} = -0.2$  dBFS, 65,536 samples

**Figure 6-18. Full-Scale Input FFT**



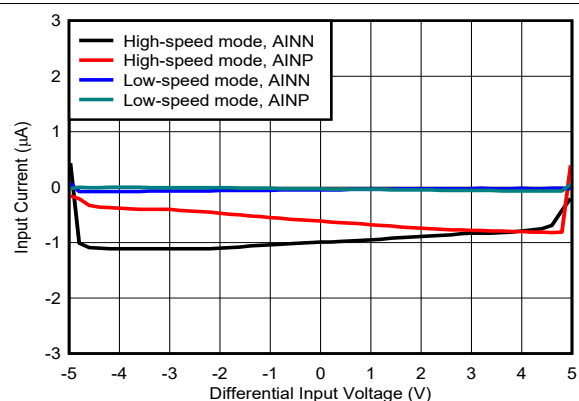
Input precharge buffers off, wideband filter, OSR = 32, low-speed mode,  $V_{IN} = -0.2$  dBFS, 65,536 samples

**Figure 6-19. Full-Scale Input FFT**



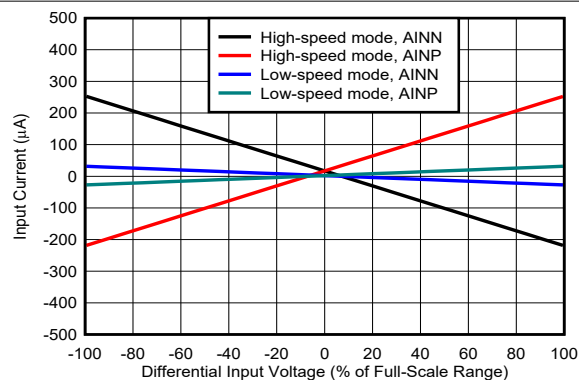
Shorted input, wideband filter, OSR = 32

**Figure 6-20. Total Noise Performance vs Reference Voltage**



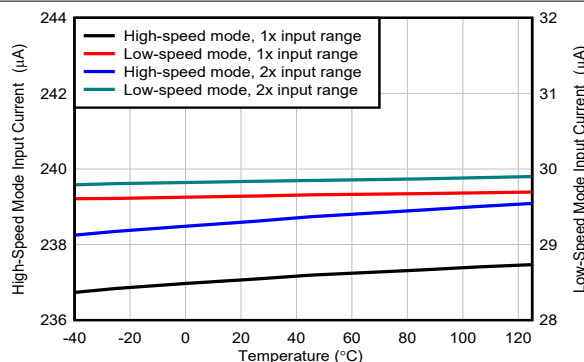
Precharge buffers on, 2x input range,  $V_{REF} = 2.5$  V,  $V_{CM} = 2.5$  V

**Figure 6-21. Input Current vs Differential Input Voltage**



Precharge buffers off, 1x and 2x input range,  $V_{REF} = 2.5$  V,  $V_{CM} = 2.5$  V

**Figure 6-22. Input Current vs Differential Input Voltage**

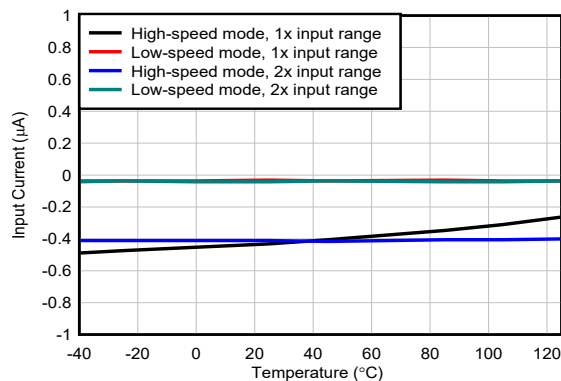


$V_{IN} = \text{full scale}$ ,  $V_{CM} = 2.5$  V, precharge buffers off

**Figure 6-23. Input Current vs Temperature**

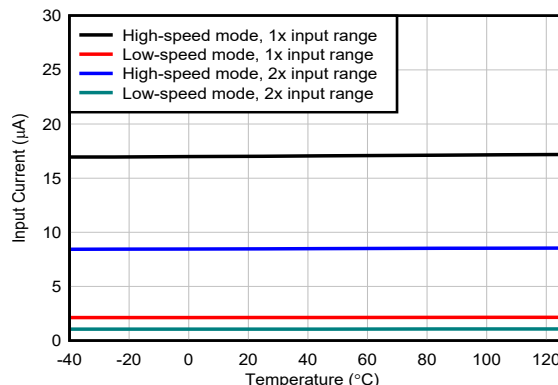
## 6.11 Typical Characteristics (continued)

AVDD1 = 5 V, AVDD2 = 5 V, AVSS = 0 V, IOVDD = 1.8 V,  $V_{REF} = 4.096$  V, high-reference range, high-speed mode, wideband filter, OSR = 32, 1x input range, input precharge buffers on, reference precharge buffer off, and  $T_A = 25^\circ\text{C}$  (unless otherwise noted)



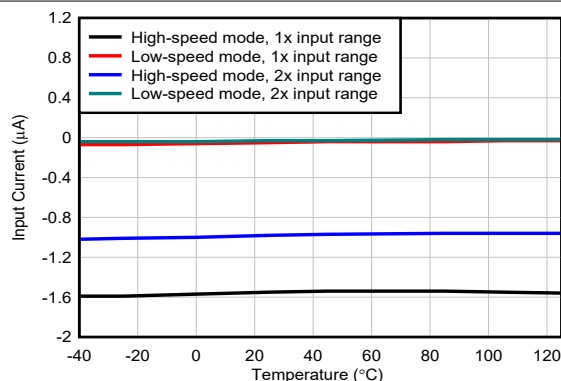
$V_{IN} = \text{full scale}$ ,  $V_{CM} = 2.5$  V, precharge buffers on

**Figure 6-24. Input Current vs Temperature**



$V_{IN} = 0$  V,  $V_{CM} = 2.5$  V, precharge buffers off

**Figure 6-25. Input Current vs Temperature**



$V_{IN} = 0$  V,  $V_{CM} = 2.5$  V, precharge buffers on

**Figure 6-26. Input Current vs Temperature**

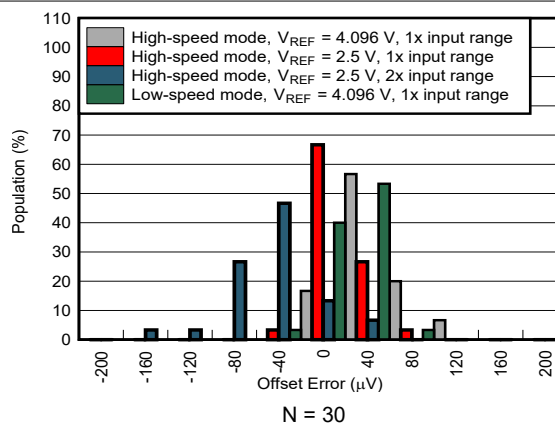


**Figure 6-27. Offset Error Distribution**

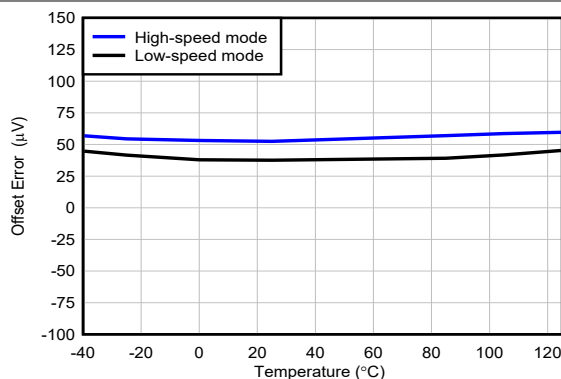


**Figure 6-28. Offset Error vs Temperature**

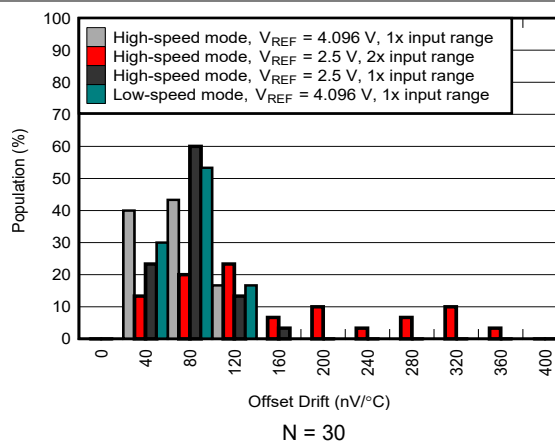
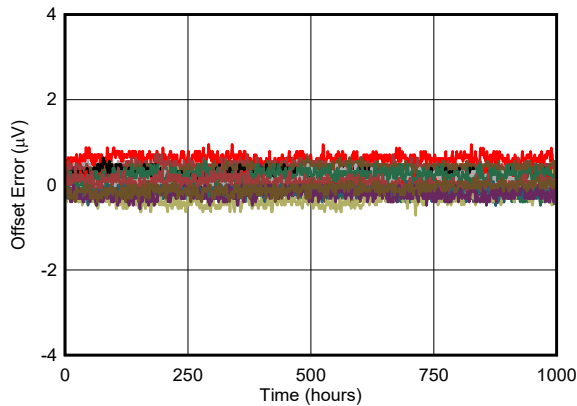


**Figure 6-29. Offset Drift Distribution**

## 6.11 Typical Characteristics (continued)

AVDD1 = 5 V, AVDD2 = 5 V, AVSS = 0 V, IOVDD = 1.8 V,  $V_{REF} = 4.096$  V, high-reference range, high-speed mode, wideband filter, OSR = 32, 1x input range, input precharge buffers on, reference precharge buffer off, and  $T_A = 25^\circ\text{C}$  (unless otherwise noted)



N = 30, offset error calibrated at t = 0  
**Figure 6-30. Long-Term Offset Drift**

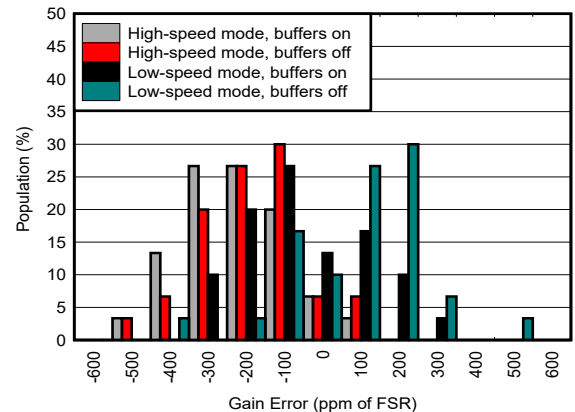


**Figure 6-31. Gain Error Distribution**

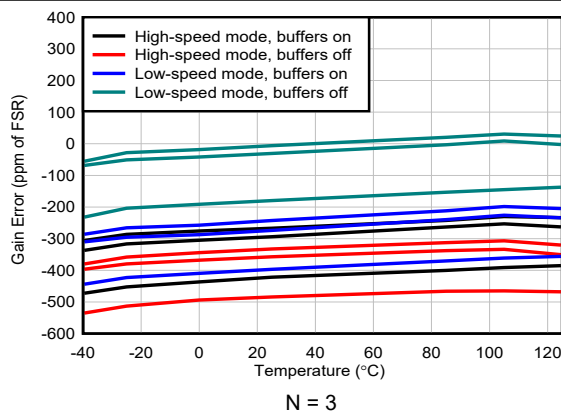


**Figure 6-32. Gain Error vs Temperature**

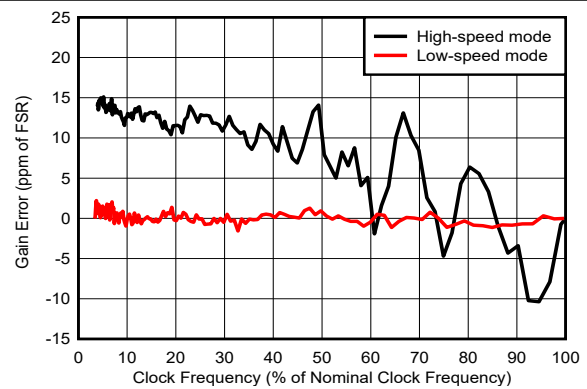


**Figure 6-33. Gain Error vs Clock Frequency**

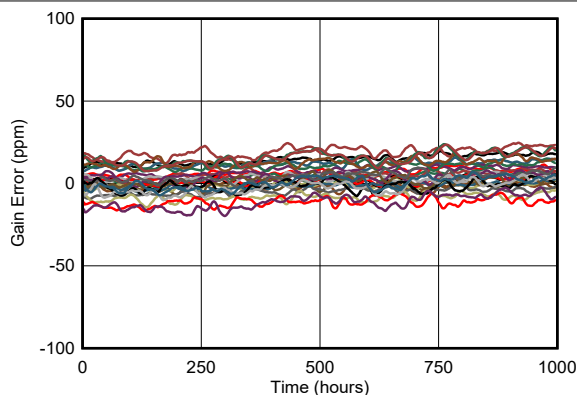


**Figure 6-34. Long-Term Gain Drift**

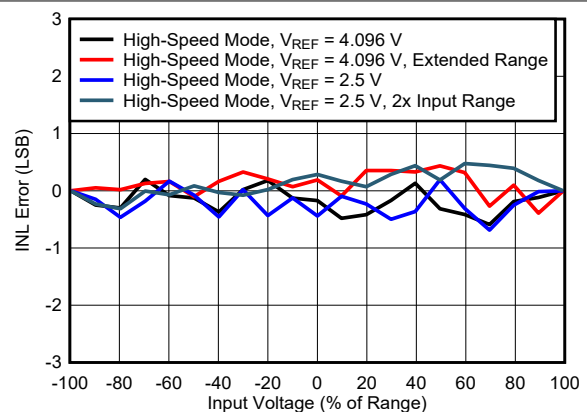


**Figure 6-35. INL Error vs Input Voltage**

## 6.11 Typical Characteristics (continued)

AVDD1 = 5 V, AVDD2 = 5 V, AVSS = 0 V, IOVDD = 1.8 V,  $V_{REF} = 4.096$  V, high-reference range, high-speed mode, wideband filter, OSR = 32, 1x input range, input precharge buffers on, reference precharge buffer off, and  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

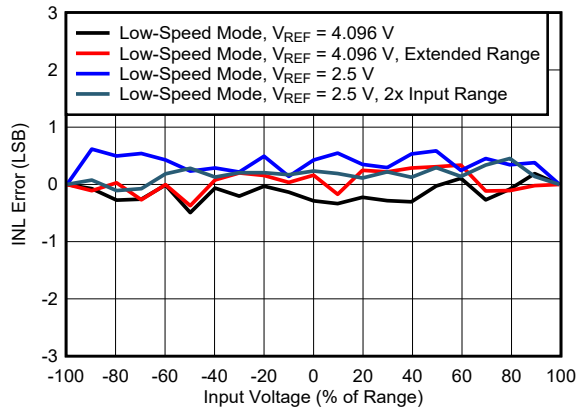


Figure 6-36. INL Error vs Input Voltage

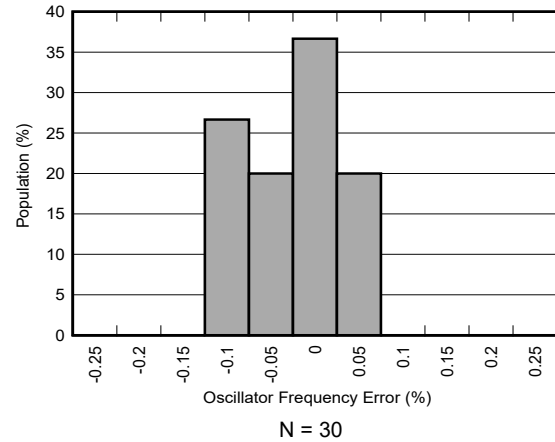


Figure 6-37. Oscillator Frequency Distribution

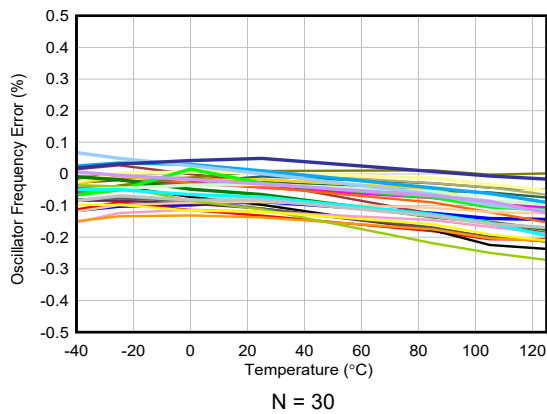


Figure 6-38. Oscillator Frequency vs Temperature

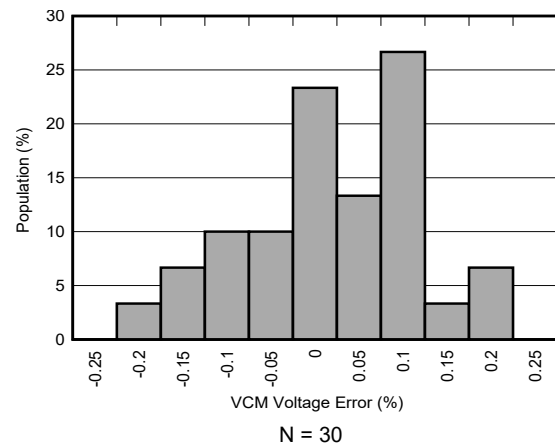


Figure 6-39. VCM Voltage Distribution

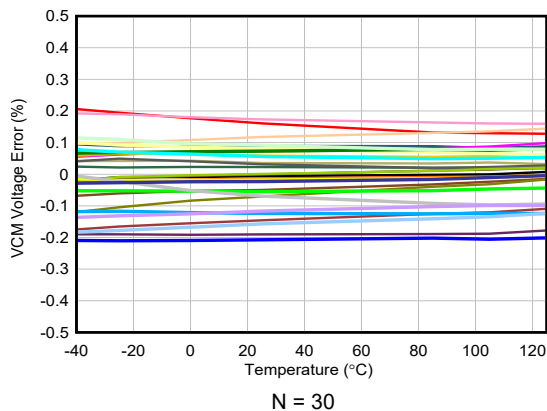


Figure 6-40. VCM Voltage Error vs Temperature

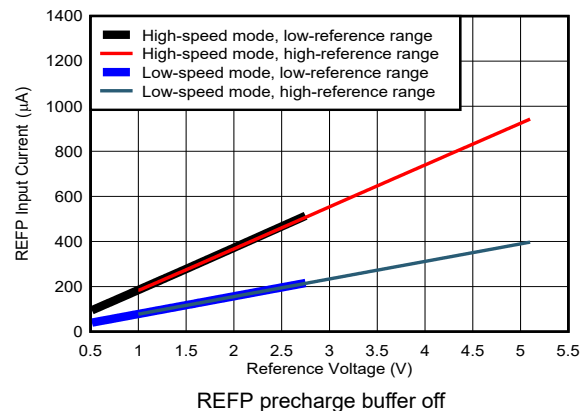


Figure 6-41. REFP Input Current vs Reference Voltage

## 6.11 Typical Characteristics (continued)

AVDD1 = 5 V, AVDD2 = 5 V, AVSS = 0 V, IOVDD = 1.8 V,  $V_{REF} = 4.096$  V, high-reference range, high-speed mode, wideband filter, OSR = 32, 1x input range, input precharge buffers on, reference precharge buffer off, and  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

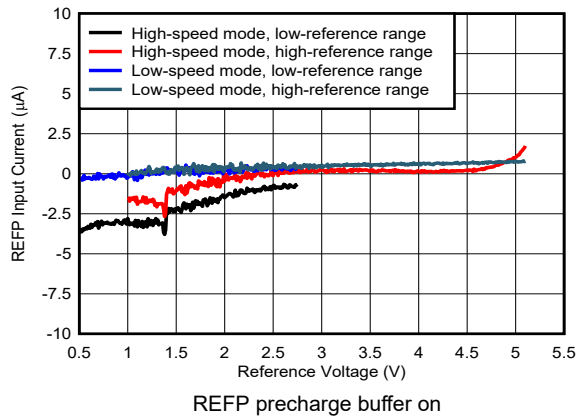


**Figure 6-42. REFP Input Current vs Reference Voltage**

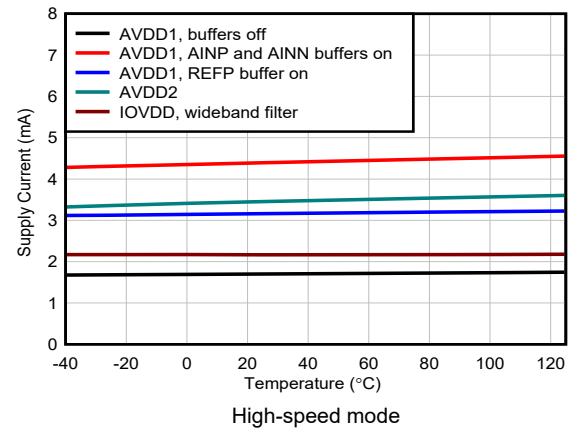


**Figure 6-43. Power-Supply Current vs Temperature**

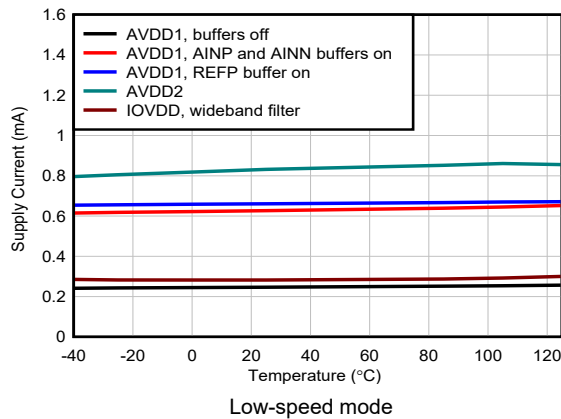


**Figure 6-44. Power-Supply Current vs Temperature**

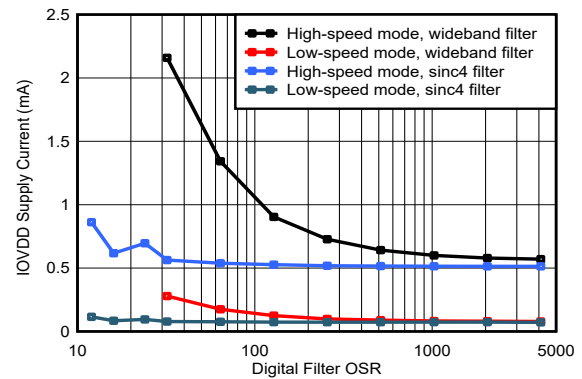


**Figure 6-45. IOVDD Current vs Oversampling Ratio**

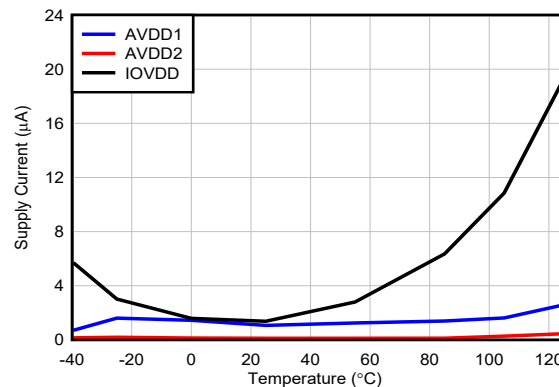


**Figure 6-46. Power-Down Mode Supply Current vs Temperature**

## 7 Parameter Measurement Information

### 7.1 Offset Error Measurement

Offset error is measured with the ADC inputs externally shorted together. The input common-mode voltage is fixed to the mid-point of the AVDD1 and AVSS power-supply range. Offset error is specified at  $T_A = 25^\circ\text{C}$ .

### 7.2 Offset Drift Measurement

Offset drift is defined as the change in offset voltage measured at multiple points over the specified temperature range. Offset drift is calculated using the *box method* in which a box is formed over the maximum and minimum offset voltages and over the specified temperature range. The box method specifies limits for the temperature error but does not specify the exact shape and slope of the device under test.

Equation 1 shows the offset drift calculation using the box method:

$$\text{Offset Drift (nV/}^\circ\text{C)} = 10^9 \cdot (V_{\text{OFSMAX}} - V_{\text{OFSMIN}}) / (T_{\text{MAX}} - T_{\text{MIN}}) \quad (1)$$

where:

- $V_{\text{OFSMAX}}$  and  $V_{\text{OFSMIN}}$  = Maximum and minimum offset voltages over the specified temperature range
- $T_{\text{MAX}}$  and  $T_{\text{MIN}}$  = Maximum and minimum temperatures

### 7.3 Gain Error Measurement

Gain error is defined as the difference between the actual and the ideal slopes of the ADC transfer function. Gain error is measured by applying dc test voltages at –95% and 95% of FSR. The error is calculated by subtracting the difference of the dc test voltages (ideal slope) from the difference in the ADC output voltages (actual slope). The difference in the slopes is divided by the ideal slope and multiplied by  $10^6$  to convert the error to ppm of FSR. Error resulting from the ADC reference voltage is excluded from the gain error measurement. The gain error is specified at  $T_A = 25^\circ\text{C}$ . Equation 2 shows the calculation of gain error:

$$\text{Gain Error (ppm of FSR)} = 10^6 \cdot (\Delta V_{\text{OUT}} - \Delta V_{\text{IN}}) / \Delta V_{\text{IN}} \quad (2)$$

where:

- $\Delta V_{\text{OUT}}$  = Difference of two ADC output voltages
- $\Delta V_{\text{IN}}$  = Difference of two input test voltages

### 7.4 Gain Drift Measurement

Gain drift is defined as the change of gain error measured at multiple points over the specified temperature range. The box method is used in which a box is formed over the maximum and minimum gain errors over the specified temperature range. The box method specifies limits for the temperature error but does not specify the exact shape and slope of the device under test. Equation 3 describes gain drift using the box method.

$$\text{Gain Drift (ppm/}^\circ\text{C)} = (GE_{\text{MAX}} - GE_{\text{MIN}}) / (T_{\text{MAX}} - T_{\text{MIN}}) \quad (3)$$

where:

- $GE_{\text{MAX}}$  and  $GE_{\text{MIN}}$  = Maximum and minimum gain errors over the specified temperature range
- $T_{\text{MAX}}$  and  $T_{\text{MIN}}$  = Maximum and minimum temperatures

### 7.5 NMRR Measurement

Normal-mode rejection ratio (NMRR) specifies the ability of the ADC to reject normal-mode input signals at specific frequencies, usually expressed at 50-Hz and 60-Hz input frequencies. Normal-mode rejection is uniquely determined by the frequency response of the digital filter. In this case, the nulls in the frequency response of the low-latency sinc3 filter option located at 50 Hz and 60 Hz provide rejection at these frequencies.

## 7.6 CMRR Measurement

Common-mode rejection ratio (CMRR) specifies the ability of the ADC to reject common-mode input signals. CMRR is expressed as dc and ac parameters. For measurement of CMRR (dc), three common-mode test voltages equal to  $AVSS + 50\text{ mV}$ ,  $(AVDD1 + AVSS) / 2$ , and  $AVDD1 - 50\text{ mV}$  are applied with the inputs externally shorted together. The maximum change of the ADC offset voltage is recorded versus the change in common-mode test voltage. Equation 4 shows how CMRR (dc) is computed.

$$\text{CMRR (dc) (dB)} = 20 \cdot \log(\Delta V_{\text{CM}} / \Delta V_{\text{OS}}) \quad (4)$$

where:

- $\Delta V_{\text{CM}}$  = Change of dc common-mode test voltage
- $\Delta V_{\text{OS}}$  = Change of corresponding offset voltage

For the measurement of CMRR (ac), an ac common-mode signal is applied at various test frequencies at 95% full-scale range. An FFT is computed from the ADC data with the common-mode signal applied. As shown in Equation 5, the nine largest amplitude spurious frequencies in the frequency spectrum are summed as powers and related to the amplitude of the common-mode test signal.

$$\text{PSRR (ac) (dB)} = 20 \cdot \log(V_{\text{CM}} / V_{\text{O}}) \quad (5)$$

where:

- $V_{\text{CM}}$  (RMS) = Common-mode input signal amplitude
- $V_{\text{O}}$  (RMS) = Root-sum-square amplitude of spurious frequencies =  $\sqrt{V_0^2 + V_1^2 + \dots V_8^2}$

## 7.7 PSRR Measurement

Power-supply rejection ratio (PSRR) specifies the ability of the ADC to reject power-supply interference. PSRR is expressed as ac and dc parameters. For measurement of PSRR (dc), the power-supply voltage is changed over the range of minimum, nominal, and maximum specified voltages with the inputs externally shorted together. The maximum change of ADC offset voltage is recorded versus the change in power-supply voltage. PSRR (dc) is computed as shown in Equation 6 as the ratio of change of the power-supply voltage step to the change of offset voltage.

$$\text{PSRR (dc) (dB)} = 20 \cdot \log(\Delta V_{\text{PS}} / \Delta V_{\text{OS}}) \quad (6)$$

where:

- $\Delta V_{\text{PS}}$  = Change of power-supply voltage
- $\Delta V_{\text{OS}}$  = Change of offset voltage

For the measurement of PSRR (ac), the power-supply voltage is modulated by a 100-mVpp (35 mV<sub>RMS</sub>) signal at various test frequencies. An FFT of the ADC data with power-supply modulation is performed. As shown in Equation 7, the nine largest amplitude spurious frequencies in the frequency spectrum are summed as powers and related to the amplitude of the power-supply modulation signal.

$$\text{PSRR (ac) (dB)} = 20 \cdot \log(V_{\text{PS}} / V_{\text{O}}) \quad (7)$$

where:

- $V_{\text{PS}}$  (RMS) = 100 mV ac power-supply modulation signal
- $V_{\text{O}}$  (RMS) = Root-sum-square amplitude of spurious frequencies =  $\sqrt{V_0^2 + V_1^2 + \dots V_8^2}$

## 7.8 INL Error Measurement

Integral nonlinearity (INL) error specifies the linearity of the ADC transfer function. INL is measured by applying a series of dc test voltages along a straight line computed from the slope and offset transfer function of the ADC. INL is the difference between a set of dc test voltages  $[V_{IN(N)}]$  to the corresponding set of output voltages  $[V_{OUT(N)}]$ . Equation 8 shows the *end-point method* of calculating INL error.

$$\text{INL (LSB)} = \text{maximum (absolute value) of INL test series } [2^{16} \cdot (V_{IN(N)} - V_{OUT(N)}) / \text{FSR}] \quad (8)$$

where:

- N = Index of dc test voltage
- $[V_{IN(N)}]$  = Set of test voltages over the range –95% to 95% of FSR
- $[V_{OUT(N)}]$  = Set of corresponding ADC output voltages
- FSR (full-scale range) =  $2 \cdot V_{REF}$  (1x input range) or  $4 \cdot V_{REF}$  (2x input range)

The INL *best-fit method* uses a least-squared error (LSE) calculation to determine a new straight line to minimize the root-sum-square of the INL errors above and below the original end-point line.

## 7.9 THD Measurement

Total harmonic distortion (THD) specifies the dynamic linearity of the ADC with an ac input signal. For the THD measurement, a –0.2-dBFS, 1-kHz differential input signal with  $V_{CM}$  equal to the mid-supply voltage is applied. A sufficient number of data points are collected to yield an FFT result with frequency bin widths of 5 Hz or less. The 5-Hz bin width reduces the noise in the harmonic bins for consistent THD measurements. As shown in Equation 9, THD is calculated as the ratio of the root-sum-square amplitude of harmonics to the input signal amplitude.

$$\text{THD (dB)} = 20 \cdot \log(V_H / V_{IN}) \quad (9)$$

where:

- $V_H$  = Root-sum-square of harmonics:  $\sqrt{(V_2^2 + V_3^2 + \dots + V_n^2)}$ , where  $V_n$  = Ninth harmonic voltage
- $V_{IN}$  = Input signal fundamental

## 7.10 SFDR Measurement

Spurious-free dynamic range (SFDR) is the ratio of the rms value of a single-tone ac input to the highest spurious signal in the ADC frequency spectrum. SFDR measurement includes harmonics of the original signal. For the SFDR measurement, a –0.2-dBFS, 1-kHz input signal with  $V_{CM}$  equal to the mid-supply voltage is applied. As shown in Equation 10, SFDR is the ratio of the rms values of the input signal to the single highest spurious signal, including harmonics of the original signal.

$$\text{SFDR (dB)} = 20 \cdot \log(V_{IN} / V_{SPUR}) \quad (10)$$

where:

- $V_{IN}$  = Input test signal
- $V_{SPUR}$  = Single highest spurious level

## 7.11 Noise Performance

The ADC provides two operating speed modes (high speed and low speed) that allow trade-offs between power consumption and signal bandwidth. Low-speed mode operates the modulator at 1/8th speed for decreased device power consumption and, as a result, the output data rates are reduced by 1/8th. The programmable oversampling ratio (OSR) determines the output data rate and associated signal bandwidth, and therefore also determines noise performance at the sub-LSB level.

The wideband filter provides data rates up to 400 kSPS in high-speed mode and 50 kSPS in low-speed mode. The low-latency sinc4 filter provides data rates up to 1.067 MSPS in high-speed mode and up to 133 kSPS in low-speed mode. The low-latency filter provides the options of sinc4, sinc4 + sinc1, sinc3, and sinc3 + sinc1 configurations.

For dc-signal measurements, the ADC noise can result in code flicker between adjacent code values. The probability of code flicker depends on the location of the signal input relative to the next code transition and the amplitude of the ADC noise combined with noise present within the signal. The ADC peak-to-peak noise value is typically  $6.6 \times$  the RMS noise value. Code flicker results when the amplitude of noise is large enough to trigger a code transition.

The quantization error of any ADC is  $\pm 0.5$  LSB. When an ac signal is applied, the quantization *error* becomes a quantization *noise*. [Figure 7-1](#) shows the quantization error converting to noise (LSB error plot) as the signal changes. For non-coherent sampling, this quantization noise is approximated as *white* noise, spread evenly across the frequency band. For any N-bit ADC, the signal-to-*quantization* noise ratio (SQNR) is as follows:  $SQNR \text{ (dB)} = 6.02 \times N + 1.76$ . For a 16-bit ADC, the SQNR is 98.1 dB.

The SNR of an ADC is determined by the sum of the device thermal noise and the device quantization noise. For most data rates of the ADS117L11, the quantization noise is larger than the thermal noise, therefore the SNR is equal to SQNR.

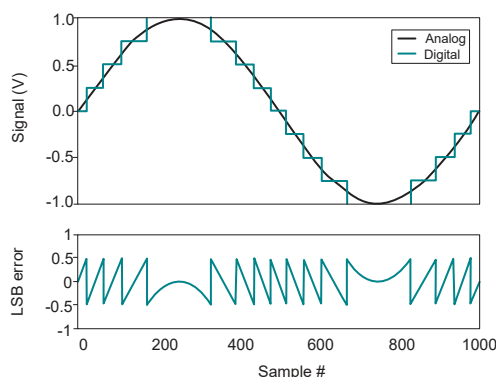


**Figure 7-1. Quantization Noise of AC Signal Input**

[Table 7-1](#) through [Table 7-5](#) summarize the noise and SNR performance and signal bandwidth of the digital filter modes. Noise and SNR performance is specified with the 1x input range and a 4.096-V reference voltage. SNR performance when operating with a 2.5-V reference voltage (1x or 2x input range) is approximately –1 dB lower at OSR = 32, increasing to the same SNR performance at OSR = 128 and above.

**Table 7-1. Wideband Filter Performance ( $V_{REF} = 4.096$  V, 1x Input Range)**

| OSR                                                      | DATA RATE (kSPS) | -0.1-dB FREQUENCY (kHz) | NOISE ( $\mu V_{RMS}$ ) | SNR (dB) |
|----------------------------------------------------------|------------------|-------------------------|-------------------------|----------|
| <b>HIGH-SPEED MODE (<math>f_{CLK} = 25.6</math> MHz)</b> |                  |                         |                         |          |
| 32                                                       | 400              | 165.000                 | 10.6                    | 97.3     |
| 64                                                       | 200              | 82.500                  | 7.47                    | 97.5     |
| 128                                                      | 100              | 41.250                  | 5.20                    | 97.8     |
| 256                                                      | 50               | 20.625                  | 3.66                    | 98.0     |
| 512                                                      | 25               | 10.312                  | 2.58                    | 98.0     |
| 1024                                                     | 12.5             | 5.156                   | 1.83                    | 98.0     |
| 2048                                                     | 6.25             | 2.578                   | 1.29                    | 98.0     |
| 4096                                                     | 3.125            | 1.289                   | 0.92                    | 98.0     |
| <b>LOW-SPEED MODE (<math>f_{CLK} = 3.2</math> MHz)</b>   |                  |                         |                         |          |
| 32                                                       | 50               | 20.625                  | 10.6                    | 97.3     |
| 64                                                       | 25               | 10.312                  | 7.47                    | 97.5     |
| 128                                                      | 12.5             | 5.156                   | 5.20                    | 97.8     |
| 256                                                      | 6.25             | 2.578                   | 3.66                    | 98.0     |
| 512                                                      | 3.125            | 1.289                   | 2.58                    | 98.0     |
| 1024                                                     | 1.5625           | 0.645                   | 1.83                    | 98.0     |
| 2048                                                     | 0.78125          | 0.322                   | 1.29                    | 98.0     |
| 4096                                                     | 0.390625         | 0.161                   | 0.92                    | 98.0     |

**Table 7-2. Sinc4 Filter Performance ( $V_{REF} = 4.096$  V, 1x Input Range)**

| OSR                                                      | DATA RATE (kSPS) | -3-dB FREQUENCY (kHz) | NOISE ( $\mu V_{RMS}$ ) | SNR (dB) |
|----------------------------------------------------------|------------------|-----------------------|-------------------------|----------|
| <b>HIGH-SPEED MODE (<math>f_{CLK} = 25.6</math> MHz)</b> |                  |                       |                         |          |
| 12                                                       | 1066.666         | 242.666               | 76.3                    | 90.5     |
| 16                                                       | 800              | 182.000               | 27.3                    | 96.0     |
| 24                                                       | 533.333          | 121.333               | 10.4                    | 97.5     |
| 32                                                       | 400              | 91.000                | 7.96                    | 97.7     |
| 64                                                       | 200              | 45.500                | 5.57                    | 98.0     |
| 128                                                      | 100              | 22.750                | 3.90                    | 98.0     |
| 256                                                      | 50               | 11.375                | 2.80                    | 98.0     |
| 512                                                      | 25               | 5.687                 | 1.98                    | 98.0     |
| 1024                                                     | 12.5             | 2.844                 | 1.40                    | 98.0     |
| 2048                                                     | 6.25             | 1.422                 | 0.99                    | 98.0     |
| 4096                                                     | 3.125            | 0.711                 | 0.70                    | 98.0     |
| <b>LOW-SPEED MODE (<math>f_{CLK} = 3.2</math> MHz)</b>   |                  |                       |                         |          |
| 12                                                       | 133.333          | 30.333                | 76.3                    | 90.5     |
| 16                                                       | 100              | 22.750                | 27.3                    | 96.0     |
| 24                                                       | 66.666           | 15.166                | 10.4                    | 97.5     |
| 32                                                       | 50               | 11.375                | 7.96                    | 97.7     |
| 64                                                       | 25               | 5.687                 | 5.57                    | 98.0     |
| 128                                                      | 12.5             | 2.844                 | 3.90                    | 98.0     |
| 256                                                      | 6.25             | 1.422                 | 2.80                    | 98.0     |
| 512                                                      | 3.125            | 0.711                 | 1.98                    | 98.0     |
| 1024                                                     | 1.5625           | 0.355                 | 1.40                    | 98.0     |
| 2048                                                     | 0.78125          | 0.177                 | 0.99                    | 98.0     |
| 4096                                                     | 0.390625         | 0.089                 | 0.70                    | 98.0     |

**Table 7-3. Sinc4 + Sinc1 Filter Performance ( $V_{REF} = 4.096\text{ V}$ , 1x Input Range)**

| SINC4 OSR                                                       | SINC1 OSR | DATA RATE (kSPS) | -3-dB FREQUENCY (kHz) | NOISE ( $\mu\text{V}_{RMS}$ ) | SNR (dB) |
|-----------------------------------------------------------------|-----------|------------------|-----------------------|-------------------------------|----------|
| <b>HIGH-SPEED MODE (<math>f_{CLK} = 25.6\text{ MHz}</math>)</b> |           |                  |                       |                               |          |
| 32                                                              | 2         | 200              | 68.35                 | 5.63                          | 98.0     |
| 32                                                              | 4         | 100              | 40.97                 | 3.98                          | 98.0     |
| 32                                                              | 10        | 40               | 17.47                 | 2.81                          | 98.0     |
| 32                                                              | 20        | 20               | 8.814                 | 1.99                          | 98.0     |
| 32                                                              | 40        | 10               | 4.420                 | 1.41                          | 98.0     |
| 32                                                              | 100       | 4                | 1.770                 | 0.99                          | 98.0     |
| 32                                                              | 200       | 2                | 0.885                 | 0.70                          | 98.0     |
| 32                                                              | 400       | 1                | 0.442                 | 0.52                          | 98.0     |
| 32                                                              | 1000      | 0.4              | 0.177                 | 0.39                          | 98.0     |
| <b>LOW-SPEED MODE (<math>f_{CLK} = 3.2\text{ MHz}</math>)</b>   |           |                  |                       |                               |          |
| 32                                                              | 2         | 25               | 8.544                 | 5.63                          | 98.0     |
| 32                                                              | 4         | 12.5             | 5.121                 | 3.98                          | 98.0     |
| 32                                                              | 10        | 5                | 2.184                 | 2.81                          | 98.0     |
| 32                                                              | 20        | 2.5              | 1.102                 | 1.99                          | 98.0     |
| 32                                                              | 40        | 1.25             | 0.552                 | 1.41                          | 98.0     |
| 32                                                              | 100       | 0.5              | 0.221                 | 0.99                          | 98.0     |
| 32                                                              | 200       | 0.25             | 0.111                 | 0.70                          | 98.0     |
| 32                                                              | 400       | 0.125            | 0.055                 | 0.52                          | 98.0     |
| 32                                                              | 1000      | 0.05             | 0.022                 | 0.39                          | 98.0     |

**Table 7-4. Sinc3 Filter Performance ( $V_{REF} = 4.096\text{ V}$ , 1x Input Range)**

| OSR                                                             | DATA RATE (SPS) | -3-dB FREQUENCY (Hz) | NOISE ( $\mu\text{V}_{RMS}$ ) | SNR (dB) |
|-----------------------------------------------------------------|-----------------|----------------------|-------------------------------|----------|
| <b>HIGH-SPEED MODE (<math>f_{CLK} = 25.6\text{ MHz}</math>)</b> |                 |                      |                               |          |
| 26667                                                           | 480             | 126                  | 0.29                          | 98.0     |
| 32000                                                           | 400             | 105                  | 0.27                          | 98.0     |
| <b>LOW-SPEED MODE (<math>f_{CLK} = 3.2\text{ MHz}</math>)</b>   |                 |                      |                               |          |
| 26667                                                           | 60              | 16                   | 0.29                          | 98.0     |
| 32000                                                           | 50              | 13                   | 0.27                          | 98.0     |

**Table 7-5. Sinc3 + Sinc1 Filter Performance ( $V_{REF} = 4.096\text{ V}$ , 1x Input Range)**

| SINC3 OSR                                                       | SINC1 OSR | DATA RATE (SPS) | -3-dB FREQUENCY (Hz) | NOISE ( $\mu\text{V}_{RMS}$ ) | SNR (dB) |
|-----------------------------------------------------------------|-----------|-----------------|----------------------|-------------------------------|----------|
| <b>HIGH-SPEED MODE (<math>f_{CLK} = 25.6\text{ MHz}</math>)</b> |           |                 |                      |                               |          |
| 32000                                                           | 3         | 133.3           | 54                   | 0.19                          | 98.0     |
| 32000                                                           | 5         | 80              | 34                   | 0.15                          | 98.0     |
| <b>LOW-SPEED MODE (<math>f_{CLK} = 3.2\text{ MHz}</math>)</b>   |           |                 |                      |                               |          |
| 32000                                                           | 3         | 16.6            | 6.7                  | 0.19                          | 98.0     |
| 32000                                                           | 5         | 10              | 4.3                  | 0.15                          | 98.0     |

## 8 Detailed Description

### 8.1 Overview

The ADS117L11 is a high-performance, 16-bit, delta-sigma ( $\Delta\Sigma$ ) analog-to-digital converter (ADC) offering an excellent combination of dc accuracy and ac performance. The device is optimized to provide high resolution with low power consumption. Integrated input and reference precharge buffers simplify the driver requirements. The digital filter consists of two programmable modes: low-latency mode (typically used for measuring dc signals) and wideband mode (typically used for measuring ac signals).

The delta-sigma modulator produces low-resolution, high-frequency data proportional to the signal magnitude. Noise shaping within the modulator shifts the quantization noise of the low-resolution data to an out-of-band frequency range where the noise is removed by the digital filter. The noise remaining within the pass band is white, which is reduced by the digital filter. The digital filter simultaneously decimates and filters the modulator data to provide the high-resolution final output data.

The *Functional Block Diagram* shows the features of the ADS117L11. The modulator is a third-order, multibit delta-sigma design that measures the differential input signal,  $V_{IN} = (V_{AINP} - V_{AINN})$ , against the differential reference,  $V_{REF} = (V_{REFP} - V_{REFN})$ . Input and positive reference precharge buffers reduce the bandwidth and driving requirements of the external input driver. The VCM output provides a buffered mid-supply voltage to drive the common-mode voltage of an external driver stage.

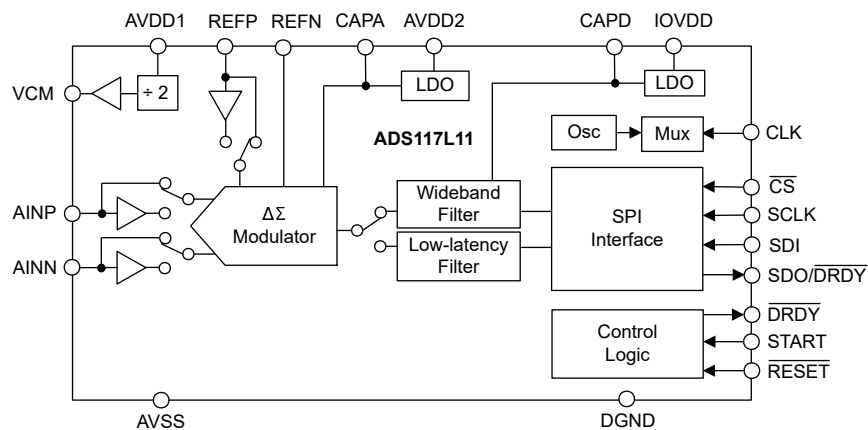
The digital filter offers two modes of operation: the low-latency filter and the wideband filter. The low-latency filter is programmable to sinc4, sinc4 + sinc1, sinc3, and sinc3 + sinc1 modes, allowing optimization between noise performance and latency. The sinc3 + sinc1 filter provides rejection at 400 Hz, 60 Hz, 50 Hz, and 16.6 Hz. The wideband filter is a multi-tap finite impulse response (FIR) design providing outstanding frequency response with low pass-band ripple, steep transition-band, and high stop-band attenuation. Programmable oversampling ratio (OSR) and two speed modes allow optimized choices of bandwidth, resolution, and device power consumption.

The SPI-compatible serial interface is used to configure the device and read conversion data. The interface features daisy-chaining capability for convenient connection of multichannel, simultaneous-sampled systems. Integrated cyclic redundancy check (CRC) error monitoring improves system-level reliability.  $\overline{\text{DRDY}}$  is the conversion data-ready output signal.

The device supports external clock operation for ac or dc applications, and internal oscillator operation for dc applications. The START pin synchronizes the digital filter process. The RESET pin resets the ADC.

Supply voltage AVDD1 powers the precharge buffers and the input sampling switches. AVDD2 powers the modulator via an internal regulator (CAPA). Supply voltage IOVDD is the digital I/O voltage that also powers the digital core with an internal regulator (CAPD). The internal regulators minimize overall power consumption and provide consistent levels of performance.

### 8.2 Functional Block Diagram



## 8.3 Feature Description

### 8.3.1 Analog Input (AINP, AINN)

The analog input of the ADC is differential, with the input defined as a difference voltage:  $V_{IN} = V_{AINP} - V_{AINN}$ . For best performance, drive the input with a differential signal with the common-mode voltage centered to mid-supply  $(AVDD1 + AVSS) / 2$ .

The ADC can accept either unipolar or bipolar input signals by configuring AVDD1 and AVSS accordingly. [Figure 8-1](#) shows an example of a differential signal with the supplies configured to unipolar operation. Symmetric input voltage headroom is available when the common-mode voltage is at mid-supply  $(AVDD1 / 2)$ . Use  $AVDD1 = 5\text{ V}$  and  $AVSS = 0\text{ V}$  for unipolar operation ( $AVDD1$  can be reduced to  $3\text{ V}$  in low-speed mode). The VCM output provides a buffered common-mode voltage to level-shift the output voltage in the external driver stage. [Figure 8-2](#) shows an example of a differential signal configured for bipolar operation. The common-mode voltage of the signal is normally at  $0\text{ V}$ . Use  $AVDD1$  and  $AVSS = \pm 2.5\text{ V}$  for bipolar operation ( $AVDD$  and  $AVSS$  can be reduced to  $\pm 1.5\text{ V}$  in low-speed mode).

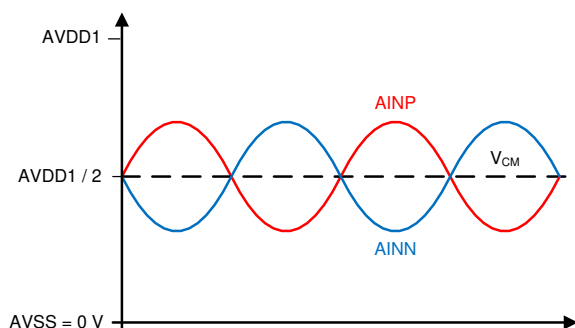


**Figure 8-1. Unipolar Differential Input Signal**

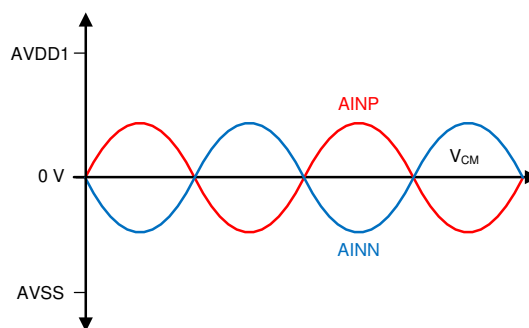


**Figure 8-2. Bipolar Differential Input Signal**

In both bipolar and unipolar power-supply configurations, the ADC can accept single-ended input signals by tying the AINN input to AVSS or ground, or to mid-supply. However, because AINN is now a fixed voltage, the voltage range of the ADC is limited by the input swing range of AINP ( $\pm 2.5\text{ V}$  or  $0\text{ V}$  to  $5\text{ V}$  for a  $5\text{-V}$  supply).

The simplified circuit of [Figure 8-3](#) represents the analog input structure.

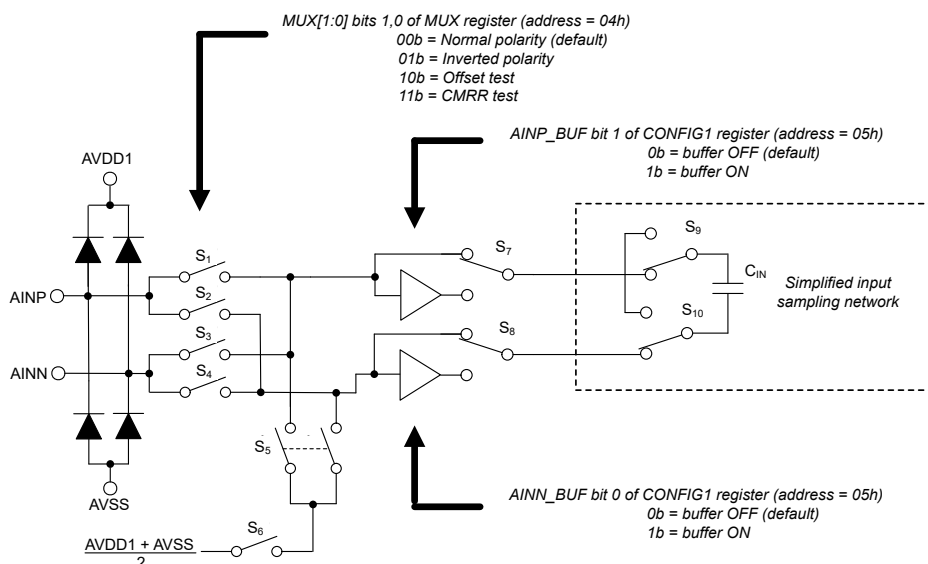


**Figure 8-3. Analog Input Circuit**

Diodes protect the ADC inputs from electrostatic discharge (ESD) events that occur during the manufacturing process and during printed circuit board (PCB) assembly when manufactured in an ESD-controlled environment. If the inputs are driven below  $AVSS - 0.3\text{ V}$ , or above  $AVDD1 + 0.3\text{ V}$ , the protection diodes may conduct. If these conditions are possible, use external clamp diodes, series resistors, or both to limit the input current to the specified value.

The input multiplexer offers the option of normal or reverse input signal polarities. The multiplexer also provides two internal test modes to help verify ADC performance. The offset test mode is used to verify noise and offset error by providing a short to the ADC inputs. The resulting noise and offset voltage data are evaluated by the user. CMRR performance is tested using the CMRR test mode by applying a CMRR test signal to the AINP input. The resulting CMRR test data are also evaluated by the user. [Table 8-1](#) shows the switch configurations of the input multiplexer circuit of [Figure 8-3](#).

**Table 8-1. Input Multiplexer Configurations**

| MUX[1:0] BITS | SWITCHES                        | DESCRIPTION                              |
|---------------|---------------------------------|------------------------------------------|
| 00b           | S <sub>1</sub> , S <sub>4</sub> | Normal polarity input                    |
| 01b           | S <sub>2</sub> , S <sub>3</sub> | Reverse polarity input                   |
| 10b           | S <sub>5</sub> , S <sub>6</sub> | Internal noise and offset error test     |
| 11b           | S <sub>1</sub> , S <sub>5</sub> | CMRR test using a signal applied to AINP |

The device has optional input precharge buffers to reduce the charge required by capacitor  $C_{IN}$  during the input sampling phase. When the capacitor is near full charge, the precharge buffers are bypassed (S<sub>7</sub> and S<sub>8</sub> of [Figure 8-3](#) in up positions). The external signal driver then provides the fine charge to the capacitor. At the completion of the sample phase, the sampling capacitor is discharged by the modulator to complete the cycle, at which time the sample process repeats. The buffers reduce the transient input current required to charge  $C_{IN}$ , therefore reducing the settling time requirement of the signal. Incomplete settling of the input signal can lead to degraded ADC performance. The input buffers are enabled by the AINP\_BUF and AINN\_BUF bits of the [CONFIG1](#) register. In many cases, if AINN is tied to ground or to a low-impedance fixed potential, the AINN buffer can be disabled to reduce power consumption.

With the input precharge buffers disabled, the charge required by the input sampling capacitor can be modeled as an average input current flowing into the ADC inputs. As shown in [Equation 11](#) and [Equation 12](#), the input current is comprised of differential and absolute components.

$$\text{Input Current (Differential Input Voltage)} = f_{MOD} \cdot C_{IN} \cdot 10^6 \text{ (}\mu\text{A/V)} \quad (11)$$

where:

- $f_{MOD} = f_{CLK} / 2 = 12.8\text{ MHz}$  (high-speed mode),  $1.6\text{ MHz}$  (low-speed mode)
- $C_{IN} = 7.4\text{ pF}$  (1x input range),  $3.6\text{ pF}$  (2x input range)

$$\text{Input Current (Absolute Input Voltage)} = f_{MOD} \cdot C_{CM} \cdot 10^6 \text{ (}\mu\text{A/V)} \quad (12)$$

where:

- $f_{MOD} = f_{CLK} / 2 = 12.8\text{ MHz}$  (high-speed mode),  $1.6\text{ MHz}$  (low-speed mode)
- $C_{CM} = 0.35\text{ pF}$  (1x input range),  $0.17\text{ pF}$  (2x input range)

For  $f_{MOD} = 12.8\text{ MHz}$ ,  $C_{IN} = 7.4\text{ pF}$ , and  $C_{CM} = 0.35\text{ pF}$ , the input current resulting from differential voltage is  $95\text{ }\mu\text{A/V}$  and the input current resulting from the absolute voltage is  $4.5\text{ }\mu\text{A/V}$ . For example, if  $AINP = 4.5\text{ V}$  and  $AINN = 0.5\text{ V}$ , then  $V_{IN} = 4\text{ V}$ . The total AINP input current =  $(4\text{ V} \cdot 95\text{ }\mu\text{A/V}) + (4.5\text{ V} \cdot 4.5\text{ }\mu\text{A/V}) = 400\text{ }\mu\text{A}$ , and the total AINN current is  $(-4\text{ V} \cdot 95\text{ }\mu\text{A/V}) + (0.5\text{ V} \cdot 4.5\text{ }\mu\text{A/V}) = -378\text{ }\mu\text{A}$ .

The charge demand of the input sampling capacitor requires the signal to settle within a half cycle at the modulator frequency  $t = 1 / (2 \cdot f_{MOD})$ . To satisfy this requirement, the driver bandwidth is typically required to be much larger than the original signal frequency. The bandwidth of the driver can be determined to be sufficient when the THD and SNR data sheet performance are achieved. In the low-speed mode of operation, the modulator sampling is eight times slower, therefore more time is available for driver settling.

### 8.3.1.1 Input Range

The ADC has two programmable input ranges: 1x and 2x, where the 1x range is defined by  $V_{IN} = \pm V_{REF}$  and the 2x range is defined by  $V_{IN} = \pm 2 \cdot V_{REF}$ . The 2x input range doubles the available range when using a reference voltage = 2.5 V or less. The 2x input range requires driving the inputs to the 5-V supply rails to exercise the full range when using a 2.5-V reference voltage. When using a 4.096-V or 5-V reference voltage be sure to program the ADC to the high-reference range mode. The 2x range operation is internally forced to the 1x range mode when the high-reference range is selected. See the [CONFIG1](#) register to program the input range. [Table 8-2](#) summarizes the ADC input range options.

**Table 8-2. ADC Input Range**

| INP_RNG BIT <sup>(1)</sup> | INPUT RANGE (V)       |
|----------------------------|-----------------------|
| 0                          | $\pm V_{REF}$         |
| 1                          | $\pm 2 \cdot V_{REF}$ |

(1) The input range is forced to 1x when the high-reference range is selected.

In some cases, the full available input range is limited by the power supply voltage. For example, the input range exceeds the power supply voltage when using a 3-V power supply with a 2.5-V reference voltage in the 2x range mode.

The ADC provides the option of bipolar or unipolar input signal operation. In bipolar mode, the ADC accepts positive and negative signals ( $-V_{REF}$  to  $V_{REF}$ ) with 15-bit output data resolution for positive signals and 15-bit output data resolution for negative signals. In unipolar mode, the ADC accepts positive signals only (0 V to  $V_{REF}$ ), providing 16-bit output data resolution. The mode is programmed by the BIP\_UNI bit of the [CONFIG4](#) register.

The ADC also provides the option of extended input range operation beyond the standard full-scale range. In this mode, the input range is extended by 25% to provide signal headroom before clipping of the signal occurs. Output data are scaled such that the positive and negative full-scale output codes (7FFFh and 8000h) in bipolar input mode are at  $\pm 1.25 \cdot k \cdot V_{REF}$ , where k is the 1x or 2x input range option.

SNR performance degrades when the signal exceeds 110% standard full-scale range because of modulator saturation. The modulator MOD\_FLAG bit of the [STATUS](#) register indicates when modulator saturation occurs. [Figure 8-4](#) shows SNR performance when operating in the extended range. See the [CONFIG2](#) register to program the extended range mode.

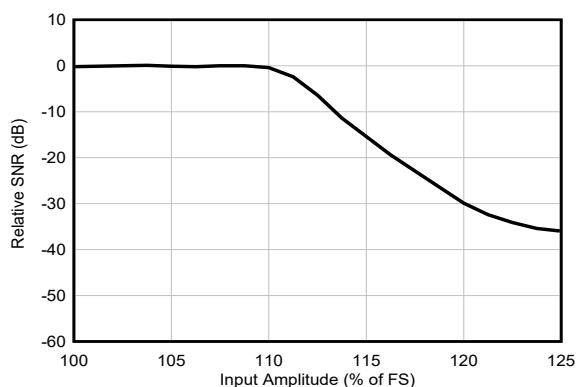


**Figure 8-4. Extended Range SNR Performance**

### 8.3.2 Reference Voltage (REFP, REFN)

A reference voltage is required for operation. The reference voltage input is differential, defined as:  $V_{REF} = V_{REFP} - V_{REFN}$ , and applied to the REFP and REFN inputs. See the [Reference Voltage Range](#) section for details of the reference voltage operating range.

As shown in [Figure 8-5](#), the reference inputs have an input structure similar to the analog inputs. ESD diodes protect the reference inputs. To keep these diodes from turning on, make sure the voltages on the reference pins do not go below AVSS by more than 0.3 V, or above AVDD1 by 0.3 V. If these conditions are possible, use external clamp diodes, series resistors, or both to limit the input current to the specified value.

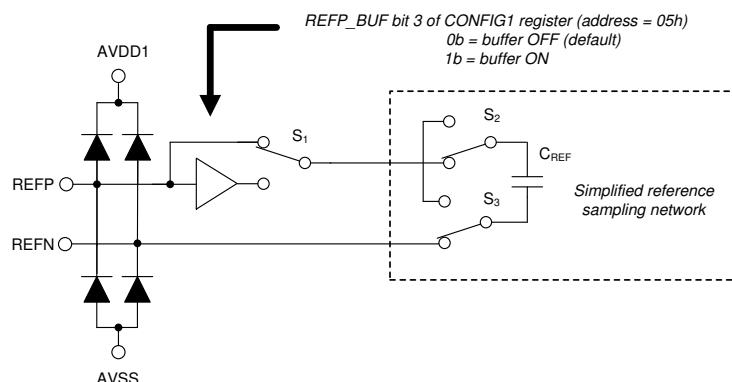


**Figure 8-5. Reference Input Circuit**

The reference voltage is sampled by a sampling capacitor  $C_{REF}$ . In unbuffered mode, current flows through the reference inputs to charge the sampling capacitor. The current consists of a dc component and an ac component that varies with the frequency of the modulator sampling clock. See the [Electrical Characteristics](#) table for the reference input current specification.

The effect of charging the reference sampling capacitor requires the external reference driver to settle at the end of the sample phase  $t = 1 / (2 \cdot f_{MOD})$ . Incomplete settling of the reference voltage can lead to excessive gain error and gain error drift. Operation in low-speed mode reduces the modulator sampling clock frequency by 1/8th, therefore allowing more time for the reference driver to settle.

The ADC provides a precharge buffer option for the REFP input to reduce the charge drawn by the sampling capacitor. The precharge buffer provides the coarse charge for the reference sampling capacitor  $C_{REF}$ . Halfway through the sample phase, the precharge buffer is bypassed ( $S_1$  is in an up position as demonstrated in [Figure 8-5](#)), at which time the external driver provides the fine charge to the sampling capacitor. Because the buffer reduces the charge demand of the sampling capacitor, the bandwidth requirement of the external driver is greatly reduced.

Many applications either ground REFN, or connect REFN to AVSS. A precharge buffer for REFN is not necessary for these cases. For applications when REFN is not a low impedance source, consider buffering the REFN input.

#### 8.3.2.1 Reference Voltage Range

The operation of the ADC is optimized by separating the reference voltage into two operating ranges: low-reference range and high-reference range. The reference voltage range must be programmed to match the applied reference voltage, such as 2.5 V or 4.096 V. The low-reference operating range is 0.5 V to 2.75 V, and the high-reference operating range is 1 V up to the  $AVDD1 - AVSS$  power supplies. For best performance where the ranges overlap, such as reference voltage = 2.5 V, use the low-reference range. Program the REF\_RNG bit of the [CONFIG1 register](#) to the appropriate reference range to match the applied reference voltage. When the high-reference range is selected, the input range is internally forced to 1x.

### 8.3.3 Clock Operation

Figure 8-6 shows the block diagram of the internal clock circuit. The ADC can be operated by an external clock or the internal oscillator. The nominal value of  $f_{CLK}$  is 25.6 MHz in high-speed mode and 3.2 MHz in low-speed mode. A divide-by-eight option is available at the CLK input to divide the high-speed mode clock frequency to provide the low-speed mode clock frequency. The clock frequency is divided by two to derive the modulator sampling clock ( $f_{MOD}$ ).

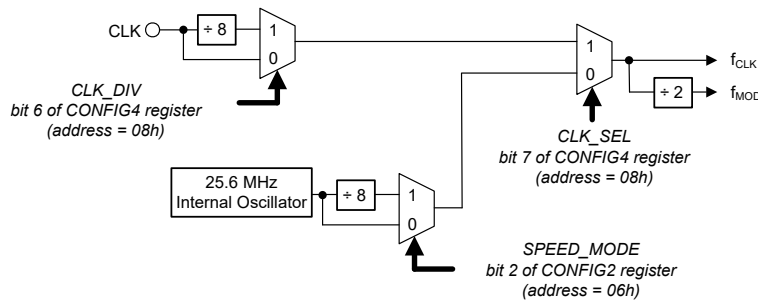


**Figure 8-6. Clock Block Diagram**

#### 8.3.3.1 Internal Oscillator

At power-up and after reset, the ADC defaults to internal oscillator mode (CLK\_SEL bit = 0b). The frequency of the internal oscillator automatically scales to high-speed or low-speed operation. Because of the clock jitter associated with the internal oscillator, only use the internal oscillator for dc signal measurements. Do not perform ac signal measurements when using the internal oscillator.

When changing the clock mode from an external clock to the internal oscillator, maintain the external clock for at least four cycles after completing the SPI register write command used to change the clock mode. After the clock mode changes, the ADC ignores control inputs (the START and RESET pins) for a period of 150  $\mu$ s to allow time for the internal oscillator to stabilize.

#### 8.3.3.2 External Clock

To operate the ADC with an external clock, apply the clock signal to the CLK pin, then program the CLK\_SEL bit to 1b. A divide-by-eight option is available to operate the ADC in low-speed mode using the high-speed mode clock frequency (set the CLK\_DIV bit = 1b). The clock can be decreased from nominal to yield specific data rates between the integer OSR values. However, the conversion noise when operating at the reduced clock frequency is the same as the higher clock frequency. Reducing the conversion noise is only possible by increasing the OSR value or changing the filter mode.

Clock jitter results in timing variations at the modulator sampling instant and if excessive, can lead to degraded SNR performance. Thus, use a low-jitter clock signal free of noise from other signals. For example, with a 200-kHz signal frequency, use an external clock with < 20-ps (rms) jitter. For lower signal frequencies, the clock jitter requirement can be relaxed by -20 dB per decade of signal frequency. For example, with  $f_{IN} = 20$  kHz, a clock with 200-ps jitter can be tolerated. Many types of RC oscillators exhibit high levels of jitter and must be avoided for ac signal measurement. Instead, use a crystal-based clock oscillator for the clock signal. Avoid ringing on the clock signal. A series resistor placed at the output of the clock buffer often helps reduce ringing.

### 8.3.4 Modulator

The ADS117L11 uses a switched-capacitor, third-order, single-loop modulator with a 5-bit internal quantizer. This modulator topology achieves excellent noise and linearity performance while consuming very low power. As with most high-order modulators driven by high amplitude out-of-band signals, modulator saturation can occur. When saturated, the in-band signal still converts, but the noise floor increases. Figure 8-7 illustrates the amplitude limit of out-of-band signals to avoid modulator saturation. The limit of dc and in-band signal amplitudes are 1 dB above standard full scale.

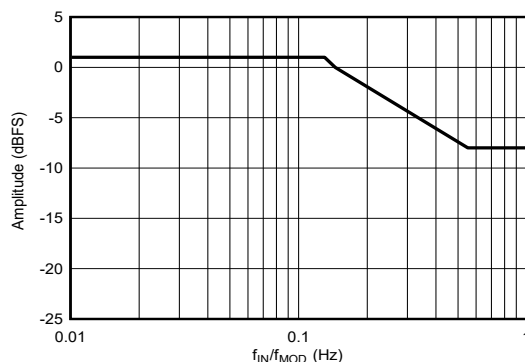


**Figure 8-7. Amplitude Limit to Avoid Modulator Saturation**

Modulator saturation is indicated by the MOD\_FLAG bit of the [STATUS](#) register. The modulator saturation status is latched during the conversion period and is refreshed at completion of the next conversion. Modulator saturation resulting from out-of-band signals can be avoided by using an antialias filter at the ADC inputs. The [Typical Application](#) section describes an example of a fourth-order antialias filter; however, a low-order filter can be used with equal effect provided the amplitude is below the saturation limit.

### 8.3.5 Digital Filter

The digital filter low-pass filters and decimates the low-resolution, high-speed data from the modulator to produce high-resolution, low-speed output data. The programmable oversampling ratio (OSR) determines the amount of filtering that affects signal bandwidth and conversion noise, and the final data rate through decimation. The output data rate is defined by:  $f_{\text{DATA}} = f_{\text{MOD}} / \text{OSR}$ .

The ADC offers the choice of two filter modes: wideband and low latency. The filter mode selection optimizes either the frequency response characteristics (wideband filter mode) or the time domain characteristics (low-latency filter mode).

#### 8.3.5.1 Wideband Filter

The wideband filter is a multistage FIR filter design featuring linear phase response, low pass-band ripple, narrow transition band, and high stop-band attenuation. Because of the excellent frequency domain performance, the wideband filter is effective for measuring ac signals. The ADC provides eight programmable oversampling ratios (OSR) and two speed modes, offering a range of data rates, resolution, and device power consumption to select from.

[Figure 8-8](#) through [Figure 8-12](#) illustrate the frequency response of the wideband filter. [Figure 8-8](#) shows the pass-band ripple. [Figure 8-9](#) shows the detailed frequency response at the transition band.

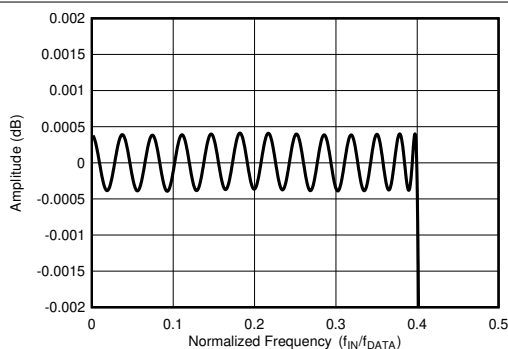


**Figure 8-8. Wideband Filter Pass-Band Ripple**

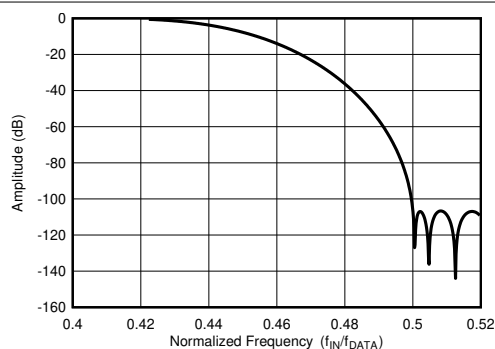


**Figure 8-9. Wideband Filter Transition Band**

Figure 8-10 shows the frequency response to  $f_{\text{DATA}}$  for  $\text{OSR} \geq 64$ . The stop band begins at  $f_{\text{DATA}} / 2$  to prevent aliasing at the Nyquist frequency. Figure 8-11 shows the stop-band attenuation to  $f_{\text{MOD}}$  for  $\text{OSR} = 32$ . In the stop-band region, out-of-band input frequencies intermodulate with multiples of the chop frequency at  $f_{\text{MOD}} / 32$ , creating a pattern of response peaks that exceed the stop-band attenuation of the digital filter. The frequency width of each response peak is twice the bandwidth of the filter. Improved stop-band attenuation is provided by using an antialias filter at the ADC input. See the [Typical Application](#) section for details of a fourth-order antialias filter.

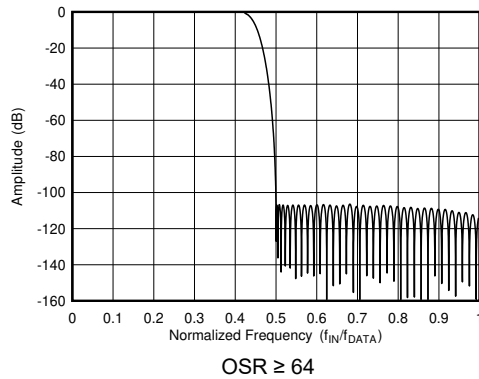


**Figure 8-10. Wideband Filter Frequency Response**

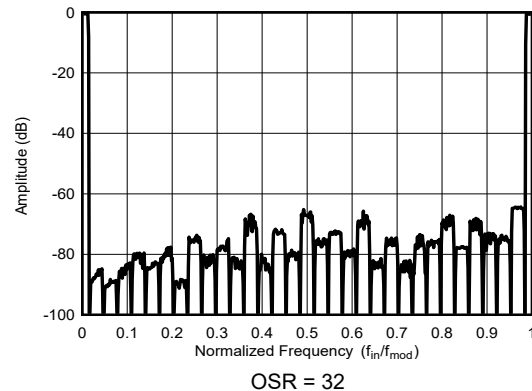


**Figure 8-11. Wideband Filter Stop-Band Attenuation**

Figure 8-12 shows the filter response centered around  $f_{\text{MOD}}$ . As shown, the filter response repeats at  $f_{\text{MOD}}$ . If not removed by an antialiasing filter, input frequencies at  $f_{\text{MOD}}$  appear as aliased frequencies in the pass band. Aliasing also occurs with input frequencies occurring at multiples of  $f_{\text{MOD}}$ . The aliased frequency bands are defined by:

$$\text{Aliased frequency bands: } (N \cdot f_{\text{MOD}}) \pm f_{\text{BW}} \quad (13)$$

where:

- $N = 1, 2, 3$ , and so on
- $f_{\text{MOD}}$  = Modulator sampling frequency
- $f_{\text{BW}}$  = Filter bandwidth

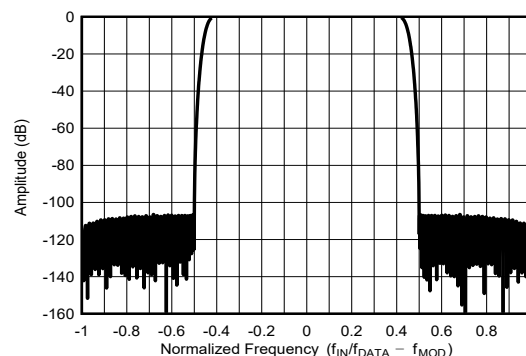


**Figure 8-12. Wideband Filter Frequency Response Centered at  $f_{\text{MOD}}$**

The group delay of the filter is the time for a continuous input signal to propagate from the filter input to the filter output. Because the filter is a linear-phase design, the envelope of a complex input signal is undistorted by the filter. The group delay (expressed in units of time) is constant versus frequency equal to the value  $= 34 / f_{\text{DATA}}$ . After a step change is applied to the ADC input (when synchronous to  $\overline{\text{DRDY}}$  falling edge), fully settled data occurs 68 data periods later. Figure 8-13 illustrates the filter group delay ( $34 / f_{\text{DATA}}$ ) and the settling time of a step input ( $68 / f_{\text{DATA}}$ ).

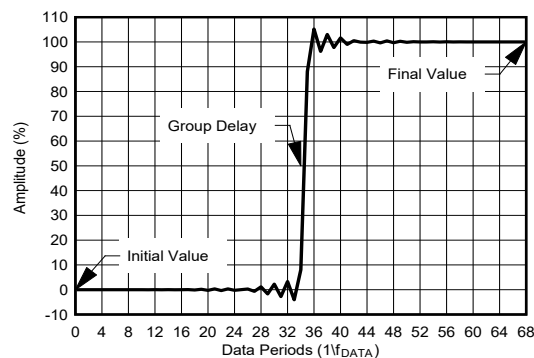


**Figure 8-13. Wideband Filter Step Response**

The digital filter is restarted when the ADC is synchronized. The ADC suppresses the first 68 conversion periods until the filter is fully settled. There is no need to discard data after synchronization. The duration of data suppression is the conversion latency time as listed in the *latency time* column of [Table 8-3](#). A 0.4- $\mu$ s fixed overhead time is incurred for all data rates. If a step change input is applied without synchronizing the ADC, then the next 69 conversions are partially settled data.

**Table 8-3. Wideband Filter**

| OSR                                                      | DATA RATE (kSPS) | –0.1-dB FREQUENCY (kHz) | –3-dB FREQUENCY (kHz) | LATENCY TIME ( $\mu$ s) <sup>(1)</sup> |
|----------------------------------------------------------|------------------|-------------------------|-----------------------|----------------------------------------|
| <b>HIGH-SPEED MODE (<math>f_{CLK} = 25.6</math> MHz)</b> |                  |                         |                       |                                        |
| 32                                                       | 400              | 165                     | 174.96                | 170.6                                  |
| 64                                                       | 200              | 82.5                    | 87.48                 | 340.6                                  |
| 128                                                      | 100              | 41.25                   | 43.74                 | 680.6                                  |
| 256                                                      | 50               | 20.625                  | 21.87                 | 1360.6                                 |
| 512                                                      | 25               | 10.312                  | 10.935                | 2720.6                                 |
| 1024                                                     | 12.5             | 5.156                   | 5.467                 | 5440.6                                 |
| 2014                                                     | 6.25             | 2.578                   | 2.734                 | 10880.6                                |
| 4096                                                     | 3.125            | 1.289                   | 1.367                 | 21760.6                                |
| <b>LOW-SPEED MODE (<math>f_{CLK} = 3.2</math> MHz)</b>   |                  |                         |                       |                                        |
| 32                                                       | 50               | 20.625                  | 21.87                 | 1364.8                                 |
| 64                                                       | 25               | 10.312                  | 10.935                | 2724.8                                 |
| 128                                                      | 12.5             | 5.156                   | 5.467                 | 5444.8                                 |
| 256                                                      | 6.25             | 2.578                   | 2.734                 | 10884.8                                |
| 512                                                      | 3.125            | 1.289                   | 1.367                 | 21764.8                                |
| 1024                                                     | 1.5625           | 0.645                   | 0.683                 | 43524.8                                |
| 2048                                                     | 0.78125          | 0.322                   | 0.342                 | 87044.8                                |
| 4096                                                     | 0.390625         | 0.161                   | 0.171                 | 174084.8                               |

(1) Latency time increases by  $8 / f_{CLK}$  ( $\mu$ s) when the analog input buffers are enabled.

### 8.3.5.2 Low-Latency Filter (Sinc)

The low-latency filter is a cascaded-integrator-comb (CIC) topology that minimizes the delay (latency) as the conversion data propagates through the filter. The CIC filter is otherwise known as a sinc filter because of the characteristic  $\sin x/x$  (sinc) frequency response. The latency time is shorter compared to the wideband filter, making the filter suitable for fast acquisition of dc signals. The device offers the choice of four sinc filter configurations: sinc4, sinc4 + sinc1, sinc3, and sinc3 + sinc1 to provide trade-offs of acquisition time, noise performance, and line-cycle rejection.

Latency is defined as the time from synchronization to the falling edge of  $\overline{DRDY}$ , at which time, fully settled data are available. Data do not need to be discarded because unsettled data are suppressed by the ADC. Detailed latency data for each sinc filter mode are given in [Table 8-4](#) through [Table 8-7](#).

If the input is changed without synchronization, then the next conversion data are partially settled. The number of conversions required for fully settled data in this case is found by rounding the latency time value to the next whole number of conversion periods.

Equation 14 is the general expression of the sinc-filter frequency response. For single-stage sinc filter options (for example, the single-stage sinc3 or sinc4 filter), the second stage is not used.

$$|H(f)| = \left| \frac{\sin \left[ \frac{A\pi f}{f_{MOD}} \right]}{A \sin \left[ \frac{\pi f}{f_{MOD}} \right]} \right|^n \cdot \left| \frac{\sin \left[ \frac{AB\pi f}{f_{MOD}} \right]}{B \sin \left[ \frac{A\pi f}{f_{MOD}} \right]} \right| \quad (14)$$

where:

- $f$  = Signal frequency
- $A$  = Stage 1 OSR,  $B$  = Stage 2 OSR
- $f_{MOD} = f_{CLK} / 2 = 12.8$  MHz (high-speed mode), 1.6 MHz (low-speed mode)
- $n$  = Order of the stage 1 filter (3 or 4)

#### 8.3.5.2.1 Sinc4 Filter

The sinc4 filter averages and decimates the high-speed modulator data to yield data rates from 1066.6 kSPS to 3.125 kSPS in high-speed mode, and data rates from 133.333 kSPS to 0.390625 kSPS in low-speed mode. Increasing the OSR value decreases the data rate and simultaneously reduces signal bandwidth and total noise resulting from increased decimation and data averaging. Table 8-4 lists the sinc4 filter characteristics.

**Table 8-4. Sinc4 Filter Characteristics**

| OSR                                                      | DATA RATE (kSPS) | –3-dB FREQUENCY (kHz) | LATENCY TIME (μs) <sup>(1)</sup> |
|----------------------------------------------------------|------------------|-----------------------|----------------------------------|
| <b>HIGH-SPEED MODE (<math>f_{CLK} = 25.6</math> MHz)</b> |                  |                       |                                  |
| 12                                                       | 1066.666         | 242.666               | 4.38                             |
| 16                                                       | 800              | 182                   | 5.63                             |
| 24                                                       | 533.333          | 121.333               | 8.13                             |
| 32                                                       | 400              | 91.0                  | 10.63                            |
| 64                                                       | 200              | 45.5                  | 20.63                            |
| 128                                                      | 100              | 22.75                 | 40.63                            |
| 256                                                      | 50               | 11.375                | 80.63                            |
| 512                                                      | 25               | 5.687                 | 160.63                           |
| 1024                                                     | 12.5             | 2.844                 | 320.63                           |
| 2048                                                     | 6.25             | 1.422                 | 640.63                           |
| 4096                                                     | 3.125            | 0.711                 | 1280.63                          |
| <b>LOW-SPEED MODE (<math>f_{CLK} = 3.2</math> MHz)</b>   |                  |                       |                                  |
| 12                                                       | 133.333          | 30.333                | 35.04                            |
| 16                                                       | 100              | 22.75                 | 45.04                            |
| 24                                                       | 66.666           | 15.166                | 65.04                            |
| 32                                                       | 50               | 11.375                | 85.04                            |
| 64                                                       | 25               | 5.687                 | 165.04                           |
| 128                                                      | 12.5             | 2.844                 | 325.04                           |
| 256                                                      | 6.25             | 1.422                 | 645.04                           |
| 512                                                      | 3.125            | 0.711                 | 1285.04                          |
| 1024                                                     | 1.5625           | 0.355                 | 2565.04                          |
| 2048                                                     | 0.78125          | 0.177                 | 5125.04                          |
| 4096                                                     | 0.390625         | 0.089                 | 10245.04                         |

(1) Latency time increases by  $8 / f_{CLK}$  (μs) when the analog input buffers are enabled.

Figure 8-14 and Figure 8-15 show the sinc4 filter frequency response at  $OSR = 32$ . The frequency response consists of a series of response nulls occurring at discrete frequencies. The null frequencies occur at multiples of  $f_{DATA}$ . At the null frequencies, the filter has zero gain. A folded image of the overall frequency response appears at multiples of  $f_{MOD}$ , as illustrated in the  $f_{MOD}$  frequency plot of Figure 8-15. No attenuation is provided by the filter at input frequencies near  $n \cdot f_{MOD}$  ( $n = 1, 2, 3$ , and so on), and if present, alias into the pass band.

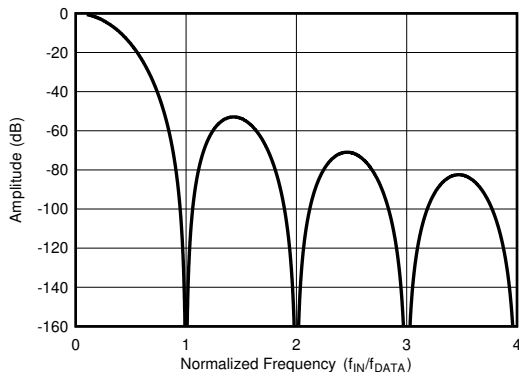


**Figure 8-14. Sinc4 Frequency Response (OSR = 32)**

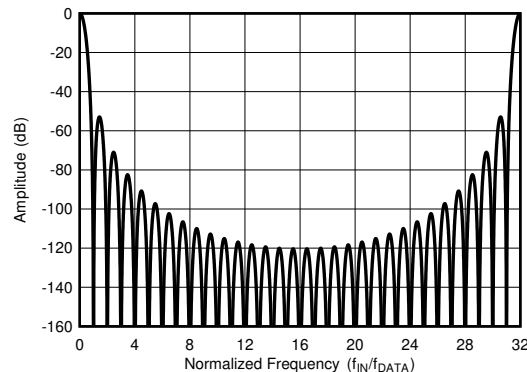


**Figure 8-15. Sinc4 Frequency Response to  $f_{MOD}$  (OSR = 32)**

### 8.3.5.2.2 Sinc4 + Sinc1 Filter

The sinc4 + sinc1 filter is the cascade of two filter sections: sinc4 and sinc1. The OSR of the sinc4 stage is a constant value (32) and the programmable OSR of the sinc1 stage determines the output data rate. The sinc4 + sinc1 filter mode has comparably less latency time than that of the single-stage sinc4 filter. Table 8-5 summarizes the sinc4 + sinc1 filter characteristics.

**Table 8-5. Sinc4 + Sinc1 Filter Characteristics**

| SINC4 OSR                                                | SINC1 OSR | DATA RATE (kSPS) | -3-dB FREQUENCY (kHz) | LATENCY TIME ( $\mu$ s) <sup>(1)</sup> |
|----------------------------------------------------------|-----------|------------------|-----------------------|----------------------------------------|
| <b>HIGH-SPEED MODE (<math>f_{CLK} = 25.6</math> MHz)</b> |           |                  |                       |                                        |
| 32                                                       | 2         | 200              | 68.35                 | 13.13                                  |
| 32                                                       | 4         | 100              | 40.97                 | 18.13                                  |
| 32                                                       | 10        | 40               | 17.47                 | 33.13                                  |
| 32                                                       | 20        | 20               | 8.814                 | 58.13                                  |
| 32                                                       | 40        | 10               | 4.420                 | 108.13                                 |
| 32                                                       | 100       | 4                | 1.770                 | 258.13                                 |
| 32                                                       | 200       | 2                | 0.885                 | 508.13                                 |
| 32                                                       | 400       | 1                | 0.442                 | 1008.13                                |
| 32                                                       | 1000      | 0.4              | 0.177                 | 2508.13                                |
| <b>LOW-SPEED MODE (<math>f_{CLK} = 3.2</math> MHz)</b>   |           |                  |                       |                                        |
| 32                                                       | 2         | 25               | 8.544                 | 105.04                                 |
| 32                                                       | 4         | 12.5             | 5.121                 | 145.04                                 |
| 32                                                       | 10        | 5                | 2.184                 | 265.04                                 |
| 32                                                       | 20        | 2.5              | 1.102                 | 465.04                                 |
| 32                                                       | 40        | 1.25             | 0.552                 | 865.04                                 |
| 32                                                       | 100       | 0.5              | 0.221                 | 2065.04                                |
| 32                                                       | 200       | 0.25             | 0.111                 | 4065.04                                |
| 32                                                       | 400       | 0.125            | 0.055                 | 8065.04                                |
| 32                                                       | 1000      | 0.05             | 0.022                 | 20065.04                               |

(1) Latency time increases by  $8 / f_{CLK}$  ( $\mu$ s) when the analog input buffers are enabled.

Figure 8-16 shows the frequency response of the sinc4 + sinc1 filter for three values of OSR. The combined frequency response is the overlay of the sinc1 filter with the sinc4 filter. For low values of OSR, the response profile is dominated by the rolloff of the sinc4 filter. Nulls in the frequency response occur at  $n \cdot f_{\text{DATA}}$ ,  $n = 1, 2, 3$ , and so on. At the null frequencies, the filter has zero gain.

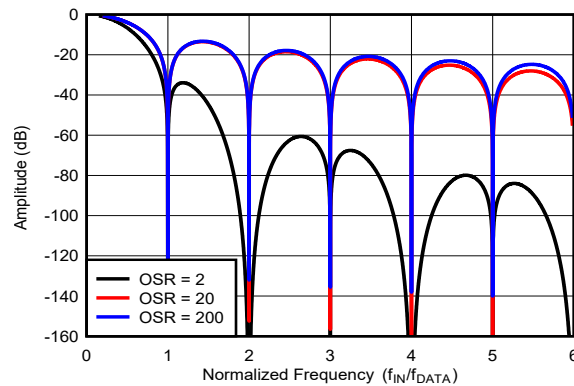


**Figure 8-16. Sinc4 + Sinc1 Frequency Response**

#### 8.3.5.2.3 Sinc3 Filter

The sinc3 filter mode is a single-stage filter. Relatively high values of OSR provide line-cycle rejection with data rates = 480 SPS, 400 SPS, 60 SPS, and 50 SPS. Because of the large width of the frequency response notch, excellent line-frequency NMRR and CMRR can be achieved with this filter. Table 8-6 summarizes the characteristics of the sinc3 filter.

**Table 8-6. Sinc3 Filter Characteristics**

| OSR                                           | DATA RATE (SPS) | −3-dB FREQUENCY (Hz) | LATENCY (ms) | REJECTION OF FIRST NULL (dB) |                    |
|-----------------------------------------------|-----------------|----------------------|--------------|------------------------------|--------------------|
|                                               |                 |                      |              | 2% CLOCK TOLERANCE           | 6% CLOCK TOLERANCE |
| HIGH-SPEED MODE (f <sub>CLK</sub> = 25.6 MHz) |                 |                      |              |                              |                    |
| 26667                                         | 480             | 126                  | 6.25         | 100                          | 71                 |
| 32000                                         | 400             | 105                  | 7.50         | 100                          | 71                 |
| LOW-SPEED MODE (f <sub>CLK</sub> = 3.2 MHz)   |                 |                      |              |                              |                    |
| 26667                                         | 60              | 15.7                 | 50.01        | 100                          | 71                 |
| 32000                                         | 50              | 13.1                 | 60.01        | 100                          | 71                 |

Figure 8-17 shows the frequency response of the sinc3 filter (OSR = 32000). Figure 8-18 shows the detailed response in the region of  $0.9$  to  $1.1 \cdot f_{\text{IN}} / f_{\text{DATA}}$ .

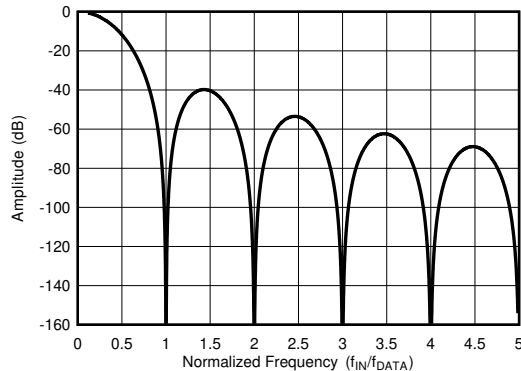


**Figure 8-17. Sinc3 Frequency Response (OSR = 32000)**

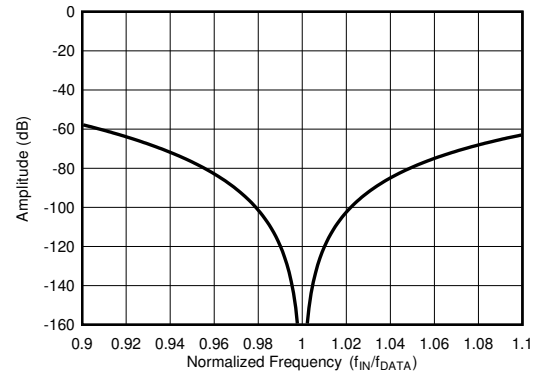


**Figure 8-18. Detail Sinc3 Frequency Response (OSR = 32000)**

### 8.3.5.2.4 Sinc3 + Sinc1 Filter

The sinc3 + sinc1 filter mode is the cascade of the sinc3 and the sinc1 filter. The OSR of the sinc3 stage is fixed (32000) and the OSR of the sinc1 stage is programmable to 3 and 5. Table 8-7 summarizes the characteristics of the sinc3 + sinc1 filter.

**Table 8-7. Sinc3 + Sinc1 Filter Characteristics**

| SINC3 OSR                                     | SINC1 OSR | DATA RATE (SPS) | −3-dB FREQUENCY (HZ) | LATENCY (ms) | REJECTION OF FIRST NULL (dB) |                    |
|-----------------------------------------------|-----------|-----------------|----------------------|--------------|------------------------------|--------------------|
|                                               |           |                 |                      |              | 2% CLOCK TOLERANCE           | 6% CLOCK TOLERANCE |
| HIGH-SPEED MODE (f <sub>CLK</sub> = 25.6 MHz) |           |                 |                      |              |                              |                    |
| 32000                                         | 3         | 133.3           | 54                   | 12.5         | 37                           | 26                 |
| 32000                                         | 5         | 80              | 34                   | 17.5         | 37                           | 26                 |
| LOW-SPEED MODE (f <sub>CLK</sub> = 3.2 MHz)   |           |                 |                      |              |                              |                    |
| 32000                                         | 3         | 16.7            | 6.7                  | 100.1        | 34                           | 26                 |
| 32000                                         | 5         | 10              | 4.2                  | 140.01       | 34                           | 26                 |

Figure 8-19 shows the frequency response of the sinc3 + sinc1 filter. The frequency response exhibits the characteristic sinc filter response lobes and nulls. The nulls occur at  $f_{DATA}$  and at multiples thereof. Figure 8-20 shows the detailed response in the region of  $0.9$  to  $1.1 \cdot f_{IN} / f_{DATA}$ .

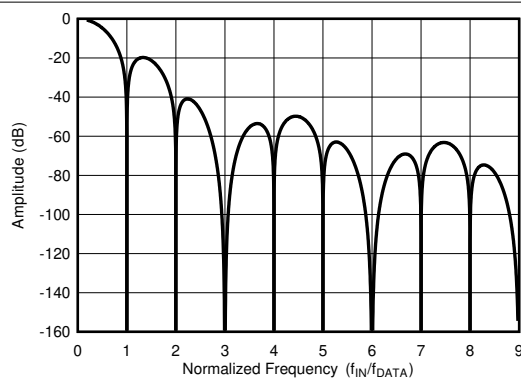


**Figure 8-19. Sinc3 + Sinc1 Frequency Response**

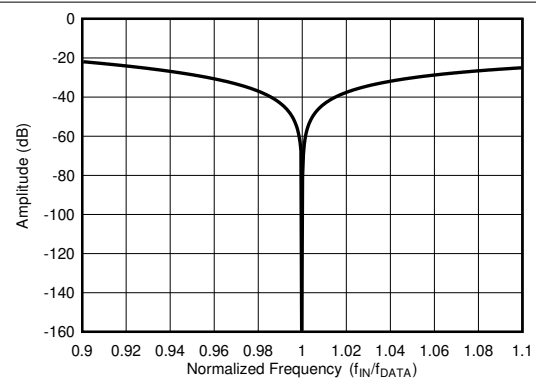


**Figure 8-20. Detail Sinc3 + Sinc1 Frequency Response**

## 8.3.6 Power Supplies

The device has three analog power-supply pins (AVDD1, AVSS, and AVDD2) and one digital power-supply pin (IOVDD). The power supplies can be sequenced in any order and are tolerant of slow or fast power-supply voltage ramp rates. However, in no case must any analog or digital input exceed the respective AVDD1 and AVSS (analog) or IOVDD (digital) power supply.

### 8.3.6.1 AVDD1 and AVSS

AVDD1 and AVSS power the precharge buffers and the internal sampling switches. The ADC can be configured either for bipolar input operation (such as using  $\pm 2.5$ -V power supplies), or for unipolar input operation (such as AVDD1 = 5 V and AVSS = DGND). Use a parallel combination of 1- $\mu$ F and 0.1- $\mu$ F bypass capacitors across the AVDD1 supply voltage and the AVSS pin, with a 3- $\Omega$  series resistor placed in series between the capacitors and the AVDD1 pin. Place the resistor and capacitors as close as possible to the AVDD1 pin.

### 8.3.6.2 AVDD2

AVDD2 is with respect to AVSS and powers the modulator core. AVDD2 can be connected to AVDD1 to simplify the required supply voltages, or AVDD2 can be operated by a lower supply voltage to minimize device power consumption. Use a combination of 1- $\mu$ F and 0.1- $\mu$ F bypass capacitors across the AVDD2 to AVSS supply pins.

Table 8-8 shows examples of AVDD1, AVSS, and AVDD2 power-supply configurations.

**Table 8-8. AVDD1, AVSS, and AVDD2 Power-Supply Voltages (All Voltages with Respect to DGND)**

| SUPPLY CONFIGURATION | HIGH-SPEED MODE |        |              | LOW-SPEED MODE |                  |                |
|----------------------|-----------------|--------|--------------|----------------|------------------|----------------|
|                      | AVDD1           | AVSS   | AVDD2        | AVDD1          | AVSS             | AVDD2          |
| Unipolar             | 5 V             | 0 V    | 1.8 V to 5 V | 3 V to 5 V     | 0 V              | 1.8 V to 5 V   |
| Bipolar              | 2.5 V           | –2.5 V | 0 V to 2.5 V | 1.5 V to 2.5 V | –1.5 V to –2.5 V | 0.3 V to 2.5 V |

### 8.3.6.3 IOVDD

IOVDD is the digital I/O supply voltage pin for the device. IOVDD is internally regulated to 1.25 V to supply power to the digital core. Bypass IOVDD to DGND with a parallel combination of 1-μF and 0.1-μF capacitors. The voltage level of IOVDD is independent of the analog supply configuration.

### 8.3.6.4 Power-On Reset (POR)

The ADC uses power-supply monitors to detect power-up and supply brownout events. Power-up or power-cycling of the IOVDD digital supply results in device reset. Power-up or power-cycling of the analog power supplies does not reset the ADC.

Figure 8-21 shows the digital power-on thresholds of the IOVDD and the internal CAPD voltages. When the voltages are above the respective thresholds, the ADC is released from reset.  $\overline{\text{DRDY}}$  later transitions high when the SPI is ready for communication. If the START pin is high, the ADC immediately begins conversions with the  $\overline{\text{DRDY}}$  pin pulsing for each conversion. However, valid conversion data only occur after the power supplies and reference voltage are stabilized. The POR\_FLAG bit of the STATUS register indicates the device POR. Write 1b to clear the bit to detect the next POR event.

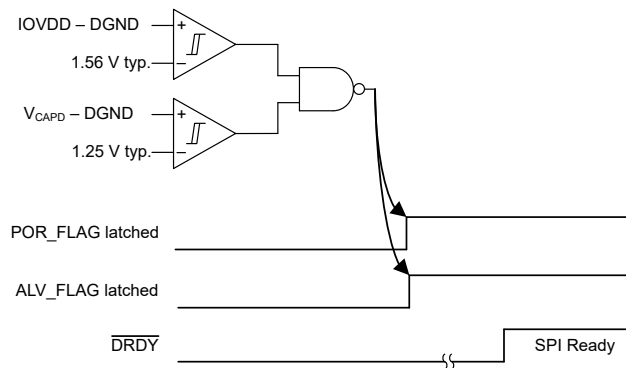


**Figure 8-21. Digital Supply Threshold**

Figure 8-22 illustrates the power-on thresholds of the analog power supplies. Four monitors are used for four analog supply voltage conditions (AVDD1 – DGND), (AVDD1 – AVSS), (AVDD2 – AVSS), and (CAPA – AVSS). Valid conversion data are available after all power supplies and the reference voltage are stabilized after power-on. The ALV\_FLAG bit of the STATUS register sets when any analog power voltage falls below the respective threshold. Write 1b to clear the bit to detect the next analog supply low-voltage condition. Power cycling the analog power supplies does not reset the ADC. Because a low voltage on the IOVDD supply also resets the internal analog LDO (CAPA), the analog low-voltage flag (ALV\_FLAG) is also set.

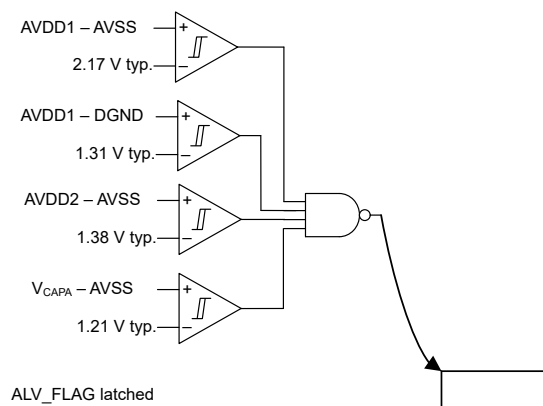


**Figure 8-22. Analog Supply Threshold**

### 8.3.6.5 CAPA and CAPD

CAPA and CAPD are the output voltages of the internal analog and digital voltage regulators. The regulators are used to reduce the supply voltage to operate internal sub-circuits and are not designed to drive external loads. CAPA is the analog regulator voltage output and is powered from AVDD2. The output voltage is 1.6 V with respect to AVSS. Bypass CAPA with a 1- $\mu$ F capacitor to AVSS. CAPD is the digital regulator voltage output, powered from IOVDD. The regulator output is 1.25 V with respect to DGND. Bypass CAPD with a 1- $\mu$ F capacitor to DGND.

### 8.3.7 VCM Output Voltage

The VCM pin provides a buffered output voltage at the mid-point of the AVDD1 – AVSS power supply. The VCM voltage is intended to drive the output common-mode control input of a fully differential amplifier (FDA) to establish the common-mode voltage for the ADC input signal. With many types of FDAs, the same common-mode voltage is provided when the common-mode control input of these devices are floated when using the same power supply. If VCM is not used, the pin can be left unconnected. The VCM output is enabled by the VCM bit of the [CONFIG1](#) register.

## 8.4 Device Functional Modes

### 8.4.1 Power-Scalable Speed Modes

The ADC offers two power-scalable speed modes that determine the range of conversion data rates and power consumed by the ADC. The modes allow optimization of signal bandwidth, data rate, and power consumption. High-speed mode provides maximum data rate and signal bandwidth, and low-speed mode minimizes power consumption for applications that do not require large signal bandwidths. The ADC clock frequency must be adapted to the operating mode. For high-speed mode the clock frequency is 25.6 MHz, and for low-speed mode the clock frequency is 3.2 MHz (see the [Clock Operation](#) section for the internal clock divider option). The speed mode is programmed by the SPEED\_MODE bit of the [CONFIG2](#) register.

### 8.4.2 Idle Mode

When conversions are stopped, the ADC can be programmed to remain in a full-powered idle mode or enter a low-power standby mode. In idle mode, the analog circuit remains fully operational, including sampling of the signal and voltage reference inputs. Only the digital filter is forced inactive. When conversions are restarted, the digital filter is reactivated to begin the conversion process. Idle mode (default) is programmed by the STBY\_MODE bit of the [CONFIG2](#) register.

### 8.4.3 Standby Mode

The ADC has the option of engaging the standby mode when conversions are stopped. Standby mode is an automatic power-down mode enabled by the STBY\_MODE bit of the [CONFIG2](#) register. Standby is entered and exited when conversions stop and start, respectively. During standby, sampling of the signal and reference voltage are stopped. When conversions are restarted, sampling of the signal and reference voltages resume. Exiting standby mode requires an additional 24 clock cycles to the normal conversion latency time.

#### 8.4.4 Power-Down Mode

Power-down mode is engaged by setting the PWDN bit of the [CONFIG2](#) register. In power-down mode, the analog and digital sections are powered off, except for a small bias current required to maintain SPI operation needed to exit power-down mode by clearing the register bit. The digital LDO also remains active to maintain user register settings. The sampling of the signal and voltage reference are stopped during power-down mode. Exit power-down mode by writing 0b to the PWDN bit or by resetting the device.

#### 8.4.5 Reset

The ADC performs an automatic reset at power-on and can also be manually reset by the  $\overline{\text{RESET}}$  pin or SPI operation. At reset the control logic, digital filter, and SPI restart and the user registers reset to the default values. See [Figure 6-3](#) for details when the ADC is available for operation after reset.

##### 8.4.5.1 $\overline{\text{RESET}}$ Pin

The  $\overline{\text{RESET}}$  pin is an active low input. The ADC is reset by taking  $\overline{\text{RESET}}$  low then back high. Because the  $\overline{\text{RESET}}$  pin has an internal 20-k $\Omega$  pullup resistor,  $\overline{\text{RESET}}$  can be left unconnected if not used. The  $\overline{\text{RESET}}$  pin is a Schmitt-triggered input designed to reduce noise sensitivity. See [Figure 6-3](#) for  $\overline{\text{RESET}}$  pin timing and for the start of SPI communications after reset. Because the ADC performs an automatic reset at power-on, a reset is not required after device power-on.

##### 8.4.5.2 Reset by SPI Register Write

The device is reset through SPI operation by writing 01011000b to the CONTROL register. Writing any other value to this register does not result in reset. In 4-wire SPI mode, reset takes effect at the end of the frame at the time  $\overline{\text{CS}}$  is taken high. In 3-wire SPI mode, reset takes effect on the last falling edge of SCLK of the register write operation. Reset in 3-wire SPI mode requires that the SPI is synchronized to the SPI host. If SPI synchronization is not assured, use the pattern described in the [Reset by SPI Input Pattern](#) section to reset the device. Reset can be validated by checking the POR\_FLAG of the STATUS register.

##### 8.4.5.3 Reset by SPI Input Pattern

The device is also reset through SPI operation by inputting a special bit pattern. The input pattern does not follow the input command format. There are two input patterns in which to reset the ADC. Pattern 1 consists of a *minimum* 1023 consecutive ones followed by one zero. The device resets on the falling edge of SCLK when the final zero is shifted in. This pattern can be used for either 3- or 4-wire SPI modes. [Figure 8-23](#) shows a pattern 1 reset example.

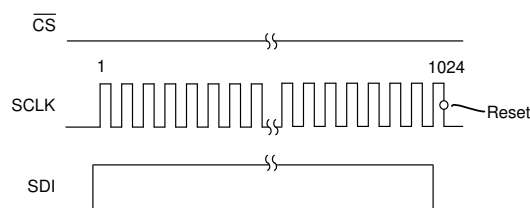


Figure 8-23. Reset Pattern 1 (3-Wire or 4-Wire SPI Mode)

Reset pattern 2 is only for use with the 4-wire SPI mode. To reset, input a *minimum* of 1024 consecutive ones (no ending zero value), followed by taking  $\overline{\text{CS}}$  high at which time reset occurs. Use pattern 2 when the devices are connected in daisy-chain mode. [Figure 8-24](#) shows a pattern 2 reset example.

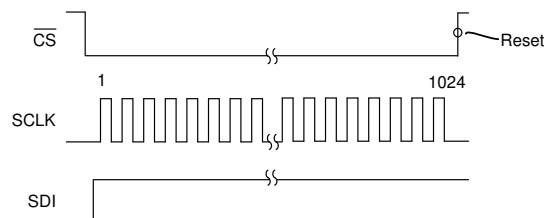


Figure 8-24. Reset Pattern 2 (4-Wire SPI Mode)

### 8.4.6 Synchronization

Conversions are synchronized and controlled by the START pin or, optionally, through SPI operation. If controlling conversions through SPI operation, keep the START pin low to avoid contention with the pin. Writing to any register from 04h through 0Eh causes the conversion to restart, thus resulting in loss of synchronization. Resynchronization of the ADC may be necessary in this case.

The ADC has three modes to synchronize and control conversions: synchronized, start/stop, and one-shot modes, each with specific functionalities. Program the selected mode of synchronization by the START\_MODE[1:0] bits of the [CONFIG2](#) register. Only the start/stop and one-shot control modes can be controlled through SPI operation.

After the ADC is synchronized, the first conversion is fully settled data but incurs a delay (latency time) compared to the normal data period. This latency is needed to account for full settling of the digital filter. The latency time depends on the data rate and the filter mode (see the [Digital Filter](#) section for filter latency details).

#### 8.4.6.1 Synchronized Control Mode

In synchronized control mode, the ADC converts continuously regardless if START is high or low. The ADC is synchronized on the rising edge of START. When synchronized, the first  $\overline{\text{DRDY}}$  falling edge is delayed to account for the filter settling time (latency time). Both a single-pulse input and a continuous-clock input can be applied to the START pin in this mode.

The ADC synchronizes at the rising edge of START. If the time to the next rising edge of START is an  $n$  multiple of the conversion period, within a  $\pm 1 / f_{\text{CLK}}$  window, the ADC does not resynchronize ( $n = 1, 2, 3$ , and so on). Synchronization does not occur because the ADC conversion period is already synchronized to the period of the START signal. If the period of the START signal is *not* an  $n$  multiple of the conversion period, the ADC resynchronizes. As a result of the propagation delay of the digital filter, a phase difference exists between the START signal and the  $\overline{\text{DRDY}}$  output. [Figure 8-25](#) shows synchronization to the START signal when the period of START pulses is not equal to an  $n$  multiple of the conversion period.

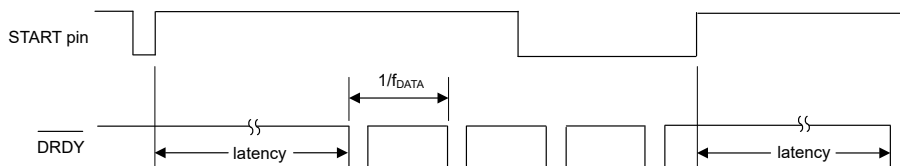


**Figure 8-25. Synchronized Control Mode**

#### 8.4.6.2 Start/Stop Control Mode

Start/stop control mode is a gate-control mode used to start and stop conversions. Conversions are started by taking the START pin high or, if conversions are controlled through SPI operation, by writing 1b to the START bit of the [CONTROL](#) register. Preclear the CONTROL register by writing 00h before setting the START bit. Conversions continue until stopped by taking the START pin low, or by writing 1b to the STOP bit through SPI operation.  $\overline{\text{DRDY}}$  is driven high at conversion start and is driven low when each conversion data are ready. If START is taken low or 1b is written to the STOP bit while conversions are in progress, the ongoing conversion finishes as normal and then stops. (See [Figure 6-4](#) for detailed START timing).

To restart an ongoing conversion, pulse START low to high, or write 1b to the START bit a second time. [Figure 8-26](#) illustrates the START and  $\overline{\text{DRDY}}$  operation. If conversions are stopped in standby mode,  $\overline{\text{DRDY}}$  returns high three clock cycles after falling low, otherwise  $\overline{\text{DRDY}}$  remains low until being forced high at the eighth SCLK edge during conversion data readout. If data are not read,  $\overline{\text{DRDY}}$  remains low and pulses high just before the next  $\overline{\text{DRDY}}$  falling edge.

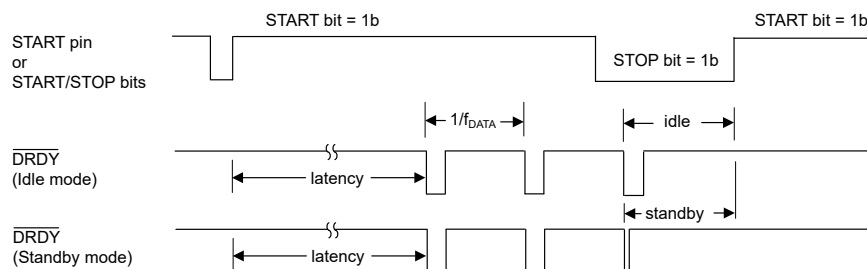


**Figure 8-26. Start/Stop Control Mode**

#### 8.4.6.3 One-Shot Control Mode

One-shot control mode initiates a single conversion when START is taken high or, through SPI operation, when the START bit of the [CONTROL](#) register is set to 1b.  $\overline{\text{DRDY}}$  drives high to indicate the conversion is started and drives low when the conversion is complete. Data are available for readback at that time.

Taking START low, or writing 1b to the STOP bit, does not interrupt the ongoing conversion. The STOP bit has no effect. To restart the conversion, pulse START low to high, or write 1b to the START bit a second time. [Figure 8-27](#) shows the one-shot control mode operation. In standby mode,  $\overline{\text{DRDY}}$  returns high three clock cycles after transitioning low, otherwise  $\overline{\text{DRDY}}$  remains low until forced high at the next rising edge of START.

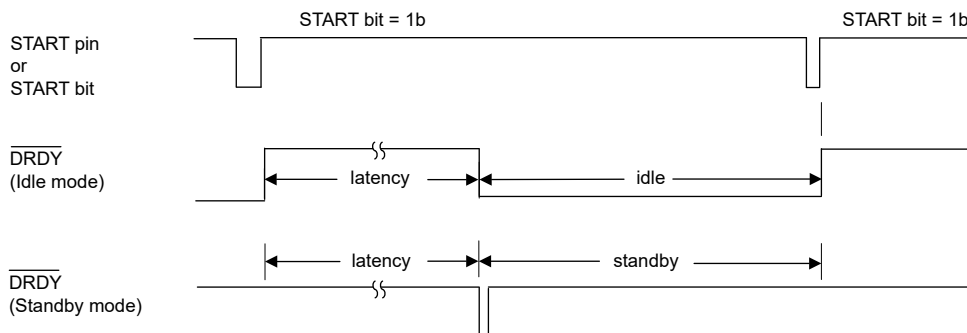


**Figure 8-27. One-Shot Control Mode**

#### 8.4.7 Conversion-Start Delay Time

A programmable delay time is provided to delay the start of the conversion cycle after the START pin or START bit is asserted. This delay time allows for settling of external components, such as the voltage reference after exiting standby mode, or for additional settling time when switching the signal through an external multiplexer. After the initial delay time, subsequent conversions are not delayed. The programmed value of this delay time adds to the value of the conversion latency time of the digital filter. See the DELAY[2:0] bits of the [CONFIG3](#) register for programming details.

### 8.4.8 Calibration

The ADS117L11 provides the ability to calibrate offset and gain errors by user-programmable offset and gain correction registers. As shown in Figure 8-28, the 24-bit offset correction value is subtracted from the conversion data before being multiplied by the 24-bit gain correction value. Final output data are rounded to 16-bit resolution and clipped to +FS and –FS code values after the calibration operation.

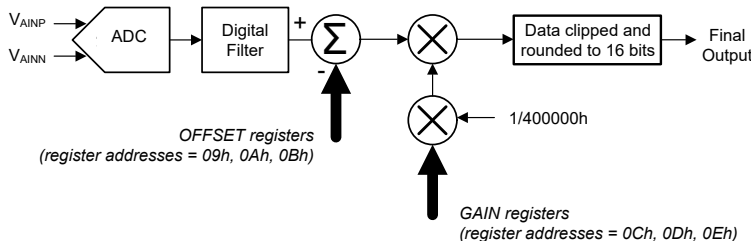


**Figure 8-28. Calibration Block Diagram**

Equation 15 shows how conversion data are calibrated:

$$\text{Final Output Data} = (\text{Data} - \text{OFFSET}) \times \text{GAIN} / 400000h \quad (15)$$

#### 8.4.8.1 OFFSET2, OFFSET1, OFFSET0 Calibration Registers (Addresses 9h, Ah, Bh)

The offset calibration value is a 24-bit value consisting of three 8-bit registers coded in 2's-complement format. The offset value is subtracted from the conversion data. The 16-bit output data is left-justified to the 24-bit offset value with register 09h the most-significant byte, register 0Ah the middle byte, and register 0Bh the sub-LSB byte. Table 8-9 shows example offset calibration values.

**Table 8-9. Offset Calibration Values**

| OFFSET CALIBRATION VALUE | OFFSET APPLIED |
|--------------------------|----------------|
| 001000h                  | –16 LSB        |
| 000100h                  | –1 LSB         |
| FFFF00h                  | 1 LSB          |
| FFF000h                  | 16 LSB         |

#### 8.4.8.2 GAIN2, GAIN1, GAIN0 Calibration Registers (Addresses 0Ch, 0Dh, 0Eh)

The gain calibration value is a 24-bit value consisting of three 8-bit registers coded in straight binary format and normalized to unity gain at 400000h. Register 0Ch is the most-significant byte, register 0Dh is the middle byte, and register 0Eh is the least-significant byte. For example, to correct a gain error greater than 1, the calculated gain calibration value is less than 400000h. Table 8-10 shows example gain calibration values.

**Table 8-10. Gain Calibration Values**

| GAIN CALIBRATION VALUE | GAIN APPLIED |
|------------------------|--------------|
| 433333h                | 1.05         |
| 400000h                | 1            |
| 3CCCCCh                | 0.95         |

### 8.4.8.3 Calibration Procedure

The recommended calibration procedure is as follows:

1. Preset the offset and gain calibration registers to 000000h and 400000h, respectively.
2. Perform offset calibration in bipolar input mode by shorting the ADC inputs, or short the inputs at the system level to include the offset error of the external amplifier stages. In unipolar mode, perform offset calibration with inputs greater than 0 V to avoid clipped readings that occur with inputs less than 0 V. Acquire conversion data and write the average value of the data to the offset calibration registers. Averaging the data reduces conversion noise to improve calibration accuracy.
3. Perform gain calibration by applying a calibration signal to the ADC input or at the system level to include the gain error of the external buffer stages. For the standard input range mode, choose the calibration voltage to be less than the full-scale input range to avoid clipping the output code. Clipped output codes result in inaccurate calibration. For example, use a 3.9-V calibration signal with  $V_{REF} = 4.096$  V. When operating in the extended range mode, the calibration signal can be equal to  $V_{REF}$  without causing clipped output codes. Acquire conversion data and average the results. Use [Equation 16](#) to calculate the gain calibration value.

$$\text{Gain Calibration Value} = (\text{expected output code} / \text{actual output code}) \cdot 4000h \quad (16)$$

For example, the expected output code of a 3.9-V calibration voltage using a 4.096-V reference voltage is:  
 $(3.9 \text{ V} / 4.096 \text{ V}) \cdot 7FFFh = 79E0h$ .

## 8.5 Programming

### 8.5.1 Serial Interface (SPI)

The serial interface is used to read conversion data, configure device registers, and control ADC conversions. The optional CRC mode is used to validate error-free data transmission between the host and ADC. A separate CRC based on the register map is used to detect register map changes after the initial register data are loaded.

The serial interface consists of four lines:  $\overline{CS}$ , SCLK, SDI, and SDO/ $\overline{DRDY}$ . The interface operates in the peripheral mode (passive) where SCLK is driven by the host. The interface is compatible to SPI mode 1 (CPOL = 0 and CPHA = 1). In SPI mode 1, SCLK idles low, and data are updated on SCLK rising edges and read on SCLK falling edges. The interface supports full-duplex operation, meaning input data and output data can be transmitted simultaneously. The interface also supports daisy-chain connection of multiple ADCs to simplify the SPI connection.

#### 8.5.1.1 Chip Select ( $\overline{CS}$ )

$\overline{CS}$  is an active-low input that enables the interface for communication. The communication frame is started by taking  $\overline{CS}$  low and is ended by taking  $\overline{CS}$  high. When  $\overline{CS}$  is taken high, the device ends the frame by interpreting the last 16-bits of input data (24 bits in CRC mode) regardless of the total number of bits shifted in. When  $\overline{CS}$  is high, the SPI interface resets, commands are blocked, and SDO/ $\overline{DRDY}$  enters a high-impedance state.  $\overline{DRDY}$  is an active output regardless of the state of  $\overline{CS}$ .  $\overline{CS}$  can be tied low to operate the interface in 3-wire SPI mode.

#### 8.5.1.2 Serial Clock (SCLK)

SCLK is the serial clock input used to shift data into and out of the ADC. Output data are updated on the rising edge of SCLK and input data are latched on the falling edge of SCLK. SCLK is a Schmitt-triggered input designed to increase noise immunity. Even though SCLK is noise resistant, keep SCLK as noise-free as possible to avoid unintentional SCLK transitions. Avoid ringing and overshoot on the SCLK input. A series termination resistor at the SCLK driver can often reduce ringing.

#### 8.5.1.3 Serial Data Input (SDI)

SDI is the serial interface data input. SDI is used to input data to the device. Input data are latched on the falling edge of SCLK. SDI can be idled high or low when not active.

#### 8.5.1.4 Serial Data Output/Data Ready (SDO/ $\overline{DRDY}$ )

SDO/ $\overline{DRDY}$  is a dual-function output pin. This pin is programmable to provide output data only, or to provide output data and the data-ready indication. The dual-function mode multiplexes output data and data-ready operations on a single pin. Output data are updated on the rising edge of SCLK. The SDO/ $\overline{DRDY}$  pin is in a high-Z state when  $\overline{CS}$  is high. See the [SDO/ \$\overline{DRDY}\$](#)  section for details of dual-function operation. The SDO\_MODE bit of the [CONFIG2](#) register programs the mode.

### 8.5.2 SPI Frame

Communication through the serial interface is based on the concept of frames. A frame consists of a prescribed number of SCLKs required to shift in or shift out data. A frame is started by taking  $\overline{CS}$  low and is ended by taking  $\overline{CS}$  high. When  $\overline{CS}$  is taken high, the device interprets the last 16 bits (or 24 bits in CRC mode) of input data regardless of the amount of data shifted into the device. In typical use, the input frame is sized to match the output frame by padding the frame with leading zeros if needed. However, if not transmitting and receiving data in full-duplex mode, the input data frame can be the minimum size of 16 bits (or 24 bits in CRC mode). The output frame size, as given in [Table 8-11](#), depends on the optional STATUS header and CRC bytes. After the ADC is powered up or reset, the default output frame size is 16 bits. In 3-wire SPI mode, the input frame must match the size of the output frame for the SPI to remain synchronized.

**Table 8-11. Output Frame Size**

| STATUS BYTE | CRC BYTE | FRAME SIZE |
|-------------|----------|------------|
| No          | No       | 16 bits    |
| No          | Yes      | 24 bits    |
| Yes         | No       | 24 bits    |
| Yes         | Yes      | 32 bits    |

### 8.5.3 SPI CRC

The SPI cyclic redundancy check (CRC) is an SPI check code used to detect transmission errors to and from the host controller. A CRC byte is transmitted with the ADC input data by the host and a CRC byte is transmitted with the output data by the ADC. The SPI CRC error check is enabled by the SPI\_CRC bit of the [CONFIG4](#) register.

The CRC code is calculated by the host on the two command bytes. Any input bytes padded to the start of the frame are not included in the CRC calculation. The ADC checks the input command CRC code against an internal code calculated over the two input command bytes. If the CRC codes do not match, the command is not executed and the SPI\_ERR bit is set in the STATUS byte. Register write operations are blocked except to the STATUS register to allow clearing the SPI CRC error by writing 1b to the SPI\_ERR bit. Register read operations are not blocked unless an SPI\_CRC error is detected in the immediately preceding register-read command frame.

The number of bytes used to calculate the output CRC code depends on the amount of data bytes transmitted in the frame. All data bytes that precede the output CRC code are used in the CRC calculation. [Table 8-12](#) shows the number of bytes used for the output CRC calculation.

**Table 8-12. Byte Count of Output CRC Code**

| BYTE COUNT | BYTE FIELD DESCRIPTION                        |
|------------|-----------------------------------------------|
| 2          | 16 bits of conversion data                    |
| 2          | One byte of register data + 00h pad byte      |
| 3          | 16 bits of conversion data + STATUS byte      |
| 3          | One byte of register data + two 00h pad bytes |

The CRC code calculation is the 8-bit remainder of the bitwise exclusive-OR (XOR) operation of the variable length argument with the CRC polynomial. The CRC is based on the CRC-8-ATM (HEC) polynomial:  $X^8 + X^2 + X^1 + 1$ . The nine coefficients of the polynomial are: 100000111. The input argument is XOR'd with FFh allowing error detection in the event that SDI and SDO/DRDY fail high or fail low.

The following procedure is used to compute the CRC code value:

1. Left shift the initial data value by eight bits by appending 0s in the LSB, creating a new data value.
2. XOR the MSB of the new data value from step 1 with FFh.
3. Align the MSB of the CRC polynomial (100000111) to the left-most, logic 1 of the data.
4. The bits of the data values that are not in alignment with the CRC polynomial drop down and append to the right of the new XOR result. XOR the data value with the aligned CRC polynomial. The XOR operation creates a new, shorter-length value.
5. If the XOR result is less than 100h, the procedure ends, yielding the 8-bit CRC code result. Otherwise, continue with the XOR operation at step 3 using the current XOR result. The number of loop iterations depend on the value of the initial data.

### 8.5.4 Register Map CRC

The register map CRC is used to check the register map contents for unintended changes. Write a new register map CRC code to the [CRC](#) register whenever the registers are changed. The CRC code is calculated over the 00h to 0Eh register addresses, skipping the 02h and 03h addresses (STATUS and CONTROL registers). The ADC continuously compares the CRC code written to the CRC register to an internal value. If the values do not match, the REG\_ERR bit in the [STATUS](#) register is set. If set, correct the register values or update the

CRC code then write 1b to the bit to clear the error flag. No other action is taken by the ADC in the event of a register map error. The register map CRC check is optional and is enabled by the REG\_CRC bit of the CONFIG4 register.

Read the REV\_ID register of the individual ADC when calculating the CRC code because the REV\_ID can change during device production without notice. Set the REG\_CRC bit to 1 (enabled) when calculating the CRC code because this bit must be set to enable the CRC check. The register map CRC code computation is the same as the one shown in the [SPI CRC](#) section.

### 8.5.5 Full-Duplex Operation

The serial interface supports full-duplex operation. Full-duplex operation allows the simultaneous transmission and reception of data in one frame. For example, the register read command for the next register can be input at the same time that data of the previously addressed register are output, which doubles the throughput when reading multiple registers. An example of full-duplex operation is illustrated in [Figure 8-30](#).

### 8.5.6 Device Commands

Commands are used to read and write register data. The register map of [Table 8-16](#) consists of a series of one-byte registers, accessible by read and write operations. The minimum frame length of the input command sequence is two bytes (three bytes in CRC mode). If desired, the input command sequence can be padded with leading zeros to match the length of the output data frame. In CRC mode, the device interprets the two bytes immediately preceding the CRC byte at the end of the frame. [Table 8-13](#) shows the ADS117L11 device commands.

**Table 8-13. SPI Commands**

| DESCRIPTION            | BYTE1               | BYTE2         | BYTE 3 (Optional CRC Byte) |
|------------------------|---------------------|---------------|----------------------------|
| No operation           | 00h                 | 00h           | D7h                        |
| Read register command  | 40h + address [3:0] | Don't care    | CRC of byte 1 and byte 2   |
| Write register command | 80h + address [3:0] | Register data | CRC of byte 1 and byte 2   |

There are special extended-length bit patterns that are longer than the standard command length. These patterns are used to reset the ADC and to reset the frame in three-wire SPI operation. The extended bit patterns are explained in the [Reset by SPI Input Pattern](#) and [3-Wire SPI Mode](#) sections.

#### 8.5.6.1 No-Operation

The no-operation command bytes are 00h and 00h. Use this command if no input command is desired. If the SPI CRC check is enabled, the CRC byte is required (byte 3), which is always D7h for bytes 00h and 00h. SDI can be held low during data readback, but in CRC mode the SPI\_ERR flag is set, which blocks future register write operations. The SPI\_ERR flag can be ignored while reading conversion data until the next register write operation. At that point, the SPI\_ERR flag of the STATUS register must be manually cleared by writing 1b.

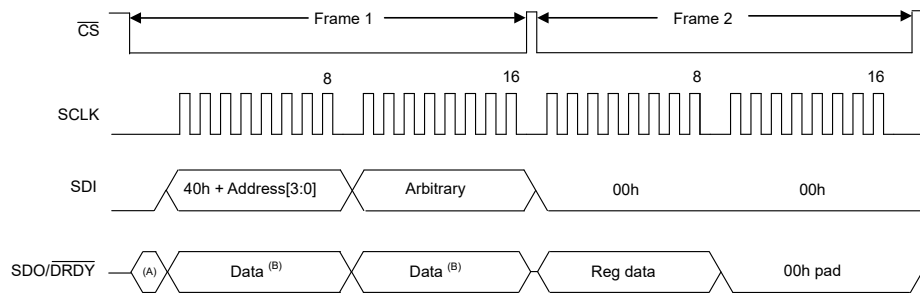
#### 8.5.6.2 Read Register Command

The read register command is used to read register data. The command follows an off-frame protocol in which the read command is sent in one frame and the ADC responds with register data in the next frame. The first byte of the command is the base command value (40h) added to the 4-bit register address. The value of the second command byte is arbitrary, but is used together with the first byte for the CRC. The response to registers outside the valid address range is 00h. The register data format is most-significant-bit first.

[Figure 8-29](#) illustrates an example of reading register data using the 16-bit output frame size. Frame 1 is the command frame and frame 2 is the data response frame. The frames are delimited by taking CS high. The data response frame is padded with 00h after the register data byte to fill the 16-bit frame. If desired, the data response frame can be shortened after the data byte by taking CS high.

If operating in full-duplex mode (such as a simultaneous read of 16-bit conversion data + CRC byte option during the input of the register read command), pad the command frame with a leading 00h value to match the length of the data response frame. When configuring multiple registers, full-duplex operation can be used to double the

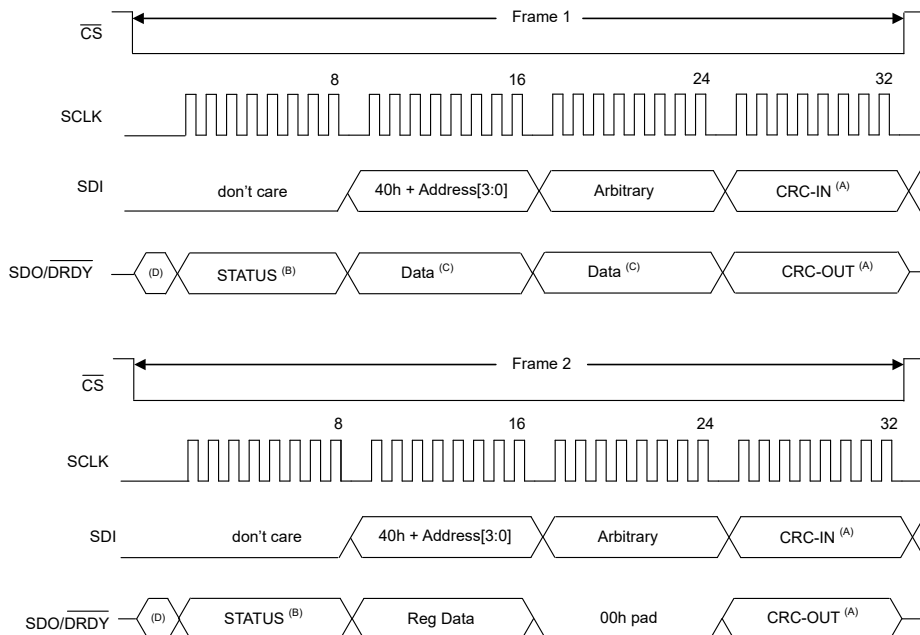
throughput of the read register operations by inputting the next read register command during the data response frame of the previous register.



- A. Previous state of SDO/DRDY before the first SCLK.
- B. Data are either 16 bits of conversion data, or if the read register command is sent in the prior frame, the data field is the register data byte + 00h pad byte.

**Figure 8-29. Read Register Data, Minimum 16-Bit Frame Size**

Figure 8-30 shows an example of the read register operation using the maximum 32-bit frame size in full-duplex operation. In frame 1, conversion data are output at the same time as the input of the read register command (if the previous frame was not a read register command). The input command is padded with a don't care byte in order to match the length of the output data frame. The input pad byte is excluded from the CRC-IN code calculation. Frame 2 shows the input of the next read register command concurrent with the output of the previous register data. A zero-value pad byte is added after the register data to place CRC-OUT in the same location as with a conversion data output frame. The CRC-OUT code includes all preceding bytes within the data output frame. The SPI\_ERR bit of the STATUS header indicates if an SPI CRC error occurred and whether the read register command is accepted.



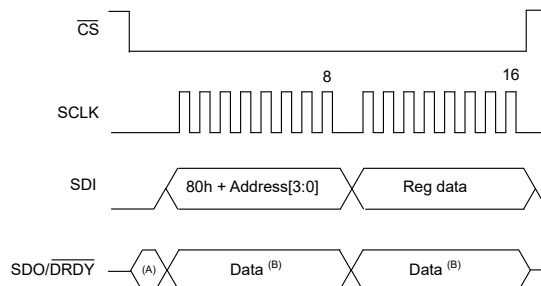
- A. Optional CRC byte. If CRC is disabled, the frame shortens by one byte.
- B. Optional STATUS byte. If STATUS is disabled, the frame shortens by one byte.
- C. Depending on the previous operation, the data field is either conversion data or register data + one 00h pad byte
- D. Previous state of SDO/DRDY before the first SCLK.

**Figure 8-30. Read Register Data, Maximum 32-Bit Frame Size**

### 8.5.6.3 Write Register Command

The write register command is used to write register data. The write register operation is performed in a single frame. The first byte of the command is the base value (80h) added to the 4-bit register address. The second byte of the command is the register data. Write operations to registers outside the valid address range are ignored.

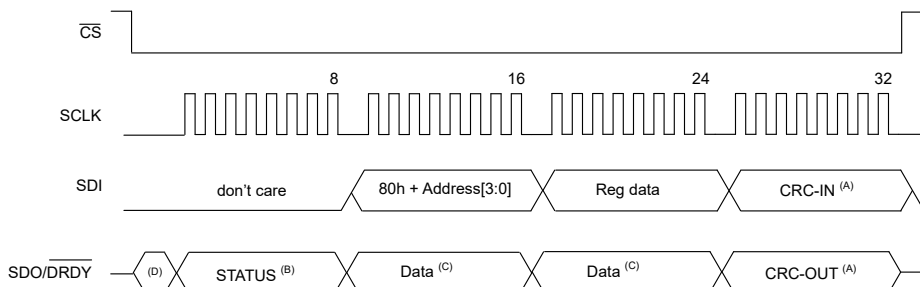
Figure 8-31 shows an example of a register write operation using the 16-bit frame size. If operating in full-duplex mode (simultaneous reading of 16-bit conversion data + CRC and STATUS bytes during the input of the register write command), include one or more leading pad bytes as necessary to the input data to match the length of the output frame. When configuring a series of registers (when conversion data can be ignored), the minimum 16-bit frame size can be used for the best throughput.



- A. Previous state of SDO/DRDY before the first SCLK.
- B. Data are either the conversion data, or if the read register command was sent in a prior frame, the data field is register data byte + one 00h pad byte.

**Figure 8-31. Write Register Data, Minimum 16-Bit Frame Size**

Figure 8-32 shows an example of a write register operation using the maximum 32-bit frame size. Full-duplex operation is also illustrated to show simultaneous input of the command and output of conversion data. The input frame is prefixed with a *don't care* byte to match the output frame length so all conversion data bytes are transmitted. Successful write operations are verified by reading back the register data, or by checking the SPI\_ERR bit of the STATUS byte for input byte CRC errors. If an SPI CRC input error occurred, SPI\_ERR is set and further register write operations are blocked (except for the STATUS register) until reset by writing 1b to the same SPI\_ERR bit.



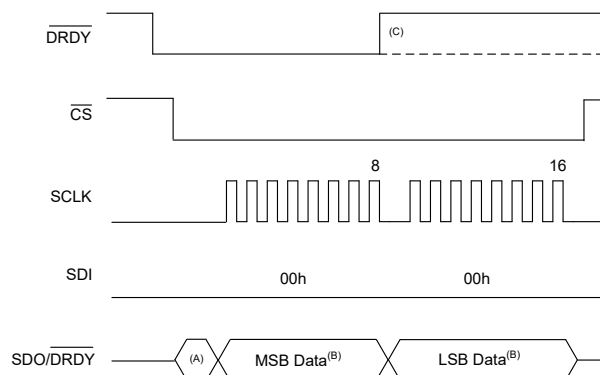
- A. Optional CRC byte. If CRC is disabled, the frame shortens by one byte.
- B. Optional STATUS byte. If STATUS is disabled, the frame shortens by one byte.
- C. The data field is either 16-bits of conversion data, or if the read register command was sent in the prior frame, register data byte + one 00h pad byte.
- D. Previous state of SDO/DRDY before the first SCLK.

**Figure 8-32. Write Register Data, Maximum 32-Bit Frame Size**

## 8.5.7 Read Conversion Data

Conversion data are read by taking  $\overline{\text{CS}}$  low and by applying SCLK to shift out data directly (no command is used). Conversion data are buffered, which allows data to be read up to one  $f_{\text{MOD}}$  clock cycle before the next  $\overline{\text{DRDY}}$  falling edge. Conversion data may be read multiple times until the next conversion data are ready. If the register read command was sent in the previous frame then register data replaces the conversion data.

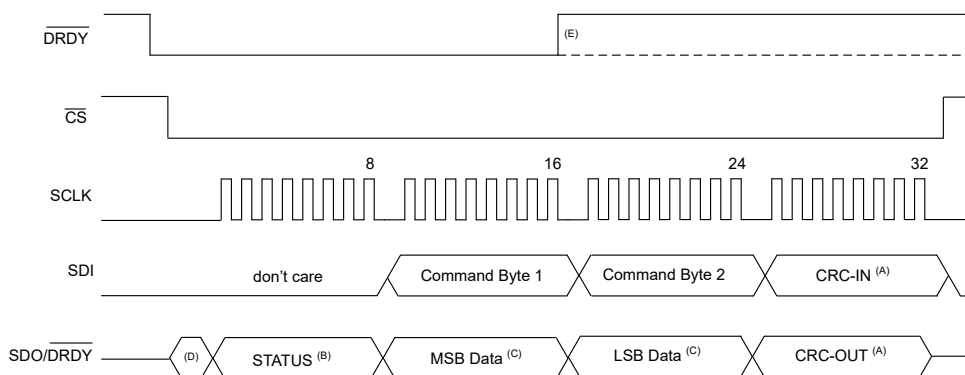
Figure 8-33 shows an example of reading the 16-bit conversion data with the STATUS and CRC bytes disabled.



- A. Before the first SCLK, SDO/ $\overline{\text{DRDY}}$  is the previous state when SDO\_MODE = 0b. Otherwise, SDO/ $\overline{\text{DRDY}}$  follows  $\overline{\text{DRDY}}$ .
- B. The data field is two bytes.
- C. In synchronized and start/stop control modes,  $\overline{\text{DRDY}}$  returns high at the eighth SCLK falling edge. In one-shot control mode,  $\overline{\text{DRDY}}$  remains low until a new conversion is started.

**Figure 8-33. Conversion Data Read, Short Format**

Figure 8-34 is an example of the long-format read data operation, which includes the STATUS header byte and the CRC byte. This example also shows the optional use of a full-duplex transmission when a register command is input at the same time the conversion data are output. If no input command is desired, the input bytes are 00h, 00h, and D7h. The output CRC (CRC-OUT) code computation includes the STATUS byte. If the conversion data readback is stopped after the eighth SCLK of the MSB data,  $\overline{\text{DRDY}}$  returns high and the DRDY bit of the STATUS header goes low to indicate a data-read attempt.



- A. Optional CRC byte. If the CRC is disabled, the frame shortens by one byte.
- B. Optional STATUS header. If STATUS is disabled, the frame shortens by one byte.
- C. The data field is two bytes.
- D. If the SDO\_MODE bit = 0, the previous state of SDO/ $\overline{\text{DRDY}}$  remains until SCLK begins. Otherwise, SDO/ $\overline{\text{DRDY}}$  follows  $\overline{\text{DRDY}}$ .
- E. In synchronized and start/stop control modes,  $\overline{\text{DRDY}}$  returns high at the 16th SCLK falling edge (eighth bit of the MS data byte). In one-shot control mode,  $\overline{\text{DRDY}}$  stays low until a new conversion is started.

**Figure 8-34. Conversion Data Read, Long Format**

Conversion data can be read asynchronous to  $\overline{\text{DRDY}}$ . However, when conversion data are read close to the  $\overline{\text{DRDY}}$  falling edge, there is uncertainty whether previous data or new data are output. If the SCLK shift operation

starts at least one  $f_{MOD}$  clock cycle before the  $\overline{DRDY}$  falling edge, then old data are provided. If the shift operation starts at least one  $f_{MOD}$  clock cycle *after*  $\overline{DRDY}$ , then new data are output. The  $DRDY$  bit of the STATUS header indicates if the data are old (previously read data) or new.

### 8.5.7.1 Conversion Data

If the input is configured for bipolar mode, the conversion data are coded in 2's-complement format, MSB (sign bit) first, to represent positive and negative signals over the range of  $-V_{REF}$  to  $V_{REF}$ . If the input is configured for unipolar mode, the conversion data are coded in straight-binary format to represent only positive signals over the range of 0 V to  $V_{REF}$ . Table 8-14 and Table 8-15 show the output data format for bipolar and unipolar input modes. The conversion data are clipped to positive and negative full-scale code values when the input signal exceeds the respective positive and negative full-scale signal range.

**Table 8-14. Conversion Data Format (Bipolar Input Mode)**

| INPUT VOLTAGE (V) <sup>(1)</sup>                         | STANDARD RANGE <sup>(2)</sup> | EXTENDED RANGE <sup>(2)</sup> |
|----------------------------------------------------------|-------------------------------|-------------------------------|
| $1.25 \cdot k \cdot V_{REF} \cdot (2^{15} - 1) / 2^{15}$ | 7FFFh                         | 7FFFh                         |
| $k \cdot V_{REF} \cdot (2^{15} - 1) / 2^{15}$            | 7FFFh                         | 6666h                         |
| $k \cdot V_{REF} / 2^{15}$                               | 0001h                         | 0001h                         |
| 0                                                        | 0000h                         | 0000h                         |
| $-k \cdot V_{REF} / 2^{15}$                              | FFFFh                         | FFFFh                         |
| $-k \cdot V_{REF}$                                       | 8000h                         | 999Ah                         |
| $-1.25 \cdot k \cdot V_{REF}$                            | 8000h                         | 8000h                         |

**Table 8-15. Conversion Data Format (Unipolar Input Mode)**

| INPUT VOLTAGE (V) <sup>(1)</sup> | STANDARD RANGE <sup>(2)</sup> | EXTENDED RANGE <sup>(2)</sup> |
|----------------------------------|-------------------------------|-------------------------------|
| $1.25 \cdot k \cdot V_{REF}$     | FFFFh                         | FFFFh                         |
| $k \cdot V_{REF}$                | FFFFh                         | CCCCh                         |
| $k \cdot V_{REF} / 2^{16}$       | 0001h                         | 0001h                         |
| $\leq 0$                         | 0000h                         | 0000h                         |

(1)  $k = 1x$  or  $2x$  input range option.

(2) Ideal output data, excluding offset, gain, linearity, and noise errors.

### 8.5.7.2 Data Ready

There are several methods available to determine when conversion data are ready for readback.

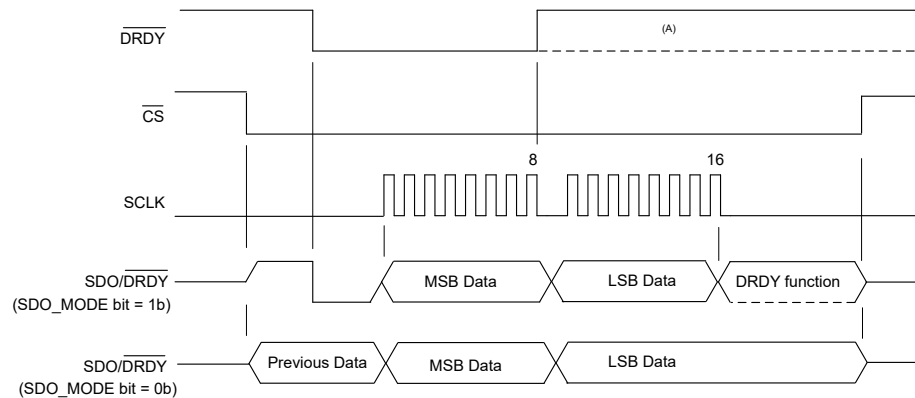
1. Hardware: Monitor the  $\overline{DRDY}$  or the SDO/ $\overline{DRDY}$  pin
2. Software: Monitor the  $DRDY$  bit of the STATUS header byte
3. Clock count: Count the number of ADC clocks to predict when data are ready

#### 8.5.7.2.1 $\overline{DRDY}$

$\overline{DRDY}$  is the data-ready output signal.  $\overline{DRDY}$  drives high when conversions are started or resynchronized, and drives low when conversion data are ready.  $\overline{DRDY}$  is driven back high at the eighth SCLK during conversion data read. This behavior applies to the synchronized and the start/stop control modes. In one-shot control mode,  $\overline{DRDY}$  stays low during conversion data read. If the ADC is programmed to enter standby mode (STBY\_MODE bit = 1b),  $\overline{DRDY}$  is driven back high three  $f_{CLK}$  cycles after transitioning low. If conversion data are not read,  $\overline{DRDY}$  pulses high just prior to the next falling edge. See the [Synchronization](#) section for details of  $\overline{DRDY}$  operation for each of the conversion control modes.  $\overline{DRDY}$  is an active output whether  $\overline{CS}$  is high or low.

#### 8.5.7.2.2 SDO/ $\overline{DRDY}$

SDO/ $\overline{DRDY}$  is a dual-function output pin that can be programmed to automatically change modes from data ready, when not reading data, to data output mode, when reading data. This pin can replace the function of the  $\overline{DRDY}$  pin to conserve the number of SPI I/O lines. When programmed to the dual-function mode (SDO\_MODE bit = 1b) and when  $\overline{CS}$  is low, SDO/ $\overline{DRDY}$  mirrors  $\overline{DRDY}$  until the first rising edge of SCLK, at which time the pin changes mode to provide data output. When the data read operation is complete (16th falling edge of SCLK, or 32nd edge if the CRC and STATUS header bytes are included), the pin reverts back to mirroring  $\overline{DRDY}$ . [Figure 8-35](#) illustrates the operation of SDO/ $\overline{DRDY}$ .



- A. In synchronized and start/stop control modes,  $\overline{\text{DRDY}}$  returns high at the eighth SCLK falling edge (eighth bit of MSB data). In one-shot control mode,  $\overline{\text{DRDY}}$  stays low until a new conversion is started.

**Figure 8-35. SDO/DRDY and DRDY Function**

#### 8.5.7.2.3 DRDY Bit

The software method of determining data ready is by polling the DRDY bit (bit 0 of the STATUS header). When  $\text{DRDY} = 1\text{b}$ , the data are new from the last data read operation, otherwise the data supplied are the previous data. After data are read, the bit stays cleared until the next conversion data are ready. To avoid missing data, poll the bit at least as often as the output data rate.

#### 8.5.7.2.4 Clock Counting

Another method to determine when data are ready is to count clock cycles. This method is only possible using an external clock because the internal clock oscillator is not observable. After synchronization or conversion start, the number of clock cycles of the first conversion increases compared to the normal conversion data period. The initial number of clock cycles is equal to the latency time of the digital filter, as listed in the [Digital Filter](#) section.

#### 8.5.7.3 STATUS Header

A STATUS header is an optional byte prefixed to the conversion data. See [Table 8-20](#) for the STATUS header field descriptions. The STATUS header is enabled by setting the STATUS bit of the [CONFIG4](#) register. The STATUS header byte sent with conversion data has the same content as the STATUS register.

#### 8.5.8 Daisy-Chain Operation

In simultaneous-sampling systems using multiple ADCs, the devices can be connected in a daisy-chain string to reduce the number of SPI connections. A daisy-chain connection links together the SPI output of one device to the SPI input of the next device so the devices in the chain appear as a single logical device to the host controller. There is no special programming required for daisy-chain operation, simply apply additional shift clocks to access all devices in the chain. For simplified operation, program the same SPI frame size for each device (for example, when enabling the CRC option of all devices, thus producing a 24-bit frame size).

[Figure 8-36](#) illustrates four devices connected in a daisy-chain configuration. The SDI of ADS117L11 (1) connects to the host SPI data out, and SDO/DRDY of ADS117L11 (4) connects to the host SPI data input. The shift operation is simultaneous for all devices in the chain. After each ADC shifts out the conversion data, the data of SDI appears on SDO/DRDY to drive the SDI of the next device in the chain. The shift operation continues until the last device in the chain is reached. The SPI frame ends when  $\overline{\text{CS}}$  is taken high, at which time the data shifted into each device is interpreted. The SDO/DRDY pin must be programmed to data output-only mode.

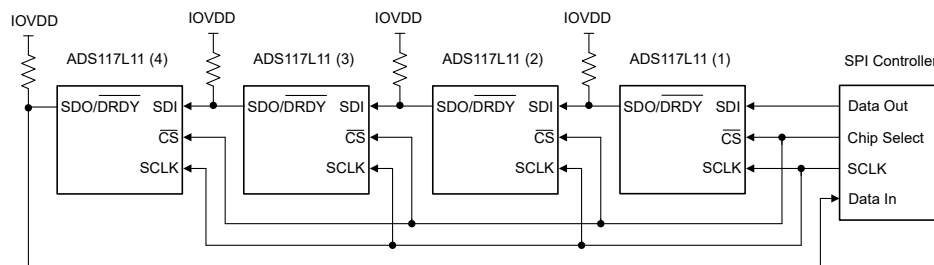


**Figure 8-36. Daisy-Chain Connection**

Figure 8-37 shows the initial communication using 16-bit frame size for each device after device power up.

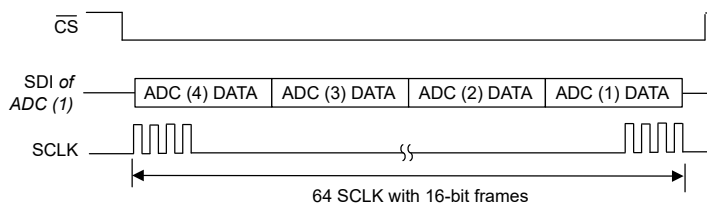
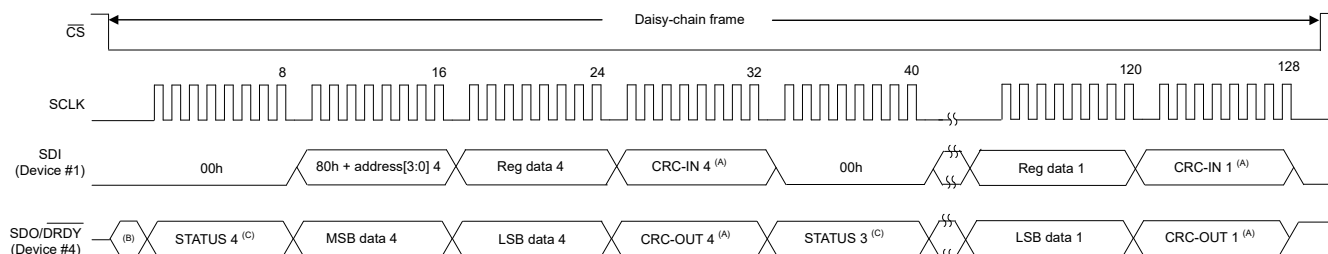


**Figure 8-37. 16-Bit Data Input Sequence**

To input data, the host first shifts in the data intended for the last device in the chain. The number of input bytes for each ADC is sized to match the output frame size. The default frame size is 16 bits (CRC and STATUS bytes are default off), so initially each ADC requires two command bytes. The input data of ADC (4) is first, followed by the input data of ADC (3), and so forth.

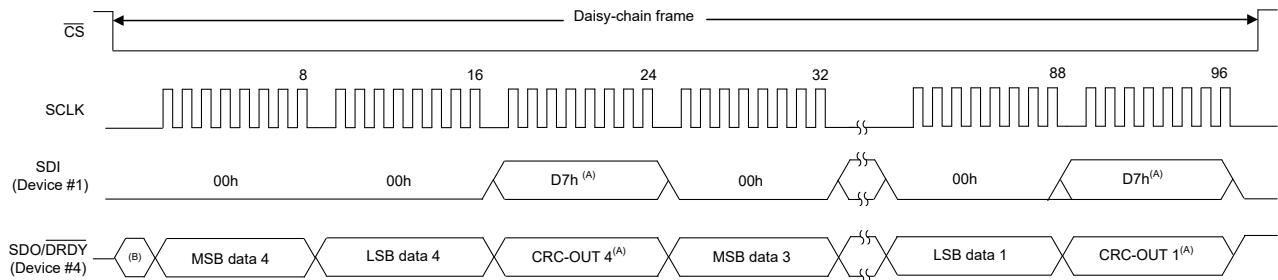
Figure 8-38 shows the detailed input data sequence for the daisy-chain write register operation of Figure 8-36. 32-bit frames for each ADC are shown (16 bits of data, with the STATUS and CRC bytes enabled). Command operations can be different for each ADC. The read register operation requires a second frame operation to read out the register data.



- A. Optional CRC byte. If CRC is disabled, the individual frames shorten one byte.
- B. Previous state of SDO/DRDY before SCLK is applied.
- C. Optional STATUS header. If STATUS is disabled, the individual frames shorten one byte.

**Figure 8-38. Write Register Data in Daisy-Chain Connection**

Figure 8-39 illustrates the clock sequence to read conversion data from the device connection in Figure 8-36. This example illustrates a 24-bit output frame (16-bits of data, with the CRC byte enabled). The output data of ADC (4) is first in the sequence, followed by the data of ADC (3), and so on. The total number of clocks required to shift out the data is given by the number of bits per frame  $\times$  the number of devices in the chain. In this example, 24-bit output frames  $\times$  four devices result in 96 total clocks.



- A. Optional CRC byte. If CRC is disabled, the individual frames shorten one byte.  
B. Previous state of SDO/DRDY before SCLK is applied.

**Figure 8-39. Read Conversion Data in Daisy-Chain Connection**

As shown in Equation 17, the maximum number of devices connected in daisy-chain configuration is limited by the SCLK signal frequency, data rate, and number of bits per frame. The same limitation applies to parallel-connected SPI because the data from each ADC is also read sequentially.

$$\text{Maximum devices in a chain} = \lfloor f_{\text{SCLK}} / (f_{\text{DATA}} \cdot \text{bits per frame}) \rfloor \quad (17)$$

For example, if  $f_{\text{SCLK}} = 20 \text{ MHz}$ ,  $f_{\text{DATA}} = 100 \text{ kSPS}$ , and the maximum length 32-bit frames are used, the maximum number of daisy-chain connected devices is the floor of:  $\lfloor 20 \text{ MHz} / (100 \text{ kHz} \cdot 32) \rfloor = 6$ .

### 8.5.9 3-Wire SPI Mode

The ADC has the option of 3-wire SPI operation by grounding  $\overline{\text{CS}}$ . 3-wire mode is detected by the ADC when  $\overline{\text{CS}}$  is grounded at power up or after reset. 3-wire SPI mode is indicated by bit 7 (CS\_MODE) of the STATUS register. The device changes to 4-wire SPI mode any time  $\overline{\text{CS}}$  is taken high.

Because  $\overline{\text{CS}}$  no longer controls frame timing in 3-wire SPI mode, SCLKs are counted by the ADC to determine the beginning and ending of a frame. The number of SCLK bits must be controlled by the host and must match the size of the output frame. The number of bits per frame depends on device configuration. The size of the output frame is listed in Table 8-11. Because frame timing is determined by the number of SCLKs, avoid inadvertent SCLK transitions, such as those possibly occurring at power up.

3-wire SPI mode supports the same command format and clocking as the 4-wire mode, except there is no  $\overline{\text{CS}}$  toggling and therefore no wait time between frames.

#### 8.5.9.1 3-Wire SPI Mode Frame Reset

In 3-wire SPI mode, an unintended SCLK can misalign the frame, resulting in loss of frame synchronization to the ADC. As shown in Figure 8-40, the SPI is resynchronized without requiring an ADC reset by sending an SPI reset pattern. The reset pattern is a minimum of 63 consecutive 1s followed by one 0 at the 64th SCLK. The 65th SCLK starts a new SPI frame. Optionally, the ADC can be completely reset by toggling  $\overline{\text{RESET}}$  or by the reset pattern shown in the [Reset by SPI Input Pattern](#) section.

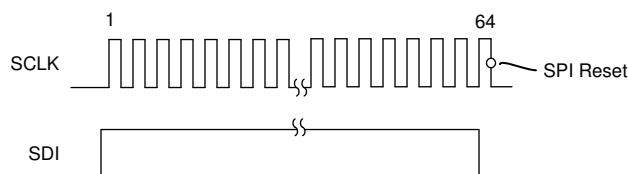


**Figure 8-40. 3-Wire Mode SPI Reset Pattern**

## 8.6 Registers

**Table 8-16** lists the register map of the ADS117L11. Register data are read or written one register at a time for each read or write operation in a frame. Writing to any register address 4h through Eh results in a conversion restart and loss of synchronization. If the ADC is idle (conversions are stopped), new conversions are not started.

**Table 8-16. ADS117L11 Register Map Overview**

| ADDRESS | REGISTER | DEFAULT   | BIT 7         | BIT 6    | BIT 5    | BIT 4           | BIT 3    | BIT 2      | BIT 1     | BIT 0    |
|---------|----------|-----------|---------------|----------|----------|-----------------|----------|------------|-----------|----------|
| 0h      | DEV_ID   | 01h       | DEV_ID[7:0]   |          |          |                 |          |            |           |          |
| 1h      | REV_ID   | xxh       | REV_ID[7:0]   |          |          |                 |          |            |           |          |
| 2h      | STATUS   | x1100xxxb | CS_MODE       | ALV_FLAG | POR_FLAG | SPI_ERR         | REG_ERR  | ADC_ERR    | MOD_FLAG  | DRDY     |
| 3h      | CONTROL  | 00h       | RESET[5:0]    |          |          |                 |          |            | START     | STOP     |
| 4h      | MUX      | 00h       | RESERVED      |          |          |                 |          |            | MUX[1:0]  |          |
| 5h      | CONFIG1  | 00h       | RESERVED      | REF_RNG  | INP_RNG  | VCN             | REFP_BUF | RESERVED   | AINP_BUF  | AINN_BUF |
| 6h      | CONFIG2  | 00h       | EXT_RNG       | RESERVED | SDO_MODE | START_MODE[1:0] |          | SPEED_MODE | STBY_MODE | PWDN     |
| 7h      | CONFIG3  | 00h       | DELAY[2:0]    |          |          | FILTER[4:0]     |          |            |           |          |
| 8h      | CONFIG4  | 08h       | CLK_SEL       | CLK_DIV  | OUT_DRV  | BIP_UNI         | RESERVED | SPI_CRC    | REG_CRC   | STATUS   |
| 9h      | OFFSET2  | 00h       | OFFSET[23:16] |          |          |                 |          |            |           |          |
| Ah      | OFFSET1  | 00h       | OFFSET[15:8]  |          |          |                 |          |            |           |          |
| Bh      | OFFSET0  | 00h       | OFFSET[7:0]   |          |          |                 |          |            |           |          |
| Ch      | GAIN2    | 40h       | GAIN[23:16]   |          |          |                 |          |            |           |          |
| Dh      | GAIN1    | 00h       | GAIN[15:8]    |          |          |                 |          |            |           |          |
| Eh      | GAIN0    | 00h       | GAIN[7:0]     |          |          |                 |          |            |           |          |
| Fh      | CRC      | 00h       | CRC[7:0]      |          |          |                 |          |            |           |          |

**Table 8-17** lists the access codes of the registers.

**Table 8-17. Register Access Type Codes**

| Access Type            | Code | Description                       |
|------------------------|------|-----------------------------------|
| Read Type              | R    | Read                              |
| Write Type             | W    | Write                             |
| Reset or Default Value | -x   | Value after reset (default value) |

### 8.6.1 DEV\_ID Register (Address = 0h) [reset = 01h]

Return to the [Register Map Overview](#).

**Figure 8-41. DEV\_ID Register**

|             |   |   |   |   |   |   |   |
|-------------|---|---|---|---|---|---|---|
| 7           | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| DEV_ID[7:0] |   |   |   |   |   |   |   |
| R-01h       |   |   |   |   |   |   |   |

**Table 8-18. DEV\_ID Register Field Descriptions**

| Bit | Field       | Type | Reset | Description                   |
|-----|-------------|------|-------|-------------------------------|
| 7:0 | DEV_ID[7:0] | R    | 00h   | Device ID.<br>01h = ADS117L11 |

### 8.6.2 REV\_ID Register (Address = 1h) [reset = xxh]

Return to the [Register Map Overview](#).

**Figure 8-42. REV\_ID Register**

| 7          | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------------|---|---|---|---|---|---|---|
| REVID[7:0] |   |   |   |   |   |   |   |
| R-xxxxxxx  |   |   |   |   |   |   |   |

**Table 8-19. REV\_ID Register Field Descriptions**

| Bit | Field       | Type | Reset   | Description                                                                                |
|-----|-------------|------|---------|--------------------------------------------------------------------------------------------|
| 7:0 | REV_ID[7:0] | R    | xxxxxxx | Die revision ID<br>The die revision ID can change during device production without notice. |

### 8.6.3 STATUS Register (Address = 2h) [reset = x1100xxx]

Return to the [Register Map Overview](#).

**Figure 8-43. STATUS Register**

| 7       | 6        | 5        | 4       | 3       | 2       | 1        | 0    |
|---------|----------|----------|---------|---------|---------|----------|------|
| CS_MODE | ALV_FLAG | POR_FLAG | SPI_ERR | REG_ERR | ADC_ERR | MOD_FLAG | DRDY |
| R-xb    | R/W-1b   | R/W-1b   | R/W-0b  | R/W-0b  | R-xb    | R-xb     | R-xb |

**Table 8-20. STATUS Register Field Descriptions**

| Bit | Field    | Type | Reset | Description                                                                                                                                                                                                                                                                                                               |
|-----|----------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | CS_MODE  | R    | xb    | $\overline{CS}$ mode.<br>This bit indicates 4-wire or 3-wire SPI mode. The mode is determined by the state of $\overline{CS}$ at power up or after reset.<br>0b = 4-wire SPI operation ( $\overline{CS}$ is active)<br>1b = 3-wire SPI operation ( $\overline{CS}$ is tied low)                                           |
| 6   | ALV_FLAG | R/W  | 1b    | Analog supply low-voltage flag.<br>This bit indicates a low-voltage condition occurred on the analog power supplies. Write 1b to clear the flag to detect the next low-voltage condition.<br>0b = No analog supply low-voltage condition from when flag last cleared<br>1b = Analog supply low-voltage condition detected |
| 5   | POR_FLAG | R/W  | 1b    | Power-on reset (POR) flag.<br>This bit indicates a reset from device power-on, by a brownout of the IOVDD supply, CAPD bypass output, or by a user-initiated reset. Write 1b to clear the flag to detect the next reset.<br>0b = No reset from when the flag last cleared<br>1b = Device reset occurred                   |

**Table 8-20. STATUS Register Field Descriptions (continued)**

| Bit | Field    | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|-----|----------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 4   | SPI_ERR  | R/W  | 0b    | <p>SPI communication CRC error.</p> <p>This bit indicates an SPI CRC error. If set, register write operations are blocked, except for the STATUS register that allows clearing the error (write 1b to clear the error). Register read operations remain functional. The SPI CRC error detection is enabled by the SPI_CRC bit (CONFIG4 register).</p> <p>0b = No error<br/>1b = SPI CRC error</p>                                           |
| 3   | REG_ERR  | R/W  | 0b    | <p>Register map CRC error.</p> <p>REG_ERR indicates if the written register map CRC (0Fh) value does not match the internal ADC calculated value. Write 1b to clear the register map CRC error or clear the REG_CRC bit. Set the REG_CRC bit (CONFIG4 register) to enable the register map error check.</p> <p>0b = No error<br/>1b = Register map CRC error</p>                                                                            |
| 2   | ADC_ERR  | R    | xb    | <p>Internal ADC error.</p> <p>ADC_ERR indicates an internal error. Perform a power cycle or reset the device.</p> <p>0b = No ADC error<br/>1b = ADC error detected</p>                                                                                                                                                                                                                                                                      |
| 1   | MOD_FLAG | R    | xb    | <p>Modulator saturation flag.</p> <p>This bit indicates a transient or continuous modulator saturation occurred during the conversion cycle. The flag is updated at the completion of each conversion.</p> <p>0b = Modulator not saturated<br/>1b = Modulator saturation detected during the conversion cycle</p>                                                                                                                           |
| 0   | DRDY     | R    | xb    | <p>Data-ready bit.</p> <p>DRDY indicates when new conversion data are ready. The DRDY bit is the inverse of the <math>\overline{\text{DRDY}}</math> pin. Poll the bit to determine if conversion data are new or are repeated data from the last read operation. DRDY = 1 indicates data are new. In one-shot control mode, the bit remains at 1b until a new conversion is started.</p> <p>0b = Data are not new<br/>1b = Data are new</p> |

## 8.6.4 CONTROL Register (Address = 3h) [reset = 00h]

Return to the [Register Map Overview](#).

**Figure 8-44. CONTROL Register**

| 7          | 6 | 5 | 4 | 3 | 2 | 1     | 0    |
|------------|---|---|---|---|---|-------|------|
| RESET[5:0] |   |   |   |   |   | START | STOP |
| W-000000b  |   |   |   |   |   | W-0b  | W-0b |

**Table 8-21. CONTROL Register Field Descriptions**

| Bit | Field      | Type | Reset   | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
|-----|------------|------|---------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:2 | RESET[5:0] | W    | 000000b | Device reset.<br>Write 010110b to reset the ADC. The adjacent START and STOP bits must be set to 00b in the same write operation to reset the ADC. These bits always read 000000b.                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 1   | START      | W    | 0b      | Start conversion.<br>Conversions are started or restarted by writing 1b. Preclear the CONTROL register by writing 00h prior to writing the START bit. In one-shot control mode, one conversion is started. In start/stop control mode, conversions are started and continue until stopped by the STOP bit. Writing 1b to START while a conversion is ongoing restarts the conversion. This bit has no effect in synchronized control mode. Writing 1b to both the START and STOP bits has no effect. START is self-clearing and always reads 0b.<br><br>0b = No operation<br>1b = Start or restart conversion |
| 0   | STOP       | W    | 0b      | Stop conversion.<br>This bit stops conversions after the current conversion completes. This bit has no effect in synchronized control mode. Writing 1b to both the START and STOP has no effect. STOP is self-clearing and always reads 0b.<br><br>0b = No operation<br>1b = Stop conversion after the current conversion completes                                                                                                                                                                                                                                                                           |

### 8.6.5 MUX Register (Address = 4h) [reset = 00h]

Return to the [Register Map Overview](#).

**Figure 8-45. MUX Register**

| 7         | 6 | 5 | 4 | 3 | 2 | 1        | 0 |
|-----------|---|---|---|---|---|----------|---|
| RESERVED  |   |   |   |   |   | MUX[1:0] |   |
| R-000000b |   |   |   |   |   | R/W-00b  |   |

**Table 8-22. MUX Register Field Descriptions**

| Bit | Field    | Type | Reset   | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
|-----|----------|------|---------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:2 | RESERVED | R    | 000000b | Reserved                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 1:0 | MUX[1:0] | R/W  | 00b     | <p>Input multiplexer selection.</p> <p>These bits select the polarity of the analog input and selects the test modes. See the <a href="#">Analog Input</a> section for details.</p> <p>00b = Normal input polarity</p> <p>01b = Inverted input polarity</p> <p>10b = Offset and noise test: AINP and AINN disconnected, ADC inputs internally shorted to (AVDD1 + AVSS) / 2</p> <p>11b = Common-mode test: ADC inputs internally shorted and connected to AINP</p> |

## 8.6.6 CONFIG1 Register (Address = 5h) [reset = 00h]

Return to the [Register Map Overview](#).

**Figure 8-46. CONFIG1 Register**

| 7        | 6       | 5       | 4      | 3        | 2        | 1        | 0        |
|----------|---------|---------|--------|----------|----------|----------|----------|
| RESERVED | REF_RNG | INP_RNG | VCM    | REFP_BUF | RESERVED | AINP_BUF | AINN_BUF |
| R-0b     | R/W-0b  | R/W-0b  | R/W-0b | R/W-0b   | R-0b     | R/W-0b   | R/W-0b   |

**Table 8-23. CONFIG1 Register Field Descriptions**

| Bit | Field    | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                   |
|-----|----------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | RESERVED | R    | 0b    | Reserved                                                                                                                                                                                                                                                                                                                                                                                                                      |
| 6   | REF_RNG  | R/W  | 0b    | Voltage reference range selection.<br>Program this bit to select the low- or high-reference voltage range to match the applied reference voltage. See the <a href="#">Recommended Operating Conditions</a> table for the range of reference voltages. When the high-reference range is selected, the INP_RNG bit is internally overridden to the 1x input range.<br><br>0b = Low-reference range<br>1b = High-reference range |
| 5   | INP_RNG  | R/W  | 0b    | Input range selection.<br>This bit selects the 1x or 2x input range. See the <a href="#">Input Range</a> section for more details.<br><br>0b = 1x input range<br>1b = 2x input range                                                                                                                                                                                                                                          |
| 4   | VCM      | R/W  | 0b    | VCM output enable.<br>This bit enables the VCM output voltage pin. The VCM voltage is $(AVDD1 + AVSS) / 2$ .<br><br>0b = Disabled<br>1b = Enabled                                                                                                                                                                                                                                                                             |
| 3   | REFP_BUF | R/W  | 0b    | Reference positive buffer enable.<br>This bit enables the REFP reference input precharge buffer.<br><br>0b = Disabled<br>1b = Enabled                                                                                                                                                                                                                                                                                         |
| 2   | RESERVED | R    | 0b    | Reserved                                                                                                                                                                                                                                                                                                                                                                                                                      |
| 1   | AINP_BUF | R/W  | 0b    | Analog input positive buffer enable.<br>This bit enables the AINP analog input precharge buffer.<br><br>0b = Disabled<br>1b = Enabled                                                                                                                                                                                                                                                                                         |
| 0   | AINN_BUF | R/W  | 0b    | Analog input negative buffer enable.<br>This bit enables the AINN analog input precharge buffer.<br><br>0b = Disabled<br>1b = Enabled                                                                                                                                                                                                                                                                                         |

### 8.6.7 CONFIG2 Register (Address = 6h) [reset = 00h]

Return to the [Register Map Overview](#).

**Figure 8-47. CONFIG2 Register**

| 7       | 6        | 5        | 4               | 3          | 2         | 1      | 0      |
|---------|----------|----------|-----------------|------------|-----------|--------|--------|
| EXT_RNG | RESERVED | SDO_MODE | START_MODE[1:0] | SPEED_MODE | STBY_MODE | PWDN   |        |
| R/W-0b  | R-0b     | R/W-0b   | R/W-00b         | R/W-0b     | R/W-0b    | R/W-0b | R/W-0b |

**Table 8-24. CONFIG2 Register Field Descriptions**

| Bit | Field           | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|-----|-----------------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | EXT_RNG         | R/W  | 0b    | Extended input range selection.<br>This bit extends the input range by 25%. See the <a href="#">Input Range</a> section for more details.<br><br>0b = Standard input range<br>1b = 25% extended input range                                                                                                                                                                                                                                                             |
| 6   | RESERVED        | R    | 0b    | Reserved                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| 5   | SDO_MODE        | R/W  | 0b    | SDO/ $\overline{\text{DRDY}}$ mode selection.<br>This bit programs the mode of the SDO/ $\overline{\text{DRDY}}$ pin to either data-output function only, or to dual-mode function of data output and data ready. For daisy-chain connection of ADCs, use the data-output function only mode. See the <a href="#">SDO/<math>\overline{\text{DRDY}}</math></a> section for more details.<br><br>0b = Data output only mode<br>1b = Dual mode: data output and data ready |
| 4:3 | START_MODE[1:0] | R/W  | 00b   | START mode selection.<br>These bits program the mode of the START pin. See the <a href="#">Synchronization</a> section for more details.<br><br>00b = Start/stop control mode<br>01b = One-shot control mode<br>10b = Synchronized control mode<br>11b = Reserved                                                                                                                                                                                                       |
| 2   | SPEED_MODE      | R/W  | 0b    | Speed mode selection.<br>This bit programs the power-scalable speed mode of the device. The clock frequency corresponds to the mode.<br><br>0b = High-speed mode ( $f_{\text{CLK}} = 25.6 \text{ MHz}$ )<br>1b = Low-speed mode ( $f_{\text{CLK}} = 3.2 \text{ MHz}$ )                                                                                                                                                                                                  |
| 1   | STBY_MODE       | R/W  | 0b    | Standby mode selection.<br>This bit enables the auto engagement of the low-power standby mode after conversions are stopped.<br><br>0b = Idle mode; ADC remains fully powered when conversions are stopped.<br>1b = Standby mode; ADC powers down when conversions are stopped. Standby mode is exited when conversions restart.                                                                                                                                        |

**Table 8-24. CONFIG2 Register Field Descriptions (continued)**

| Bit | Field | Type | Reset | Description                                                                                                                                                                                                                         |
|-----|-------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0   | PWDN  | R/W  | 0b    | Power-down mode selection.<br>When set, the ADC is powered down. All functions are powered down except for SPI operation and the digital LDO to retain user register settings.<br><br>0b = Normal operation<br>1b = Power-down mode |

### 8.6.8 CONFIG3 Register (Address = 7h) [reset = 00h]

Return to the [Register Map Overview](#).

**Figure 8-48. CONFIG3 Register**

|            |   |   |             |   |   |   |   |
|------------|---|---|-------------|---|---|---|---|
| 7          | 6 | 5 | 4           | 3 | 2 | 1 | 0 |
| DELAY[2:0] |   |   | FILTER[4:0] |   |   |   |   |
| R/W-000b   |   |   | R/W-00000b  |   |   |   |   |

**Table 8-25. CONFIG3 Register Field Descriptions**

| Bit | Field      | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                |
|-----|------------|------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:5 | DELAY[2:0] | R/W  | 000b  | Conversion-start delay time selection.<br>Programmable delay time before the start of the <i>first</i> conversion when START is applied. Delay time is given in number of $f_{MOD}$ clock cycles ( $f_{MOD} = f_{CLK} / 2$ ).<br><br>000b = 0<br>001b = 4<br>010b = 8<br>011b = 16<br>100b = 32<br>101b = 128<br>110b = 512<br>111b = 1024 |

**Table 8-25. CONFIG3 Register Field Descriptions (continued)**

| Bit | Field       | Type | Reset  | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
|-----|-------------|------|--------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 4:0 | FILTER[4:0] | R/W  | 00000b | <p>Digital filter mode and oversampling ratio selection. These bits configure the digital filter. The digital filter has five modes: wideband, sinc4, sinc4 + sinc1, sinc3, and sinc3 + sinc1, each with a range of OSR values. See <a href="#">Table 7-1</a> through <a href="#">Table 7-5</a> for data rate and bandwidth information.</p> <p>00000 = wideband, OSR = 32</p> <p>00001 = wideband, OSR = 64</p> <p>00010 = wideband, OSR = 128</p> <p>00011 = wideband, OSR = 256</p> <p>00100 = wideband, OSR = 512</p> <p>00101 = wideband, OSR = 1024</p> <p>00110 = wideband, OSR = 2048</p> <p>00111 = wideband, OSR = 4096</p> <p>01000 = sinc4, OSR = 12</p> <p>01001 = sinc4, OSR = 16</p> <p>01010 = sinc4, OSR = 24</p> <p>01011 = sinc4, OSR = 32</p> <p>01100 = sinc4, OSR = 64</p> <p>01101 = sinc4, OSR = 128</p> <p>01110 = sinc4, OSR = 256</p> <p>01111 = sinc4, OSR = 512</p> <p>10000 = sinc4, OSR = 1024</p> <p>10001 = sinc4, OSR = 2048</p> <p>10010 = sinc4, OSR = 4096</p> <p>10011 = sinc4, OSR = 32 + sinc1, OSR = 2</p> <p>10100 = sinc4, OSR = 32 + sinc1, OSR = 4</p> <p>10101 = sinc4, OSR = 32 + sinc1, OSR = 10</p> <p>10110 = sinc4, OSR = 32 + sinc1, OSR = 20</p> <p>10111 = sinc4, OSR = 32 + sinc1, OSR = 40</p> <p>11000 = sinc4, OSR = 32 + sinc1, OSR = 100</p> <p>11001 = sinc4, OSR = 32 + sinc1, OSR = 200</p> <p>11010 = sinc4, OSR = 32 + sinc1, OSR = 400</p> <p>11011 = sinc4, OSR = 32 + sinc1, OSR = 1000</p> <p>11100 = sinc3, OSR = 26667</p> <p>11101 = sinc3, OSR = 32000</p> <p>11110 = sinc3, OSR = 32000 + sinc1, OSR = 3</p> <p>11111 = sinc3, OSR = 32000 + sinc1, OSR = 5</p> |

## 8.6.9 CONFIG4 Register (Address = 8h) [reset = 08h]

Return to the [Register Map Overview](#).

**Figure 8-49. CONFIG4 Register**

| 7       | 6       | 5       | 4       | 3        | 2       | 1       | 0      |
|---------|---------|---------|---------|----------|---------|---------|--------|
| CLK_SEL | CLK_DIV | OUT_DRV | BIP_UNI | RESERVED | SPI_CRC | REG_CRC | STATUS |
| R/W-0b  | R/W-0b  | R/W-0b  | R/W-0b  | R-1b     | R/W-0b  | R/W-0b  | R/W-0b |

**Table 8-26. CONFIG4 Register Field Descriptions**

| Bit | Field    | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|-----|----------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | CLK_SEL  | R/W  | 0b    | Clock selection.<br>Selects internal or external clock operation.<br><br>0b = Internal clock operation<br>1b = External clock operation                                                                                                                                                                                                                                                                                                         |
| 6   | CLK_DIV  | R/W  | 0b    | External clock divider selection.<br>This bit is used to divide the external clock by 8.<br><br>0b = No clock division<br>1b = Clock division by 8                                                                                                                                                                                                                                                                                              |
| 5   | OUT_DRV  | R/W  | 0b    | Digital output drive selection.<br>Select the drive strength of the digital outputs.<br><br>0b = Full-drive strength<br>1b = Half-drive strength                                                                                                                                                                                                                                                                                                |
| 4   | BIP_UNI  | R/W  | 0b    | Bipolar or unipolar input range selection. Select the type of input range: bipolar or unipolar.<br><br>0b = Bipolar input range, $V_{IN} = \pm V_{REF}$ (1x input range) or $V_{IN} = \pm 2 \cdot V_{REF}$ (2x input range), 2's-complement data format<br><br>1b = Unipolar input range, $V_{IN} = 0 \text{ V to } V_{REF}$ (1x input range) or $V_{IN} = 0 \text{ V to } 2 \cdot V_{REF}$ (2x input range), straight-binary data format       |
| 3   | RESERVED | R    | 1b    | Reserved                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| 2   | SPI_CRC  | R/W  | 0b    | SPI CRC enable.<br>This bit enables the SPI CRC error check. When enabled, the device verifies the CRC input byte and appends a CRC output byte to the output data. The SPI_ERR bit of the STATUS byte sets if an input SPI CRC error is detected. Write 1b to the SPI_ERR bit to clear the error.<br><br>0b = SPI CRC function disabled<br>1b = SPI CRC function enabled                                                                       |
| 1   | REG_CRC  | R/W  | 0b    | Register map CRC enable.<br>This bit enables the register map CRC error check. Write the register map CRC value to the 0Fh register, calculated over registers 0h to 1h and 4h to Eh. An internal CRC value is compared to the value written to the register map CRC register. The REG_ERR bit of the STATUS byte sets if the CRC values do not match.<br><br>0b = Register map CRC function disabled<br>1b = Register map CRC function enabled |

**Table 8-26. CONFIG4 Register Field Descriptions (continued)**

| Bit | Field  | Type | Reset | Description                                                                                                                                                                                                                            |
|-----|--------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0   | STATUS | R/W  | 0b    | <p>STATUS byte output enable.</p> <p>Program this bit to prefix the STATUS byte to the conversion data output.</p> <p>0b = Status byte not prefixed to the conversion data</p> <p>1b = Status byte prefixed to the conversion data</p> |

**8.6.10 OFFSET2, OFFSET1, OFFSET0 Registers (Addresses = 9h, Ah, Bh) [reset = 00h, 00h, 00h]**Return to the [Register Map Overview](#).**Figure 8-50. OFFSET2, OFFSET1, OFFSET0 Registers**

|               |   |   |   |   |   |   |   |
|---------------|---|---|---|---|---|---|---|
| 7             | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| OFFSET[23:16] |   |   |   |   |   |   |   |
| R/W-00000000b |   |   |   |   |   |   |   |
| 7             | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| OFFSET[15:8]  |   |   |   |   |   |   |   |
| R/W-00000000b |   |   |   |   |   |   |   |
| 7             | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| OFFSET[7:0]   |   |   |   |   |   |   |   |
| R/W-00000000b |   |   |   |   |   |   |   |

**Table 8-27. OFFSET Registers Field Description**

| Bit  | Field        | Type | Reset   | Description                                                                                                                                                                                                                                            |
|------|--------------|------|---------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 23:0 | OFFSET[23:0] | R/W  | 000000h | <p>User offset calibration value.</p> <p>Three registers form the 24-bit offset calibration word. OFFSET[23:0] is in 2's-complement representation and is subtracted from the conversion result. The offset operation precedes the gain operation.</p> |

### 8.6.11 GAIN2, GAIN1, GAIN0 Registers (Addresses = Ch, Dh, Eh) [reset = 40h, 00h, 00h]

Return to the [Register Map Overview](#).

**Figure 8-51. GAIN2, GAIN1, GAIN0 Registers**

|               |   |   |   |   |   |   |   |
|---------------|---|---|---|---|---|---|---|
| 7             | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| GAIN[23:16]   |   |   |   |   |   |   |   |
| R/W-01000000b |   |   |   |   |   |   |   |
| 7             | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| GAIN[15:8]    |   |   |   |   |   |   |   |
| R/W-00000000b |   |   |   |   |   |   |   |
| 7             | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| GAIN[7:0]     |   |   |   |   |   |   |   |
| R/W-00000000b |   |   |   |   |   |   |   |

**Table 8-28. GAIN Registers Field Description**

| Bit  | Field      | Type | Reset   | Description                                                                                                                                                                                                                                                          |
|------|------------|------|---------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 23:0 | GAIN[23:0] | R/W  | 400000h | User gain calibration value.<br>Three registers form the 24-bit gain calibration word. GAIN[23:0] is in straight-binary representation and normalized to 400000h for gain = 1. The conversion data is multiplied by GAIN[23:0] / 400000h after the offset operation. |

### 8.6.12 CRC Register (Address = Fh) [reset = 00h]

Return to the [Register Map Overview](#).

**Figure 8-52. CRC Register**

|               |   |   |   |   |   |   |   |
|---------------|---|---|---|---|---|---|---|
| 7             | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| CRC[7:0]      |   |   |   |   |   |   |   |
| R/W-00000000b |   |   |   |   |   |   |   |

**Table 8-29. CRC Register Field Descriptions**

| Bit | Field    | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|-----|----------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:0 | CRC[7:0] | R/W  | 00h   | Register map CRC value.<br>The register map CRC is a user-computed value of registers 0h to 1h together with registers 4h through Eh. The value written to this register is compared to an internal CRC calculation. If the values do not match, the REG_ERR bit is set in the STATUS header byte and register. The register CRC check is enabled by the REG_CRC bit. If the register CRC function is disabled, this register is available for scratchpad purposes. |

## 9 Application and Implementation

### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 9.1 Application Information

The performance capability of the ADS117L11 is achievable when familiar with the requirements of the input driver, antialias filter, reference voltage, and PCB layout. The following sections provide design guidelines.

#### 9.1.1 Input Driver

The ADC incorporates precharge buffers that reduce the settling and bandwidth requirement of the analog input driver. If a 10-MHz or less bandwidth driver is used, or if there is a long distance between the driver and the ADC inputs (such as a cable connection), enable the input precharge buffers. For higher gain-bandwidth drivers, the precharge buffers can be disabled to reduce power consumption, but in any case, best gain error performance is achieved with the input precharge buffers active. In low-speed mode operation, the modulator sample rate is significantly reduced, therefore the driver has more time to settle between the input sampling pulses. Using a lower bandwidth input driver or disabling the precharge buffers can be practical options for low-speed operation.

#### 9.1.2 Antialias Filter

Input signals occurring near  $f_{\text{MOD}}$  (12.8 MHz in high-speed mode and 1.6 MHz in low-speed mode) fold back (or alias) to the pass band, resulting in data errors. When aliased, the frequency errors cannot be removed by post processing. An analog antialias filter at the ADC inputs removes the frequencies from the input signal before they are aliased by the ADC. The required order of the antialias filter is dependent on the selected OSR and the target value of signal attenuation at  $f_{\text{MOD}}$ . A large value of OSR means more frequency range between the  $f_{\text{DATA}}$  Nyquist frequency and  $f_{\text{MOD}}$  for the filter to provide the desired roll off. For example, for OSR = 128, more than two decades of frequency separates  $f_{\text{DATA}}$  and  $f_{\text{MOD}}$ . With a corner frequency =  $f_{\text{DATA}}$ , a third-order, 60-dB per decade filter provides a 120-dB alias rejection at  $f_{\text{MOD}}$ .

#### 9.1.3 Reference Voltage

For data sheet performance, the ADC requires a reference voltage with low noise and good drive strength to charge the sampled reference input. Because the modulator continuously samples the reference voltage whether conversions are ongoing or not (except in standby and power-down modes), the reference loading is constant, therefore incomplete settling of the reference voltage appears as a gain error to the system. The total system gain error can be calibrated. A 22- $\mu\text{F}$  decoupling capacitor at the reference output and 1- $\mu\text{F}$  and 0.1- $\mu\text{F}$  capacitors directly across the reference input pins filters the reference input. The ADC also incorporates an optional reference precharge buffer for the positive input to buffer the reference voltage.

#### 9.1.4 Simultaneous-Sampling Systems

When using the ADC in a multichannel system, the same design principles apply with additional considerations for clock routing, synchronization, shared reference voltage, and SPI clocking. See the [ADS127L11 in Simultaneous-Sampling Systems 24-bit ADC application brief](#) for details for use in simultaneous-sampling systems.

## 9.2 Typical Application

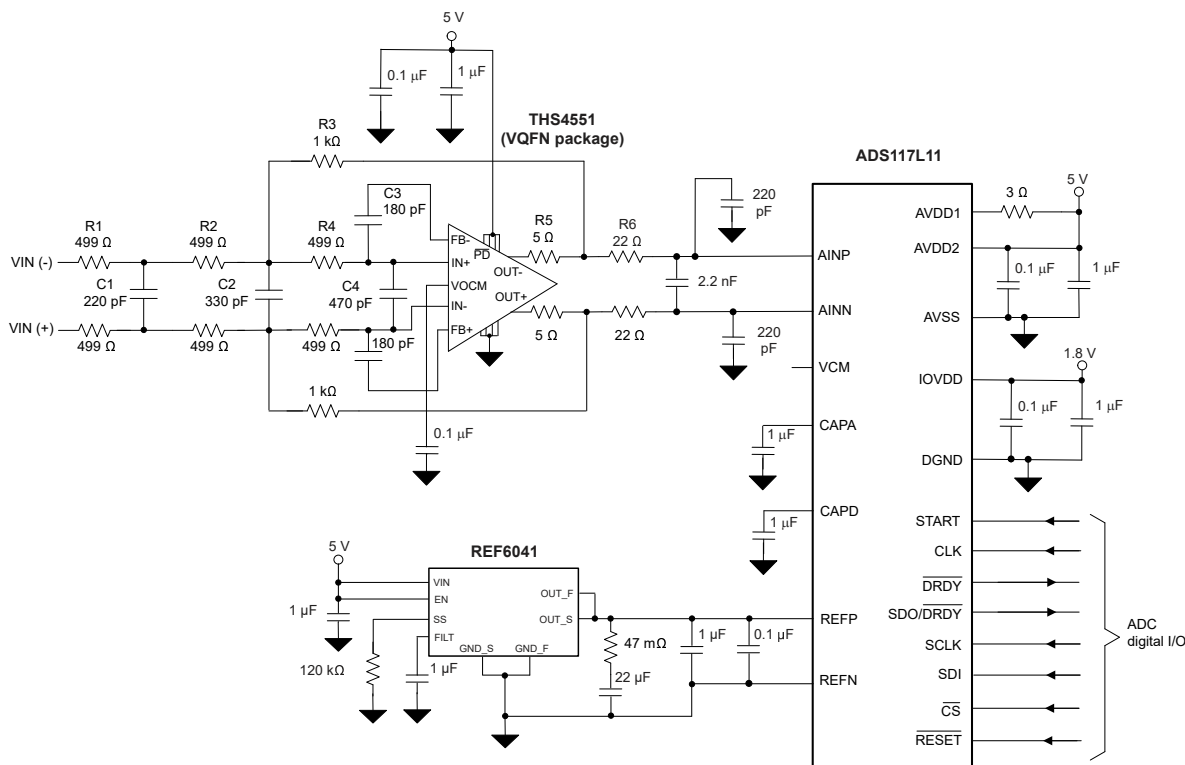


**Figure 9-1. ADS117L11 Circuit Diagram**

### 9.2.1 Design Requirements

Figure 9-1 shows an application of the ADS117L11 used in a precision data acquisition system. The goal of this design is an antialias filter at the ADC input to attenuate out-of-band signals at the modulator sample rate ( $f_{MOD}$ ). The requirement of the antialias filter is 90-dB attenuation at the critical  $f_{MOD}$  frequency (12.8 MHz in high-speed mode) using the OSR = 32 setting in wideband filter mode. The filter is designed for a flat amplitude response and low group delay error within the pass band of the signal.

Table 9-1 lists the target design values and the actual values in this design example.

**Table 9-1. Antialias Filter Design Requirements**

| FILTER PARAMETER            | TARGET VALUE | ACTUAL VALUE |
|-----------------------------|--------------|--------------|
| Voltage gain                | 0 dB         | 0 dB         |
| Alias rejection at 12.8 MHz | 90 dB        | 90 dB        |
| –0.1-dB frequency           | 250 kHz      | 260 kHz      |
| –3-dB frequency             | 500 kHz      | 550 kHz      |
| Amplitude peaking           | 20 mdB       | 12 mdB       |
| Group delay linearity       | 0.1 μs       | 0.017 μs     |

### 9.2.2 Detailed Design Procedure

The antialias filter consists of a passive first-order input filter, an active second-order filter, and a passive first-order output filter. The filter is fourth-order overall. The filter design accommodates the worst-case wideband filter OSR value (32), which results in less than two decades of frequency range between the Nyquist frequency at  $f_{\text{DATA}}$  and the  $f_{\text{MOD}}$  frequency. The fourth-order filter provides 90-dB rolloff over this frequency range. The filter rolloff at  $f_{\text{MOD}}$  is the key function of the filter.

The THS4551 amplifier is selected for the active filter stage because of the 135-MHz gain-bandwidth product (GBP) and 50-ns settling time. The amplifier GBP is sufficient to maintain the filter rolloff at 12.8 MHz, even with the dc gain of 15 dB. For example, for applications where gain is desired, a 10-MHz amplifier has marginal GBP to fully support the required rolloff at the  $f_{\text{MOD}}$  frequency. The settling time specification of the THS4551 also makes the device a good choice for driving the ADC sampled inputs.

The design of the active filter section begins with an equal-R assumption to reduce the number of component values to select. The dc gain of the filter is  $R_3 / (R_1 + R_2)$ . 1-k $\Omega$  resistors are selected to be low enough in value to keep resistor noise and amplifier input current noise from affecting the noise of the ADC.

The 1-k $\Omega$  input resistor is divided into two 499- $\Omega$  resistors ( $R_1$  and  $R_2$ ) to implement the first-order filter using  $C_1$ . The first-order filter is decoupled from the second-order active filter, but shares  $R_1$  and  $R_2$  to determine each filter stage corner frequency. The corner frequency is given by  $C_1$  and the Thevenin resistance at the terminals of  $C_1$  ( $R_{\text{TH}} = 2 \times 250 \Omega$ ).

Given an arbitrary selection of  $R_4$  ( $2 \times 499 \Omega$  in this case), the values of the  $2 \times 180$  pF ( $C_3$ ) feedback capacitors and the single 330-pF differential capacitor ( $C_2$ ) are calculated by the filter design equations given in the [Design Methodology for MFB Filters in ADC Interface Applications application note](#). The design inputs are filter  $f_o$  and filter Q for the multiple-feedback active filter topology. The differential capacitor ( $C_4$ ) is not part of the filter design but is used to improve filter phase margin. The 5- $\Omega$  resistors ( $R_5$ ) isolate the amplifier outputs from stray capacitance to further improve filter phase margin.

The final RC filter at the ADC inputs serves two purposes. First, the filter provides a fourth pole to the overall filter response, thereby increasing filter rolloff. The other purpose of the filter is a charge reservoir to filter the sampled input of the ADC. The charge reservoir reduces the instantaneous charge demand of the amplifier, maintaining low distortion and low gain error that otherwise can degrade because of incomplete amplifier settling. The input filter values are  $2 \times 22 \Omega$  and 2.2 nF. The 22- $\Omega$  resistors are outside the THS4551 filter loop to isolate the amplifier outputs from the 2.2-nF capacitor to maintain phase margin.

Low voltage-coefficient C0G capacitors are used everywhere in the signal path for their low distortion properties. The amplifier gain resistors are 0.1% tolerance to provide best possible THD performance. The ADC VCM output connection to the amplifier VOCM input pin is optional because the same function is provided by the amplifier.

See the [THS4551 data sheet](#) for additional examples of active filter designs and application.

### 9.2.3 Application Curves

The following figures are produced by the **TINA-TI™**, SPICE-based analog simulation program. The THS4551 SPICE model can be downloaded at the [THS4551 product folder](#).

**Figure 9-2** shows the frequency response of the antialias filter and the *total* response of the antialias filter and the ADC. As shown in this image, the filter provides 90-dB stop-band attenuation from the Nyquist frequency to the 12.8-MHz  $f_{MOD}$  frequency.

**Figure 9-3** shows the analog filter group delay. The 0.575- $\mu$ s group delay is small in comparison to the 85- $\mu$ s group delay of the ADC digital filter ( $34 / f_{DATA}$ ). The analog filter group delay linearity is 0.017  $\mu$ s, peaking at the edge of the 165-kHz pass band.

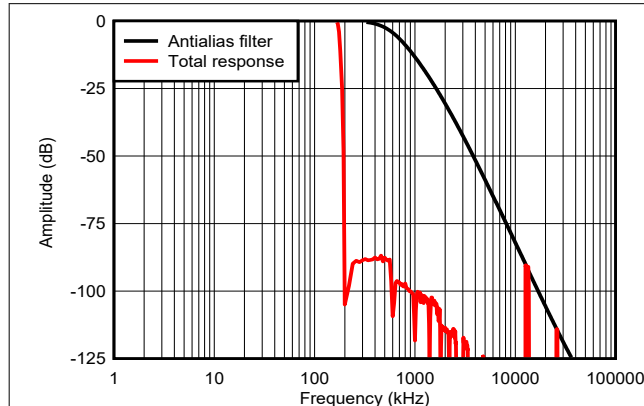


**Figure 9-2. Antialias Filter Frequency Response**

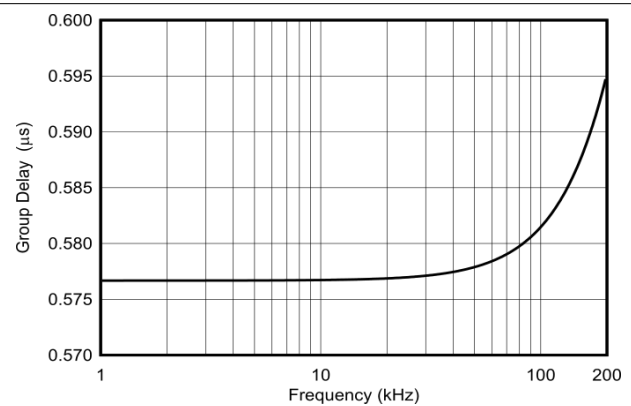


**Figure 9-3. Antialias Filter Group Delay**

### 9.3 Power Supply Recommendations

The ADC has three analog power supplies and one digital power supply. Power-supply voltages AVDD1 and AVSS establish the type of analog input signal range. Bipolar input signals are only possible using bipolar supply voltages, such as AVDD1 = 2.5 V and AVSS = –2.5 V, and only unipolar input signals are possible using unipolar supply voltages, such as AVDD1 = 5 V and AVSS = DGND.

The AVDD2 power-supply voltage is with respect to AVSS and the IOVDD power-supply voltage is with respect to DGND. The specified range of the power supplies are listed in the [Recommended Operating Conditions](#) table. The ADC can be operated using a single 5-V voltage for all supplies (or one 3-V voltage in low-speed mode) with AVSS = DGND. The ADC supply pins must always have separate bypass capacitors.

Power-supply bypassing at the device pins is essential to achieve data sheet performance. The ADC also requires capacitors for the CAPA and CAPD pins, and for the analog input and reference pins. Place the capacitors close to the device pins using short, direct traces with the smaller capacitor value placed closest to the device pins.

The recommended bypass components of the device pins are as follows:

1. AVDD1 to AVSS:
  - a. Parallel combination of 1- $\mu$ F and 0.1- $\mu$ F capacitors across the AVDD1 power supply and AVSS
  - b. A 3- $\Omega$  resistor placed in series between the bypass capacitors and the device AVDD1 pin
2. AVDD2 to AVSS: Parallel combination of 1- $\mu$ F and 0.1- $\mu$ F capacitors across the pins
3. IOVDD to DGND: Parallel combination of 1- $\mu$ F and 0.1- $\mu$ F capacitors across the pins
4. CAPA to AVSS: 1- $\mu$ F capacitor placed across the pins
5. CAPD to DGND: 1- $\mu$ F capacitor placed across the pins
6. REFP, REFN: Parallel combination of 1- $\mu$ F and 0.1- $\mu$ F capacitors across the pins
7. AINP, AINN: 22- $\Omega$  resistors in series, followed by 2.2 nF across the pins, 220 pF from each pin to AVSS

**Figure 9-4** shows the component placement for the device configured for unipolar power-supply operation.

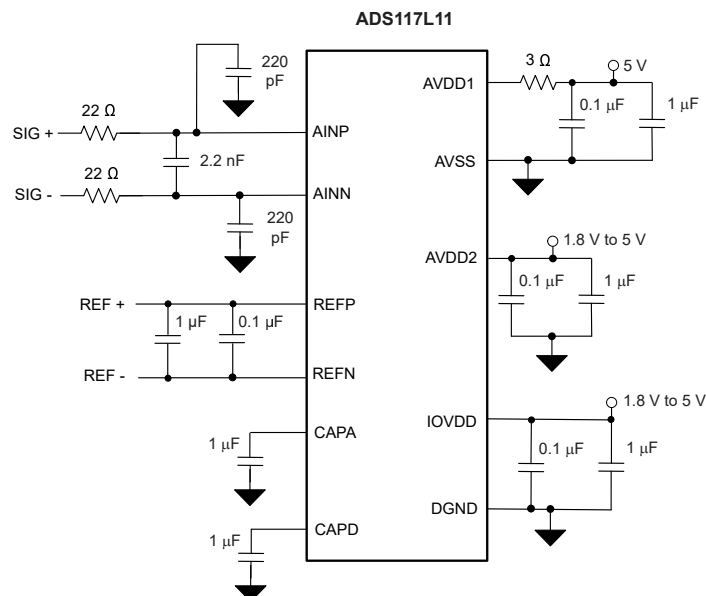


**Figure 9-4. Device Bypass Recommendation**

The power supplies do not require special sequencing and can be powered up in any order, but in no case must any analog or digital input exceed the respective AVDD1 and AVSS (analog) or IOVDD (digital) power-supply voltages. An internal reset is performed after the IOVDD power-supply voltage is applied.

## 9.4 Layout

### 9.4.1 Layout Guidelines

To achieve data sheet performance, use a minimum four-layer PCB board with the inner layers dedicated to ground and power planes. Best performance is achieved by combining the analog and digital grounds on a single, unbroken ground plane. In some layout geometries, however, using separate analog and digital grounds may be necessary to help direct digital currents away from the analog ground (such as pulsing LED indicators, relays, and so on). In this case, consider separate ground return paths for these loads. When separate analog and digital grounds are used, join the grounds at the ADC.

Use the power plane layer to route the power supplies to the ADC.

The top and bottom layers route the analog and digital signals. Route the input signal as a matched differential pair throughout the signal chain to reduce differential noise coupling. Avoid crossing or adjacent placement of digital signals with the analog signals. This layout is especially true for high-frequency digital signals such as the clock input, and SPI signals, SCLK, and SDO/DRDY. The pin placement of both ADC package options minimizes the need to cross digital and analog signals.

Place the voltage reference close to the ADC. Orient the reference such that the reference ground pin is close to the ADC REFN pin. Place the reference input bypass capacitors directly at the ADC pins. Use reference bypass capacitors for each ADC in multichannel systems and connect the reference ground pin to the ground plane (or to AVSS in some bipolar supply systems) at one point and route REFP and REFN as paired traces to each ADC.

### 9.4.2 Layout Example

Figure 9-5 is a layout example based on the circuit diagram of Figure 9-1. The ADC is shown in the WQFN package option. A four-layer PCB is used, with the inner layers dedicated as ground and power planes. Cutouts are used on the plane layers under the amplifier input pins to reduce stray capacitance to increase amplifier phase margin. Thermal vias for the ADS117L11 and THS4551 WQFN package thermal pad are not used so that bypass capacitors can be placed on the bottom layer underneath the devices. Place the smaller of the parallel supply bypass capacitors closest to the device supply pins.

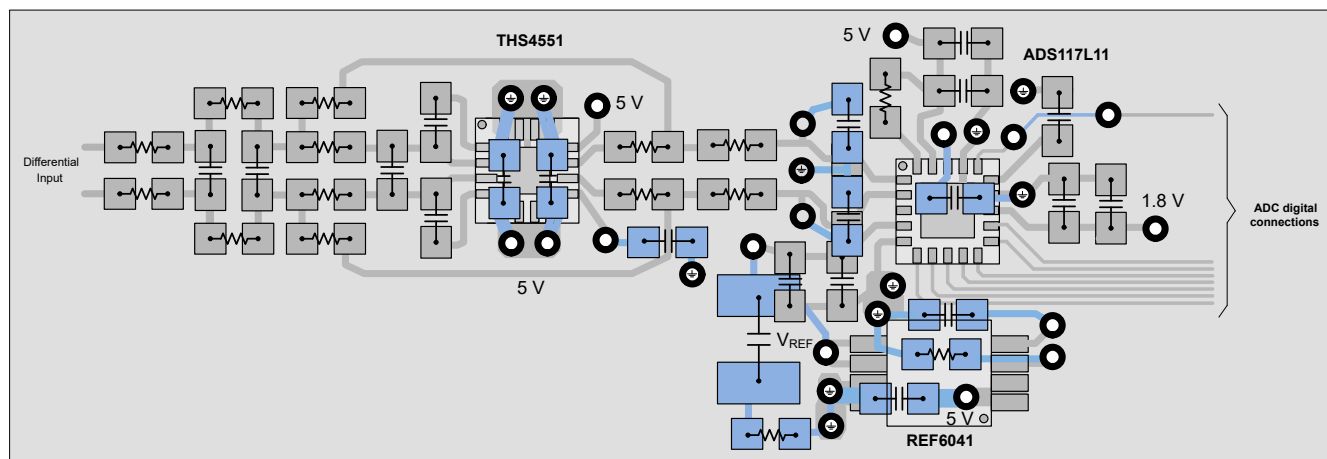


**Figure 9-5. Layout Example of Typical Application Circuit**

See the [QFN and SON PCB Attachment application report](#) for details of attaching the WQFN package to the printed circuit board.

## 10 Device and Documentation Support

### 10.1 Documentation Support

#### 10.1.1 Related Documentation

For related documentation see the following:

- Texas Instruments, [ADS127L11 in Simultaneous-Sampling Systems 24-bit ADC application brief](#)
- Texas Instruments, [ADS127L11 24-bit ADC CRC Calculator](#)
- Texas Instruments, [IEPE Vibration Sensor Interface Reference Design for PLC Analog Input design guide](#)
- Texas Instruments, [THS4551 Low-Noise, Precision, 150-MHz, Fully Differential Amplifier data sheet](#)
- Texas Instruments, [REF60xx High-Precision Voltage Reference with Integrated ADC Drive Buffer data sheet](#)
- Texas Instruments, [Design Methodology for MFB Filters in ADC Interface Applications application note](#)
- Texas Instruments, [QFN and SON PCB Attachment application report](#)

#### 10.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](https://www.ti.com). Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

#### 10.3 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

#### 10.4 Trademarks

TINA-TI™ and TI E2E™ are trademarks of Texas Instruments.

All trademarks are the property of their respective owners.

#### 10.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### 10.6 Glossary

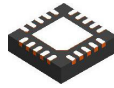
[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

## 11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## 11.1 Mechanical Data

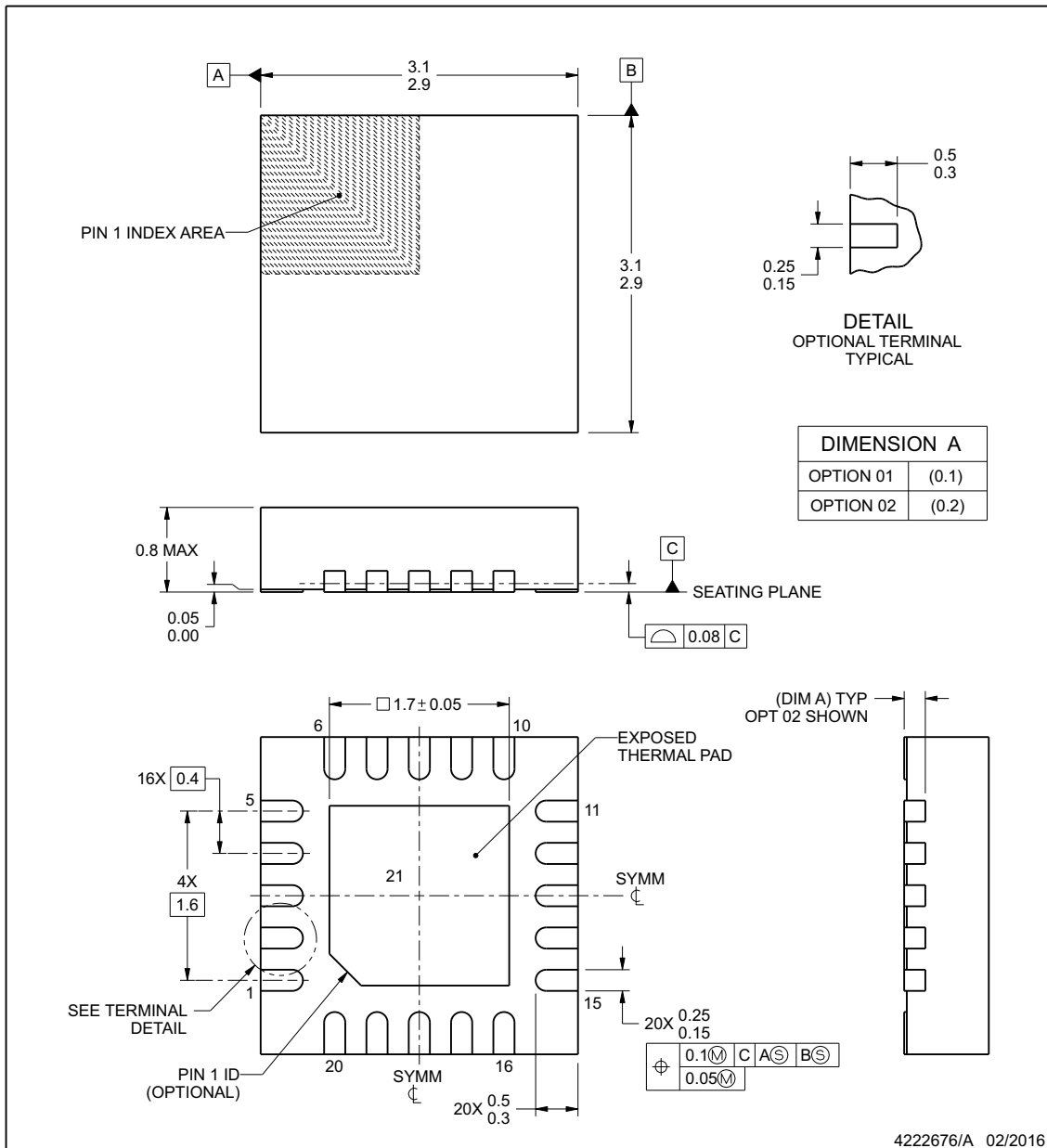
**RUK0020B**



### PACKAGE OUTLINE

**WQFN - 0.8 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD

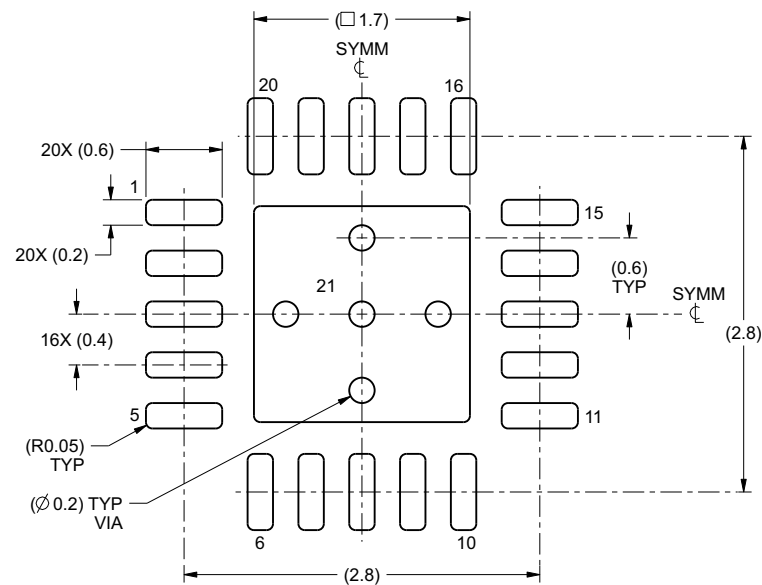


#### NOTES:

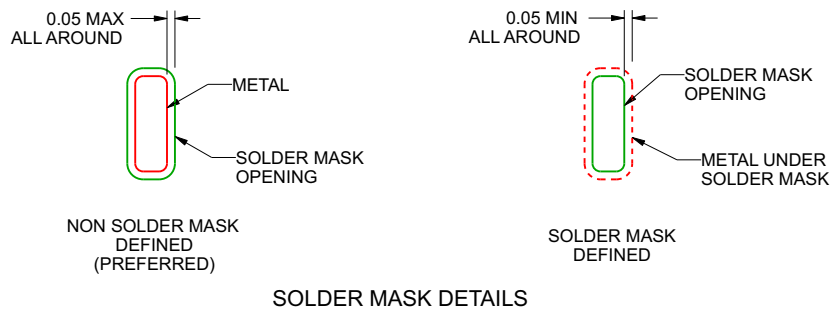
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

**EXAMPLE BOARD LAYOUT****RUK0020B****WQFN - 0.8 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
SCALE:20X



4222676/A 02/2016

NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

www.ti.com

**WQFN - 0.8 mm max height**

4222676/A 02/2016

Product Folder Links: [ADS117L11](#)

## PACKAGING INFORMATION

| Orderable part number          | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|--------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">ADS117L11IRUKR</a> | Active        | Production           | WQFN (RUK)   20 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | A17L11              |
| ADS117L11IRUKR.A               | Active        | Production           | WQFN (RUK)   20 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | A17L11              |
| <a href="#">ADS117L11IRUKT</a> | Active        | Production           | WQFN (RUK)   20 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | A17L11              |
| ADS117L11IRUKT.A               | Active        | Production           | WQFN (RUK)   20 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | A17L11              |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

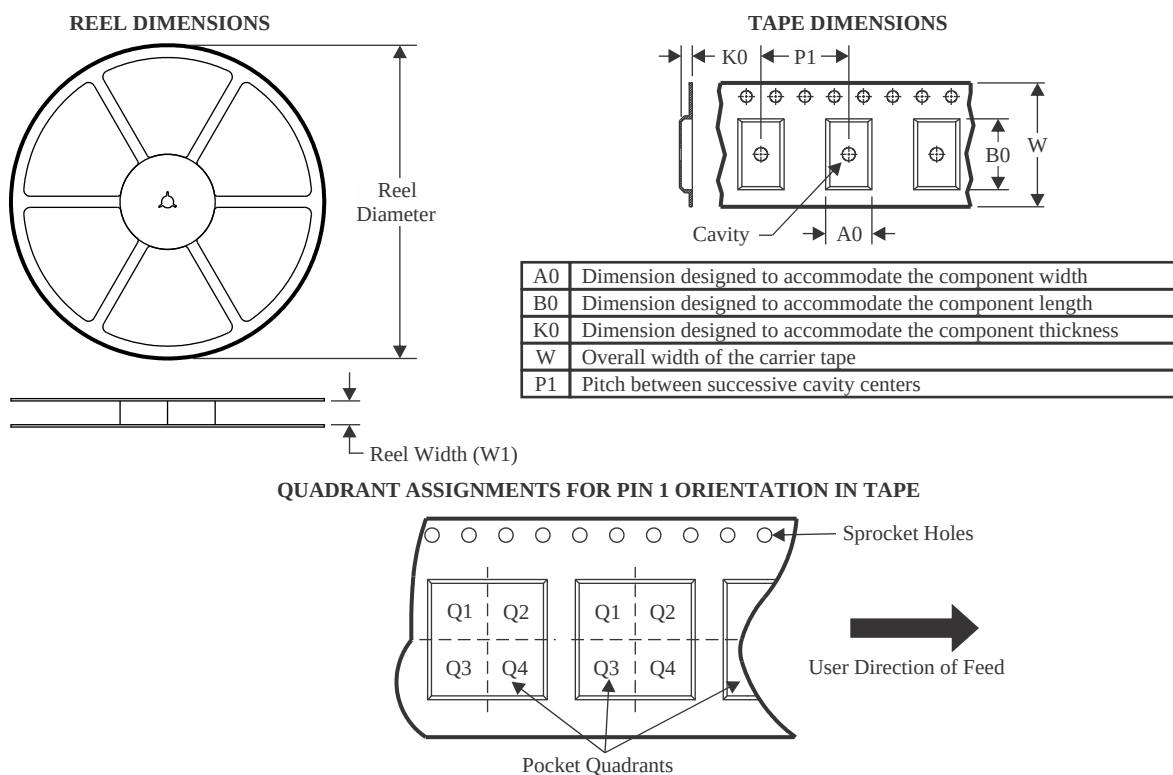
<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

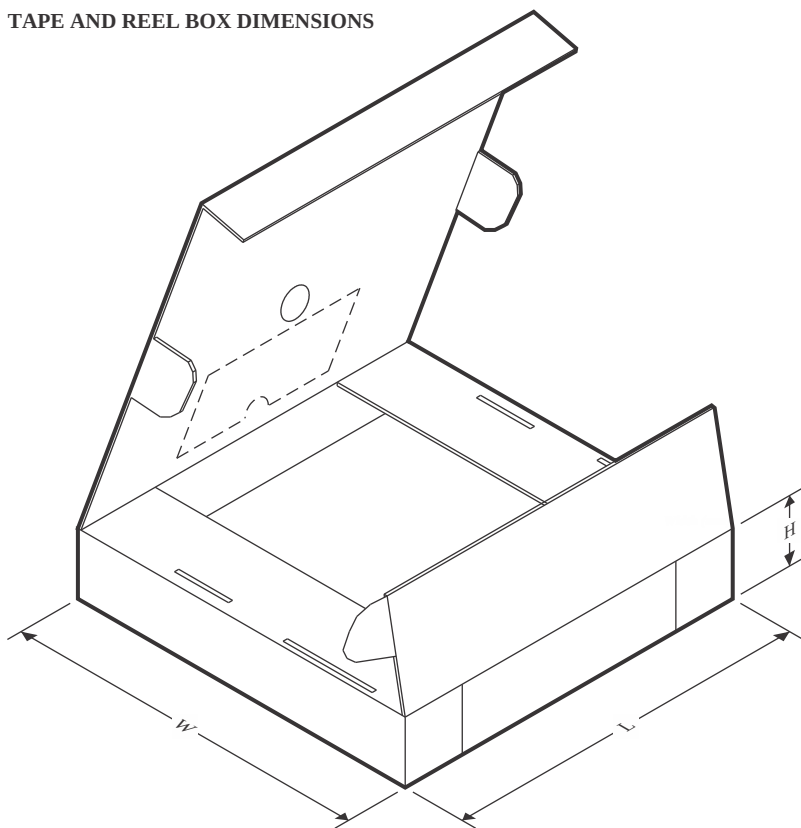
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| ADS117L11IRUKR | WQFN         | RUK             | 20   | 3000 | 330.0              | 12.4               | 3.3     | 3.3     | 1.1     | 8.0     | 12.0   | Q2            |
| ADS117L11IRUKT | WQFN         | RUK             | 20   | 250  | 180.0              | 12.4               | 3.3     | 3.3     | 1.1     | 8.0     | 12.0   | Q2            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| ADS117L11IRUKR | WQFN         | RUK             | 20   | 3000 | 367.0       | 367.0      | 35.0        |
| ADS117L11IRUKT | WQFN         | RUK             | 20   | 250  | 210.0       | 185.0      | 35.0        |

## GENERIC PACKAGE VIEW

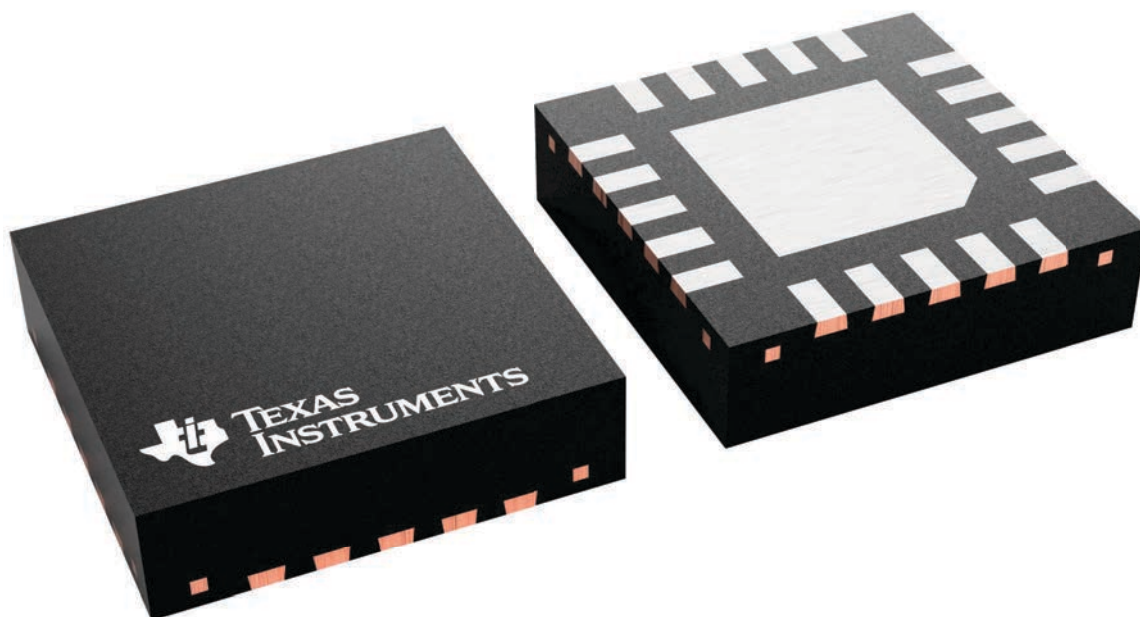
**RUK 20**

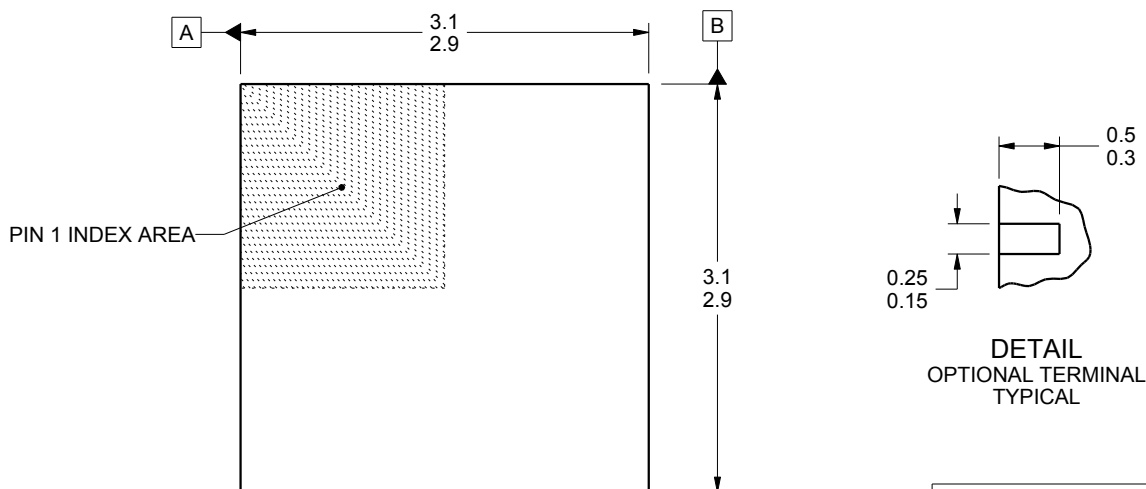
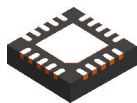
**WQFN - 0.8 mm max height**

3 x 3, 0.4 mm pitch

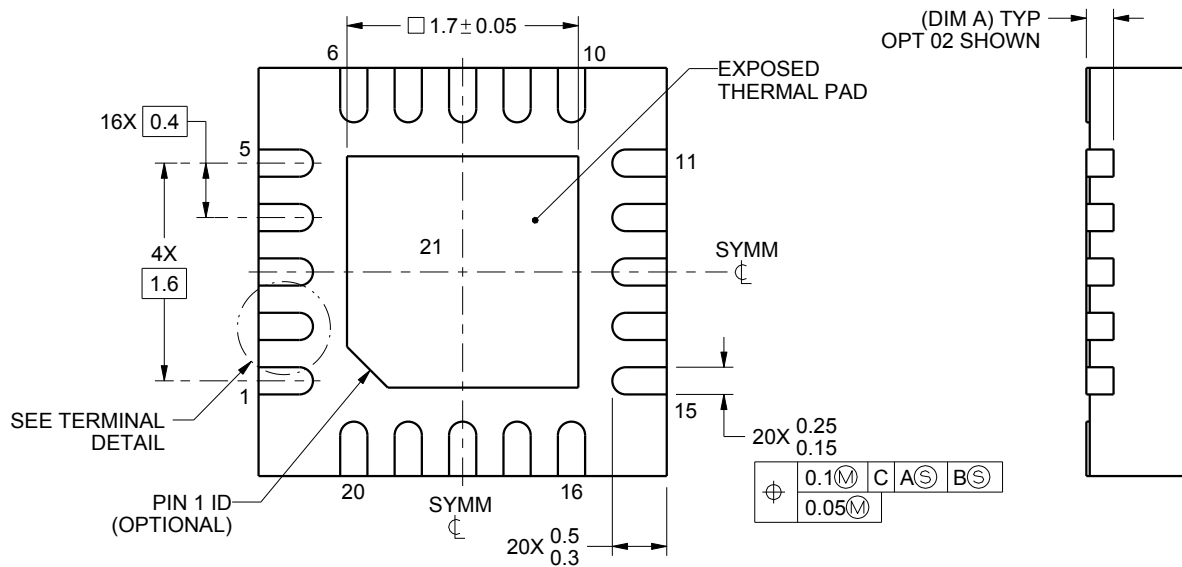
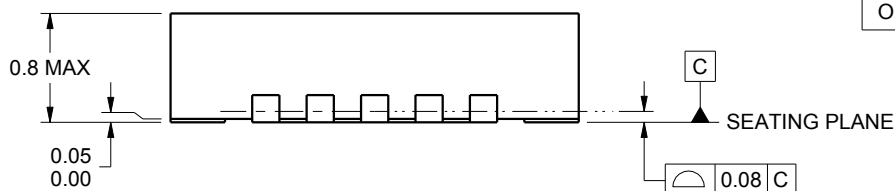
PLASTIC QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.





| DIMENSION A |       |
|-------------|-------|
| OPTION 01   | (0.1) |
| OPTION 02   | (0.2) |



4222676/A 02/2016

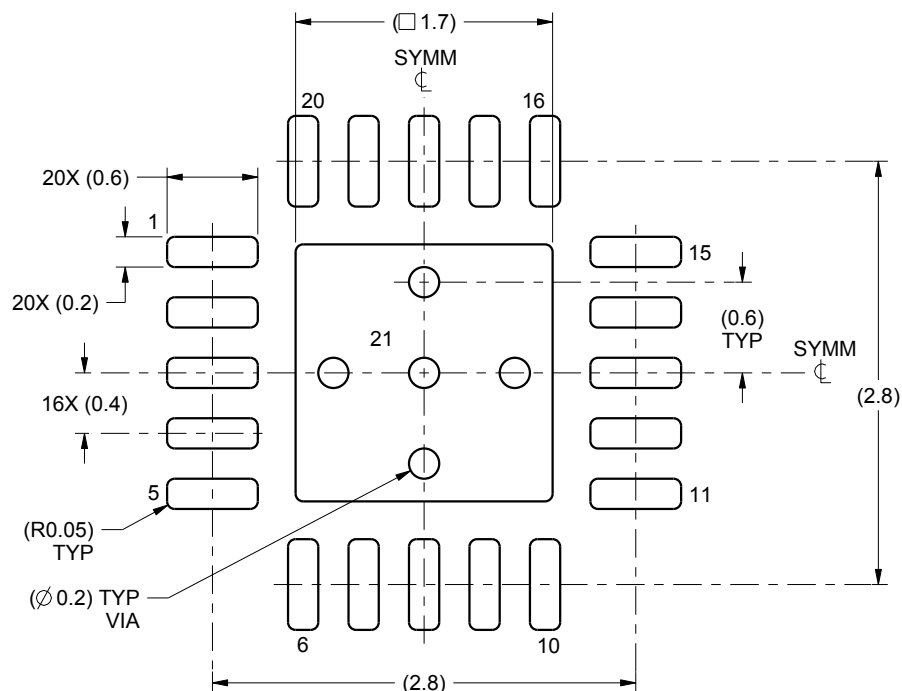
NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

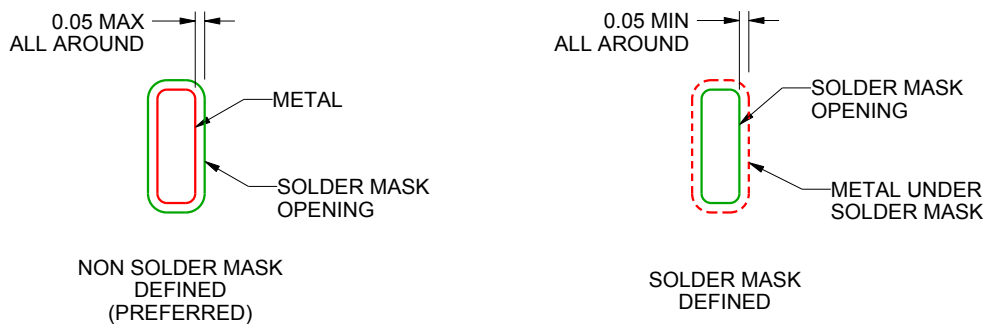
**RUK0020B**

**WQFN - 0.8 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
SCALE:20X



## SOLDER MASK DETAILS

4222676/A 02/2016

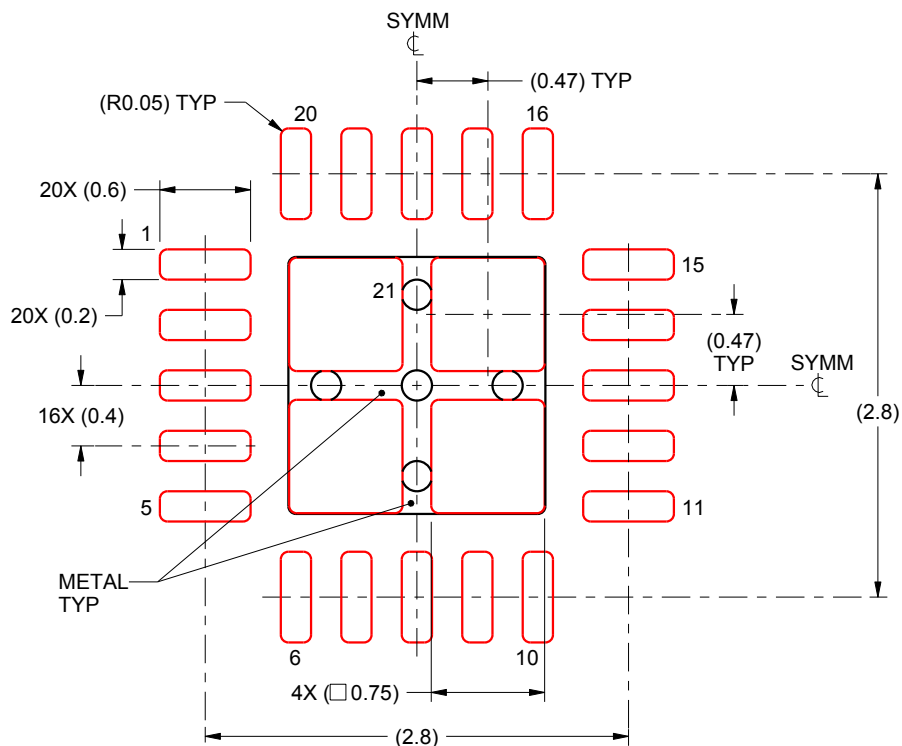
NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

**RUK0020B**

### WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



## SOLDER PASTE EXAMPLE BASED ON 0.1 mm THICK STENCIL

EXPOSED PAD 21:  
78% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE  
SCALE:20X

4222676/A 02/2016

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

## IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](https://www.ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2025, Texas Instruments Incorporated